



ispGDX2™ Device Datasheet

June 2010

Select Devices Discontinued!

Product Change Notifications (PCNs) #09-10 has been issued to discontinue select devices in this data sheet.

The original datasheet pages have not been modified and do not reflect those changes. Please refer to the table below for reference PCN and current product status.

| Product Line | Ordering Part Number | Product Status | Reference PCN |
|---------------|----------------------|--------------------|---------------------------|
| LX64V | LX64V-3F100C | Active / Orderable | |
| | LX64V-3FN100C | | |
| | LX64V-5F100C | | |
| | LX64V-5FN100C | | |
| LC64B | LX64B-3F100C | Discontinued | PCN#09-10 |
| | LX64B-3FN100C | | |
| | LX64B-5F100C | | |
| | LX64B-5FN100C | | |
| LX64C | LX64C-3F100C | Discontinued | PCN#09-10 |
| | LX64C-3FN100C | | |
| | LX64C-5F100C | | |
| | LX64C-5FN100C | | |
| LX128V | LX128V-32F208C | Active / Orderable | |
| | LX128V-32FN208C | | |
| | LX128V-5F208C | | |
| | LX128V-5FN208C | | |
| LX128B | LX128B-32F208C | Discontinued | PCN#09-10 |
| | LX128B-32FN208C | | |
| | LX128B-5F208C | | |
| | LX128B-5FN208C | | |
| LX128C | LX128C-32F208C | Discontinued | PCN#09-10 |
| | LX128C-32FN208C | | |
| | LX128C-5F208C | | |
| | LX128C-5FN208C | | |
| LX256V | LX256V-35F484C | Active / Orderable | |
| | LX256V-35FN484C | | |
| | LX256V-5F484C | | |
| | LX256V-5FN484C | | |
| LX256B | LX256B-35F484C | Discontinued | PCN#09-10 |
| | LX256B-35FN484C | | |
| | LX256B-5F484C | | |
| | LX256B-5FN484C | | |



| Product Line | Ordering Part Number | Product Status | Reference PCN |
|--------------|----------------------|--------------------|---------------------------|
| LX256C | LX256C-35F484C | Discontinued | PCN#09-10 |
| | LX256C-35FN484C | | |
| | LX256C-5F484C | | |
| | LX256C-5FN484C | | |
| LX64EV | LX64EV-3F100C | Active / Orderable | |
| | LX64EV-3FN100C | | |
| | LX64EV-5F100C | | |
| | LX64EV-5F100I | | |
| | LX64EV-5FN100C | | |
| | LX64EV-5FN100I | | |
| LX64EB | LX64EB-3F100C | Discontinued | PCN#09-10 |
| | LX64EB-3FN100C | | |
| | LX64EB-5F100C | | |
| | LX64EB-5F100I | | |
| | LX64EB-5FN100C | | |
| | LX64EB-5FN100I | | |
| LX64EC | LX64EC-3F100C | Discontinued | PCN#09-10 |
| | LX64EC-3FN100C | | |
| | LX64EC-5F100C | | |
| | LX64EC-5F100I | | |
| | LX64EC-5FN100C | | |
| | LX64EC-5FN100I | | |
| LX128EV | LX128EV-32F208C | Active / Orderable | |
| | LX128EV-32FN208C | | |
| | LX128EV-5F208C | | |
| | LX128EV-5F208I | | |
| | LX128EV-5FN208C | | |
| | LX128EV-5FN208I | | |
| LX128EB | LX128EB-32F208C | Discontinued | PCN#09-10 |
| | LX128EB-32FN208C | | |
| | LX128EB-5F208C | | |
| | LX128EB-5F208I | | |
| | LX128EB-5FN208C | | |
| | LX128EB-5FN208I | | |
| LX128EC | LX128EC-32F208C | Discontinued | PCN#09-10 |
| | LX128EC-32FN208C | | |
| | LX128EC-5F208C | | |
| | LX128EC-5F208I | | |
| | LX128EC-5FN208C | | |
| | LX128EC-5FN208I | | |
| LX256EV | LX256EV-35F484C | Active / Orderable | |
| | LX256EV-35FN484C | | |
| | LX256EV-5F484C | | |
| | LX256EV-5F484I | | |
| | LX256EV-5FN484C | | |
| | LX256EV-5FN484I | | |



| Product Line | Ordering Part Number | Product Status | Reference PCN |
|----------------|----------------------|---------------------|---------------------------|
| LX256EB | LX256EB-35F484C | Discontinued | PCN#09-10 |
| | LX256EB-35FN484C | | |
| | LX256EB-5F484C | | |
| | LX256EB-5F484I | | |
| | LX256EB-5FN484C | | |
| | LX256EB-5FN484I | | |
| LX256EC | LX256EC-35F484C | Discontinued | PCN#09-10 |
| | LX256EC-35FN484C | | |
| | LX256EC-5F484C | | |
| | LX256EC-5F484I | | |
| | LX256EC-5FN484C | | |
| | LX256EC-5FN484I | | |



Features

■ High Performance Bus Switching

- High bandwidth
 - Up to 12.8 Gbps (SERDES)
 - Up to 38 Gbps (without SERDES)
- Up to 16 (15x10) FIFOs for data buffering
- High speed performance
 - $f_{MAX} = 360\text{MHz}$
 - $t_{PD} = 3.0\text{ns}$
 - $t_{CO} = 2.9\text{ns}$
 - $t_S = 2.0\text{ns}$
- Built-in programmable control logic capability
- I/O intensive: 64 to 256 I/Os
- Expanded MUX capability up to 188:1 MUX

■ sysCLOCK™ PLL

- Frequency synthesis and skew management
- Clock multiply and divide capability
- Clock shifting up to +/-0.35ns in 335ps steps
- Up to four PLLs

■ sysIO™ Interfacing

- LVC MOS 1.8, 2.5, 3.3 and LVTTTL support for standard board interfaces
- SSTL 2/3 Class I and II support
- HSTL Class I, III and IV support
- GTL+, PCI-X for bus interfaces
- LVPECL, LVDS and Bus LVDS differential support
- Hot socketing
- Programmable drive strength

■ Two Options Available

- High-performance sysHSI (standard part number)
- Low-cost, no sysHSI (“E-Series”)

■ sysHSI Blocks Provide up to 16 High-speed Channels

- Serializer/de-serializer (SERDES) included
- Clock Data Recovery (CDR) built in
- 800 Mbps per channel
- LVDS differential support
- 10B/12B support
 - Encoding / decoding
 - Bit alignment
 - Symbol alignment
- 8B/10B support
 - Bit alignment
 - Symbol alignment
- Source Synchronous support

■ Flexible Programming and Testing

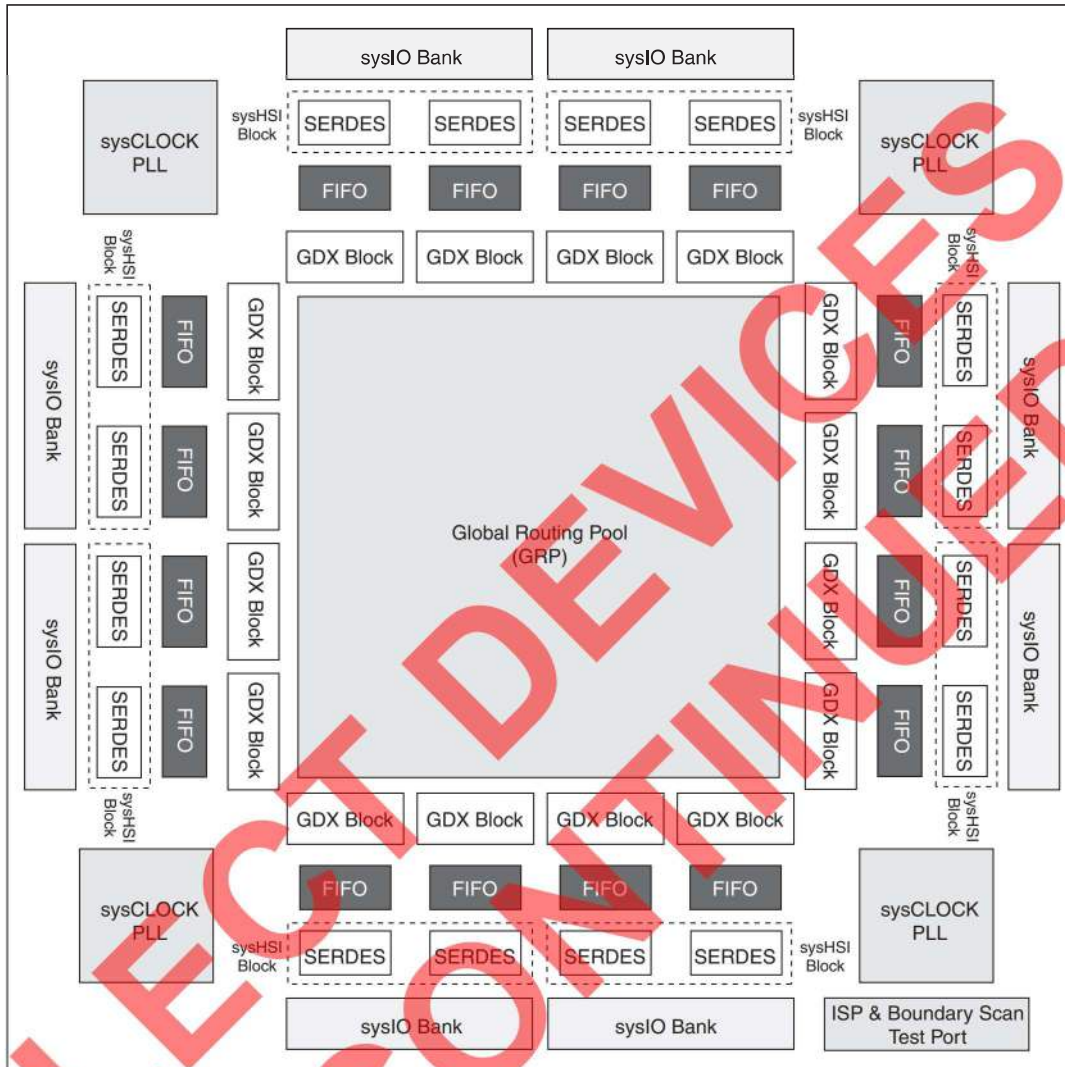
- IEEE 1532 compliant In-System Programmability (ISP™)
- Boundary scan test through IEEE 1149.1 interface
- 3.3V, 2.5V or 1.8V power supplies
- 5V tolerant I/O for LVC MOS 3.3 and LVTTTL interfaces

Table 1. ispGDX2 Family Selection Guide

| | ispGDX2-64/E | ispGDX2-128/E | ispGDX2-256/E |
|------------------------------|-----------------------------|----------------|----------------|
| I/Os | 64 | 128 | 256 |
| GDX Blocks | 4 | 8 | 16 |
| t_{PD} | 3.0ns | 3.2ns | 3.5ns |
| t_S | 2.0ns | 2.0ns | 2.0ns |
| t_{CO} | 2.9ns | 3.1ns | 3.2ns |
| f_{MAX} (Toggle) | 360MHz | 330MHz | 300MHz |
| Max Bandwidth | SERDES ^{1,2} | 3.2Gbps | 12.8Gbps |
| | Without SERDES ³ | 11Gbps | 38Gbps |
| sysHSI Channels ² | 4 | 8 | 16 |
| LVDS/Bus LVDS (Pairs) | 32 | 64 | 128 |
| PLLs | 2 | 2 | 4 |
| Package | 100-ball fpBGA | 208-ball fpBGA | 484-ball fpBGA |

1. Max number of SERDES channels per device * 800Mbps
 2. “E-Series” does not support sysHSI.
 3. f_{MAX} (Toggle) * maximum I/Os divided by 2.

Figure 1. ispGDX2 Block Diagram (256-I/O Device)



Introduction

The ispGDX2™ family is Lattice’s second generation in-system programmable generic digital crosspoint switch for high speed bus switching and interface applications.

The ispGDX2 family is available in two options. The standard device supports sysHSI capability for ultra fast serial communications while the lower-cost “E-series” supports the same high-performance FPGA fabric without the sysHSI Block.

This family of switches combines a flexible switching architecture with advanced sysIO interfaces including high performance sysHSI Blocks, and sysCLOCK PLLs to meet the needs of the today’s high-speed systems. Through a multiplexer-intensive architecture, the ispGDX2 facilitates a variety of common switching functions.

The availability of on-chip control logic further enhances the power of these devices. A high-performance solution, the family supports bandwidth up to 38Gbps.

Every device in the family has a number of PLLs to provide the system designer with the ability to generate multiple clocks and manage clock skews in their systems.

The sysIO interfaces provide system-level performance and integration. These I/Os support various modes of LVCMOS/LVTTL and support popular high-speed standard interfaces such as GTL+, PCI-X, HSTL, SSTL, LVDS and Bus-LVDS. The sysHSI Blocks further extend this capability by providing high speed serial data transfer capability.

Devices in the family can operate at 3.3V, 2.5V or 1.8V core voltages and can be programmed in-system via an IEEE 1149.1 interface that is compliant with the IEEE 1532 standard. Voltages required for the I/O buffers are independent of the core voltage supply. This further enhances the flexibility of this family in system designs.

Typical applications for the ispGDX2 include multi-port multi-processor interfaces, wide data and address bus multiplexing, programmable control signal routing and programmable bus interfaces. Table 1 shows the members of the ispGDX2 family and their key features.

Architecture

The ispGDX2 devices consist of GDX Blocks interconnected by a Global Routing Pool (GRP). Signals interface with the external system via sysIO banks. In addition, each GDX Block is associated with a FIFO and a sysHSI Block to facilitate the transfer of data on- and off-chip. Figure 1 shows the ispGDX2 block diagram. Each GDX Block can be individually configured in one of four modes:

- Basic (No FIFO or SERDES)
- FIFO Only
- SERDES Only
- SERDES and FIFO

Each sysIO bank has its own I/O power supply and reference voltage. Designers can use any output standard within a bank that is compatible with the power supply. Any input standard may be used, providing it is compatible with the reference voltage. The banks are independent.

Global Routing Pool (GRP)

The ispGDX2 architecture is organized into GDX Blocks, which are connected via a Global Routing Pool. The innovative GRP is optimized for routability, flexibility and speed. All the signals enter via the GDX Block. The block supplies these either directly or in registered form to the GRP. The GRP routes the signals to different blocks, and provides separate data and control routing. The data path is optimized to achieve faster speed and routing flexibility for nibble oriented signals. The control routing is optimized to provide high-speed bit oriented routing of control signals.

There are some restrictions on the allocation of pins for optimal bus routing. These restrictions are considered by the software in the allocation of pins.

GDX Block

The blocks are organized in a "block" (nibble) manner, with each GDX Block providing data flow and control logic for 16 I/O buffers. The data flow is organized as four nibbles, each nibble containing four Multiplexer Register Blocks (MRBs). Data for the MRBs is provided from 64 lines from the GRP. Figure 2 illustrates the groups of signals going into and out of a GDX Block.

Control signals for the MRBs are provided from the Control Array. The Control Array receives the 32 signals from the GRP and generates 16 control signals: eight MUX Select, four Clock/Clock Enable, two Set/Reset and two Output Enable. Each nibble is controlled via two MUX select signals. The remaining control signals go to all the MRBs.

Besides the control signals from the Control Array, the following global signals are available to the MRBs in each GDX Block: four Clock/Clock Enable, one reset/preset, one power-on reset, two of four MUX select (two of two in 64 I/O), four Output Enable (two in 64 I/O) and Test Out Enable (TOE).

MUX and Register Block (MRB)

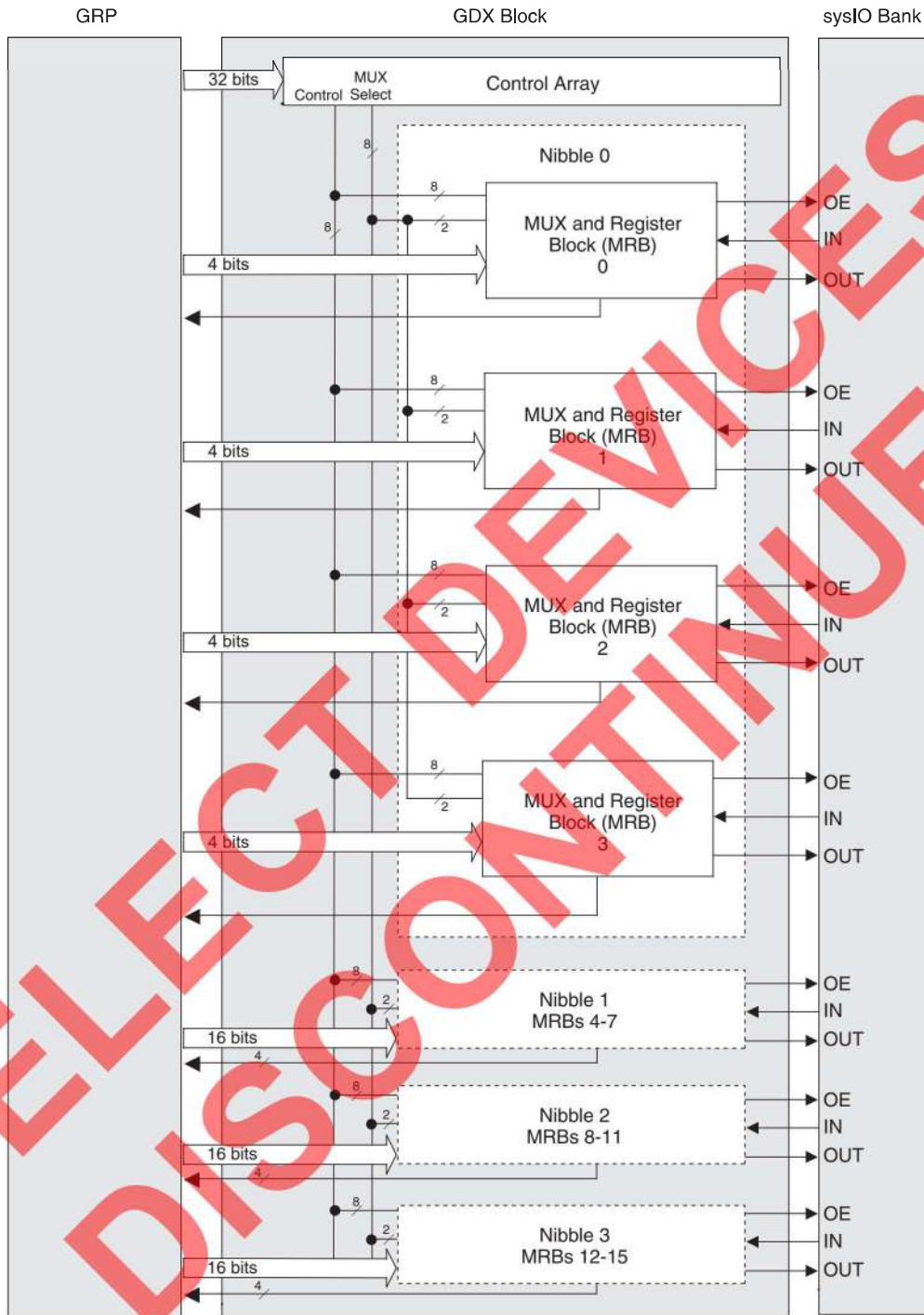
Every MRB Block has a 4:1 MUX (I/O MUX) and a set of three registers which are connected to the I/O buffers, FIFO and sysHSI Blocks. Multiple MRBs can be combined to form large multiplexers as described below. Figure 3 shows the structure of the MRB.

Each of the three registers in the MRB can be configured as edge-triggered D-type flip-flop or as a level sensitive latch. One register operates on the input data, the other output data and the last register synchronizes the output enable function. The input and output data signals can bypass each of their registers. The polarity of the data out and output enable signals can be selected.

The Output and OE register share the same clock and clock enable signals. The Input register has a separate clock and clock enable. The initialization signals of each register can be independently configured as Set or Reset. These registers have programmable polarity control for Clock, Clock Enable and Set/Reset. The output enable register input can be set either by one of the two output enables generated locally from the Control Array or from one of the four (two in 64 I/O) Global OE enable pins. In addition to the local clock and clock enable signals, each MRB has access to Global Clock, Clock Enable, Reset and TOE nets.

SELECT DEVELOPMENTS
DISCONTINUED

Figure 2. GDX Block



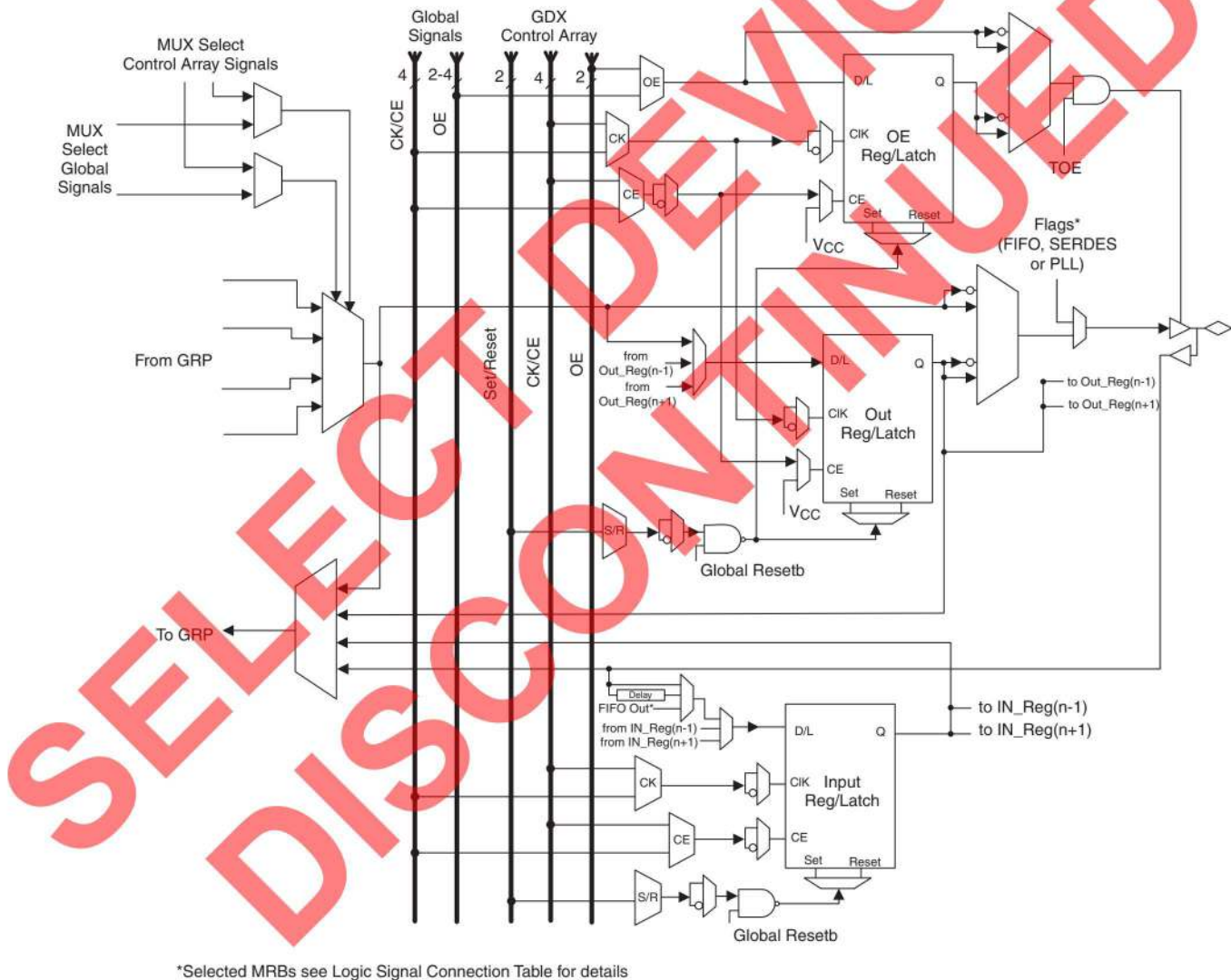
The output register of the MRB has a built-in bi-directional shift register capability. Each output register corresponding to MRB “n”, receives data output from its two adjacent MRBs, MRB (n-1) and MRB (n+1), to provide shift register capability. Like the output register, each input register of the MRB has built-in shift register capability. Each input register can receive data from its two adjacent MRB input registers, to provide bi-directional shift register capability. The chaining crosses GDX Block boundaries. The chain of input registers and the chain of output registers can be combined as one shift register via the GRP.

The four data inputs to the 4:1 MUX come from the GRP. The output of this MUX connects to the output register. A fast feedback path from the MUX to the GRP allows wider MUXes to be built. Table 2 summarizes the various MUX sizes and delay levels.

Table 2. MUX Size Versus Internal Delay

| MUX Sizes | Levels of Internal GRP Delays |
|--------------------------------|-------------------------------|
| 4:1 | One Level |
| Up to 16:1 | Two Levels |
| Up to 64:1 | Three Levels |
| Up to 188:1 (with ispGDX2-256) | Four Levels |

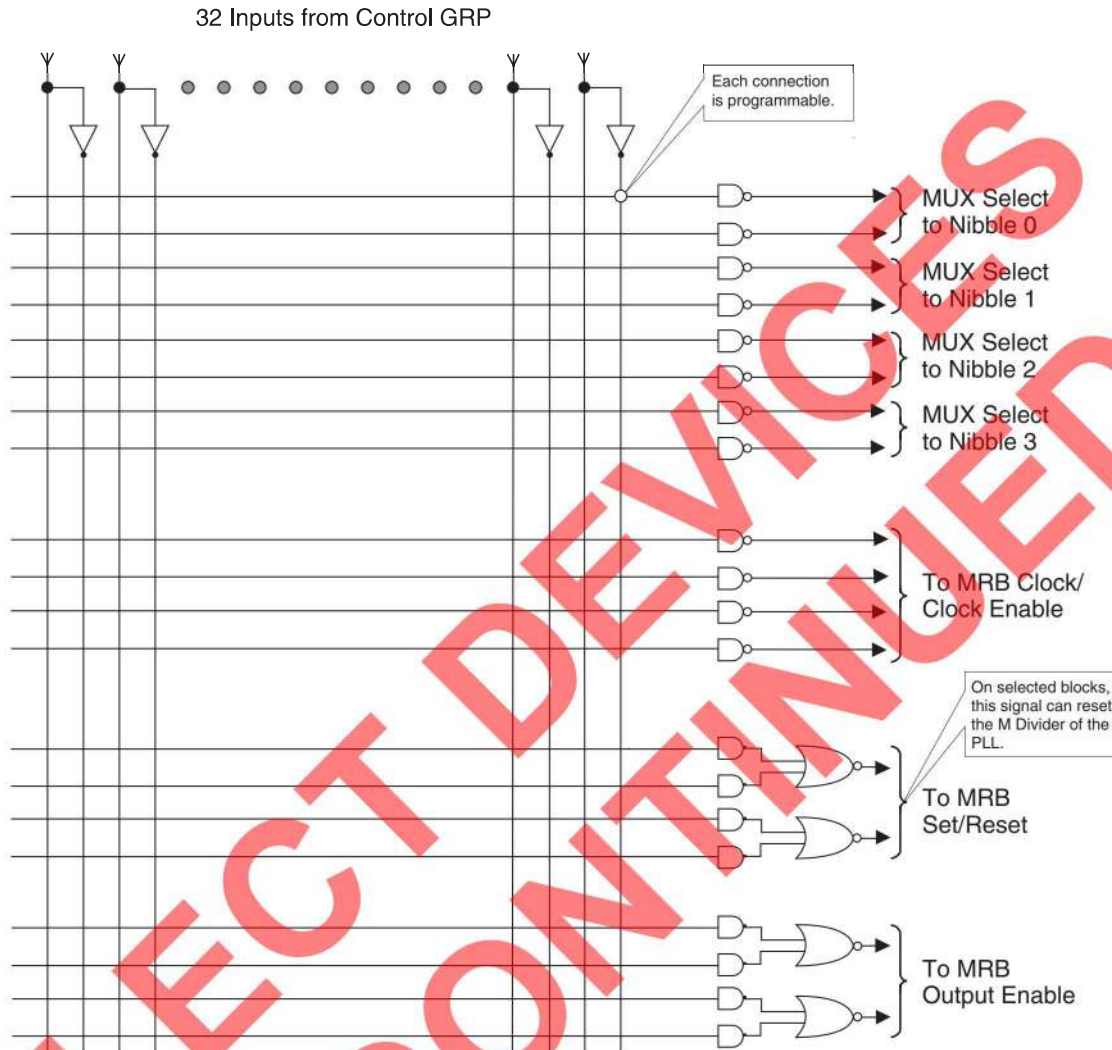
Figure 3. ispGDX2 Family MRB



Control Array

The control array generates control signals for the 16 MRBs within a GDX Block. The true and complement forms of 32 inputs from the GRP are available in the control array. The 20 NAND terms can use any or all of these inputs to form the control array outputs. Two AND terms are combined with a NOR term to form Set/Reset and OE signals. Figure 4 illustrates the control array.

Figure 4. ispGDX2 Family Control Array

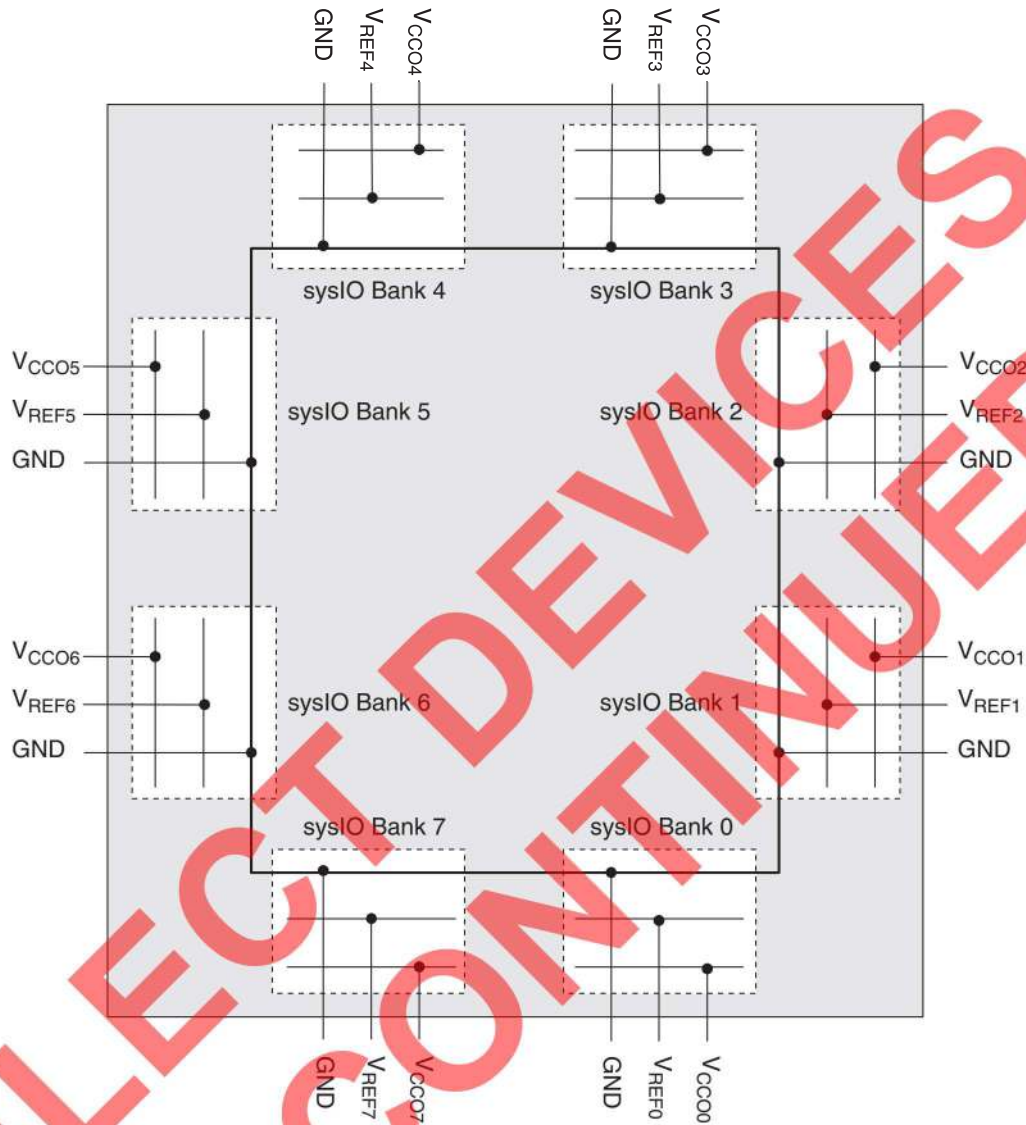


sysIO Banks

The inputs and outputs of ispGDX2 devices are divided into eight sysIO banks, where each bank is capable of supporting different I/O standards. The number of I/Os per bank is 32, 16 and 8 for the 256-, 128- and 64-I/O devices respectively. Each sysIO bank has its own I/O supply voltage (V_{CCO}) and reference voltage (V_{REF}), allowing each bank complete independence from the other banks. Each I/O within a bank can be individually configured to any standard consistent with the V_{CCO} and V_{REF} settings. Figure 5 shows the I/O banks for the ispGDX2-256 device.

The I/O of the ispGDX2 devices contain a programmable strength and slew rate tri-state output buffer, a programmable input buffer, a programmable pull-up resistor, a programmable pull-down resistor and a programmable bus-keeper latch. These programmable capabilities allow the support of a wide range of I/O standards.

Figure 5. ispGDX2-256 sysIO Banks



There are three classes of I/O interface standards implemented in the ispGDX2 devices. The first is the non-terminated, single-ended interface; it includes the 3.3V LVTTTL standard along with the 1.8V, 2.5V and 3.3V LVCMOS interface standards. The slew rate and strength of these output buffers can be controlled individually. Additionally, PCI 3.3, PCI-X and AGP-1X are all subsets of this interface type. The second interface class implemented is the terminated, single-ended interface standard. This group of interfaces includes different versions of SSTL and HSTL interfaces along with CTT and GTL+. Use of these I/O interfaces requires an additional V_{REF} signal. At the system level, a termination voltage, V_{TT} , is also required. Typically, an output will be terminated to V_{TT} at the receiving end of the transmission line it is driving. The final types of interfaces implemented are the differential standards LVPECL, LVDS and Bus LVDS. Table 3 shows the I/O standards supported by the ispGDX2 devices along with nominal V_{CCO} , V_{REF} and V_{TT} .

The ispGDX2 family also features 5V tolerant I/O. I/O banks with $V_{CCO} = 3.3V$ may have inputs driven to a maximum of 5.5V for easy interfacing with legacy systems. Up to 64 I/O pins per device may be driven by 5V inputs.

Table 3. ispGDX2 Supported I/O Standards

| sysIO Standard | Nominal V _{CCO} | Nominal V _{REF} | Nominal V _{TT} |
|-------------------------|--------------------------|--------------------------|-------------------------|
| LVC MOS 3.3 | 3.3V | — | — |
| LVC MOS 2.5 | 2.5V | — | — |
| LVC MOS 1.8 | 1.8V | — | — |
| LV TTL | 3.3V | — | — |
| PCI 3.3 | 3.3V | — | — |
| PCI -X | 3.3V | — | — |
| AGP-1X | 3.3V | — | — |
| SSTL3 class I & II | 3.3V | 1.5V | 1.5V |
| SSTL2 class I & II | 2.5V | 1.25V | 1.25V |
| CTT 3.3 | 3.3V | 1.5V | 1.5V |
| CTT 2.5 | 2.5V | 1.25V | 1.25V |
| HSTL class I | 1.5V | 0.75V | 0.75V |
| HSTL class III | 1.5V | 0.9V | 0.75V |
| HSTL class IV | 1.5V | 0.9V | 1.5V |
| GTL+ | 1.8/2.5/3.3V | 1.0V | 1.5V |
| LVPECL ^{1,2,3} | 3.3V | — | — |
| LVDS | 2.5/3.3V | — | — |
| Bus-LVDS | 2.5/3.3V | — | — |

1. LVPECL drivers require three resistor pack (see Figure 17).

2. Depending on the driving LVPECL output specification, GDX2 LVPECL input driver may require terminating resistors.

3. For additional information on LVPECL refer to Lattice technical note number TN1000, *sysIO Design and Usage Guidelines*.

The dedicated inputs support a subset of the sysIO standards indicated in Table 4. These inputs are associated with a bank consistent with their location.

Table 4. I/O Standards Supported by Dedicated Inputs

| | LVC MOS | LVDS | All other ASIC I/Os |
|----------------------------|------------------|------|---------------------|
| Global OE Pins | Yes | No | Yes ² |
| Global MUX Select Pins | Yes | No | Yes ² |
| Resetb | Yes | No | Yes ² |
| Global Clock/Clock Enables | Yes | Yes | Yes ² |
| ispJTAG™ Port | Yes ¹ | No | No |
| TOE | Yes | No | No |

1. LVC MOS as defined by the V_{CCJ} pin voltage.

2. No PCI clamp.

For more information on the sysIO capability, please refer to Lattice technical note number TN1000, *sysIO Design and Usage Guidelines*.

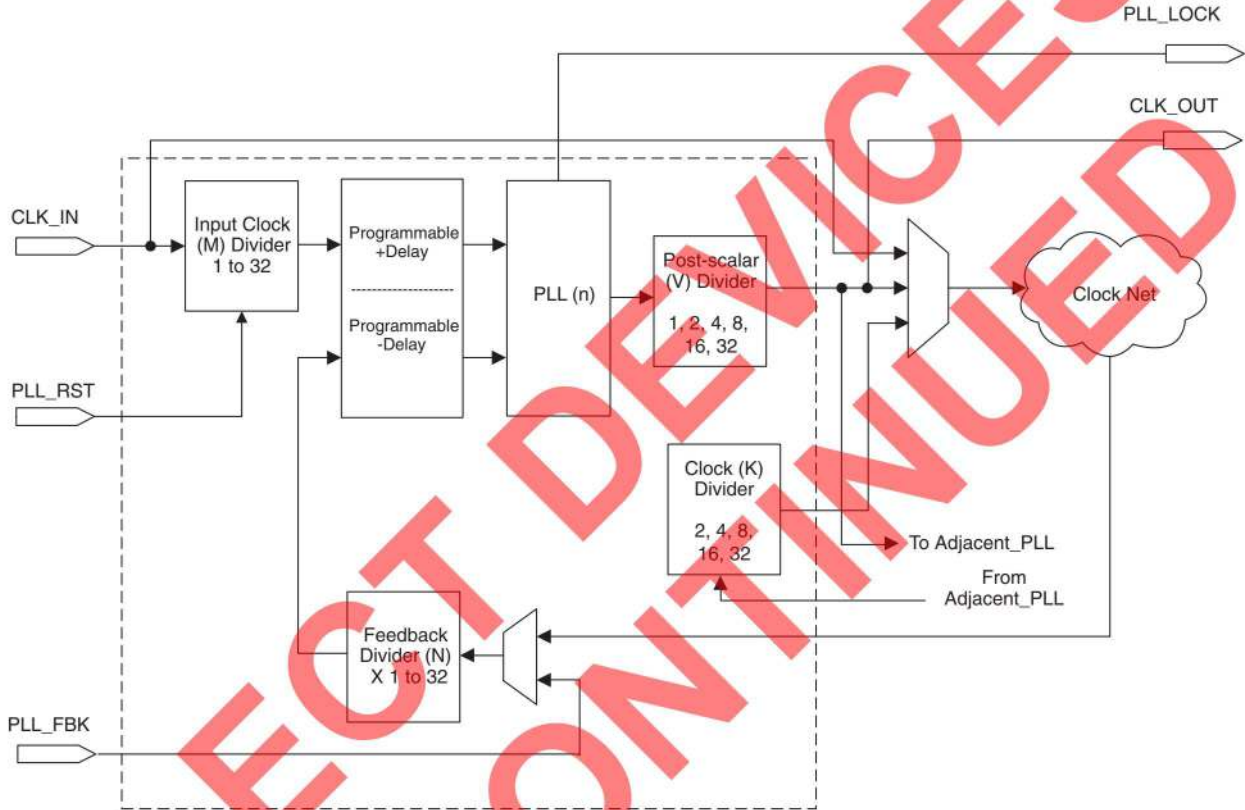
sysCLOCK PLL

The sysCLOCK PLL circuitry consists of Phase-Lock Loops (PLLs) along the various dividers and reset and feedback signals associated with the PLLs. This feature gives the user the ability to synthesize clock frequencies and generate multiple clock signals for routing within the device. Furthermore, it can generate clock signals that are deskewed either at the board level or the device level. Figure 6 shows the ispGDX2 PLL block diagram.

Each PLL has a set of PLL_RST, PLL_FBK and PLL_LOCK signals. In order to facilitate the multiply and divide capabilities of the PLL, each PLL has associated dividers. The M divider is used to divide the clock signal, while the

N divider is used to multiply the clock signal. The K divider is used to provide a divided clock frequency of the adjacent PLL. This output can be routed to the global clock net. The V divider is used to provide lower frequency output clocks, while maintaining a stable, high frequency output from the PLL's VCO circuit. The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. For more information on the PLL, please refer to Lattice technical note number TN1003, *sysCLOCK PLL Design and Usage Guidelines*.

Figure 6. sysCLOCK PLL

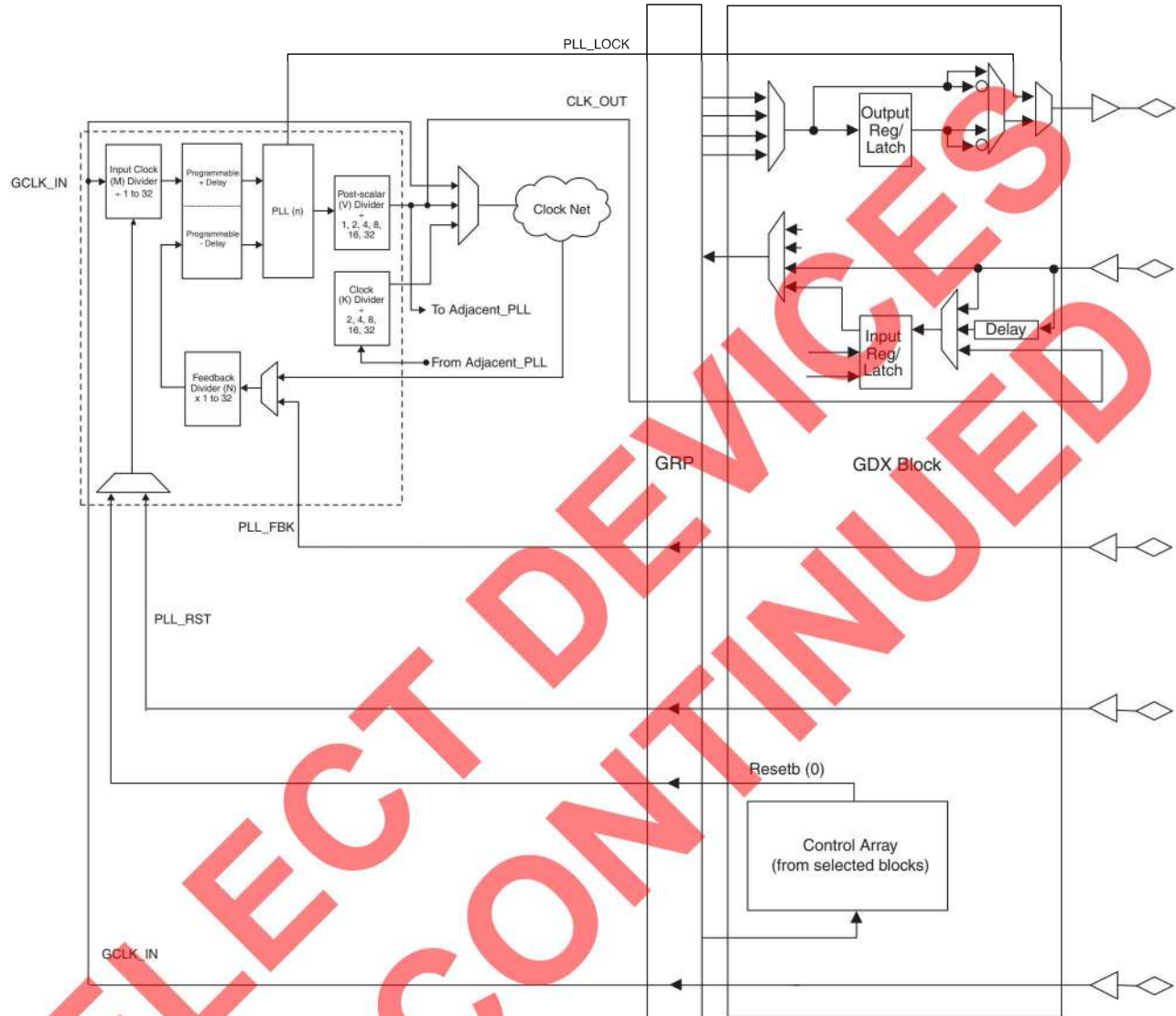


There are four global clock networks routed to each MRB block. These global clocks, CLK0-3, can either be generated by the PLL circuits or supplied externally. External clock pins can be configured as single-ended or differential (LVDS) input. Figure 7 illustrates how the sysCLOCK PLL inputs and outputs can be routed to the I/O pins or general routing. Figure 10 shows the clock network for the ispGDX2-256 and Figure 8 shows the clock networks for ispGDX2-128 and ispGDX2-64. The Reset (0) pin from the Control Array of selected GDX Blocks can be programmed to reset the M Divider of the PLLs. This provides a means for generating the reset signal internally. Table 5 details which GDX Block provides reset to the PLLs.

Table 5. Internal Reset Input of the PLL (M Divider)

| | PLL0 | PLL1 | PLL2 | PLL3 |
|-------------|--------------|--------------|--------------|--------------|
| ispGDX2-256 | GDX Block 5A | GDX Block 7B | GDX Block 1A | GDX Block 3B |
| ispGDX2-128 | GDX Block 2A | — | GDX Block 0A | — |
| ispGDX2-64 | GDX Block 0A | — | GDX Block 1B | — |

Figure 7. I/O Pin Connection to the sysCLOCK PLL¹



1. Some pins are shared. See Logic Signal Connections Table for details.

Figure 8. ispGDX2-64 CLOCK Network

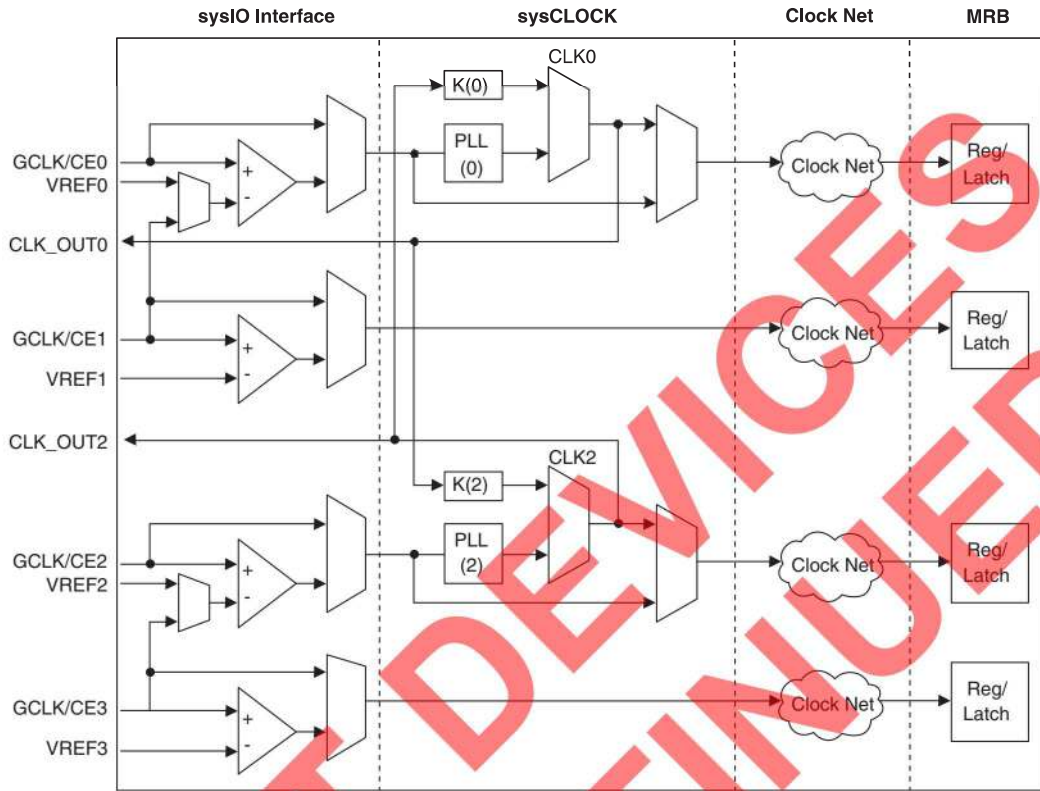


Figure 9. ispGDX2-128 CLOCK Network

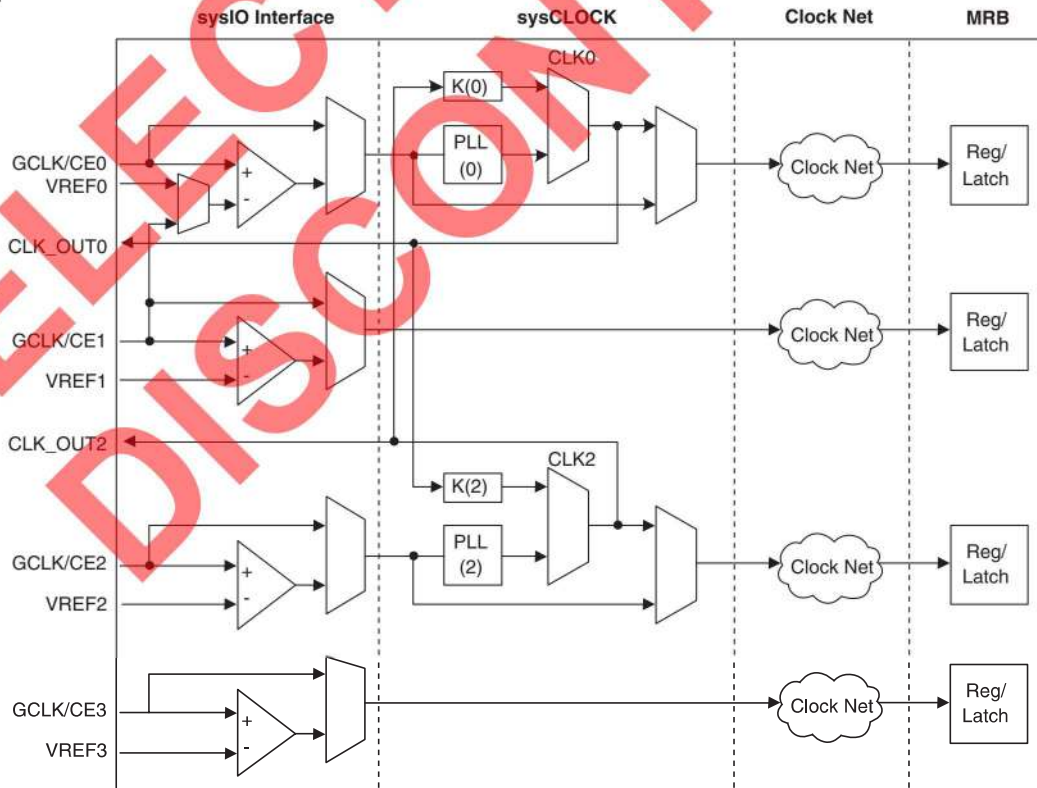
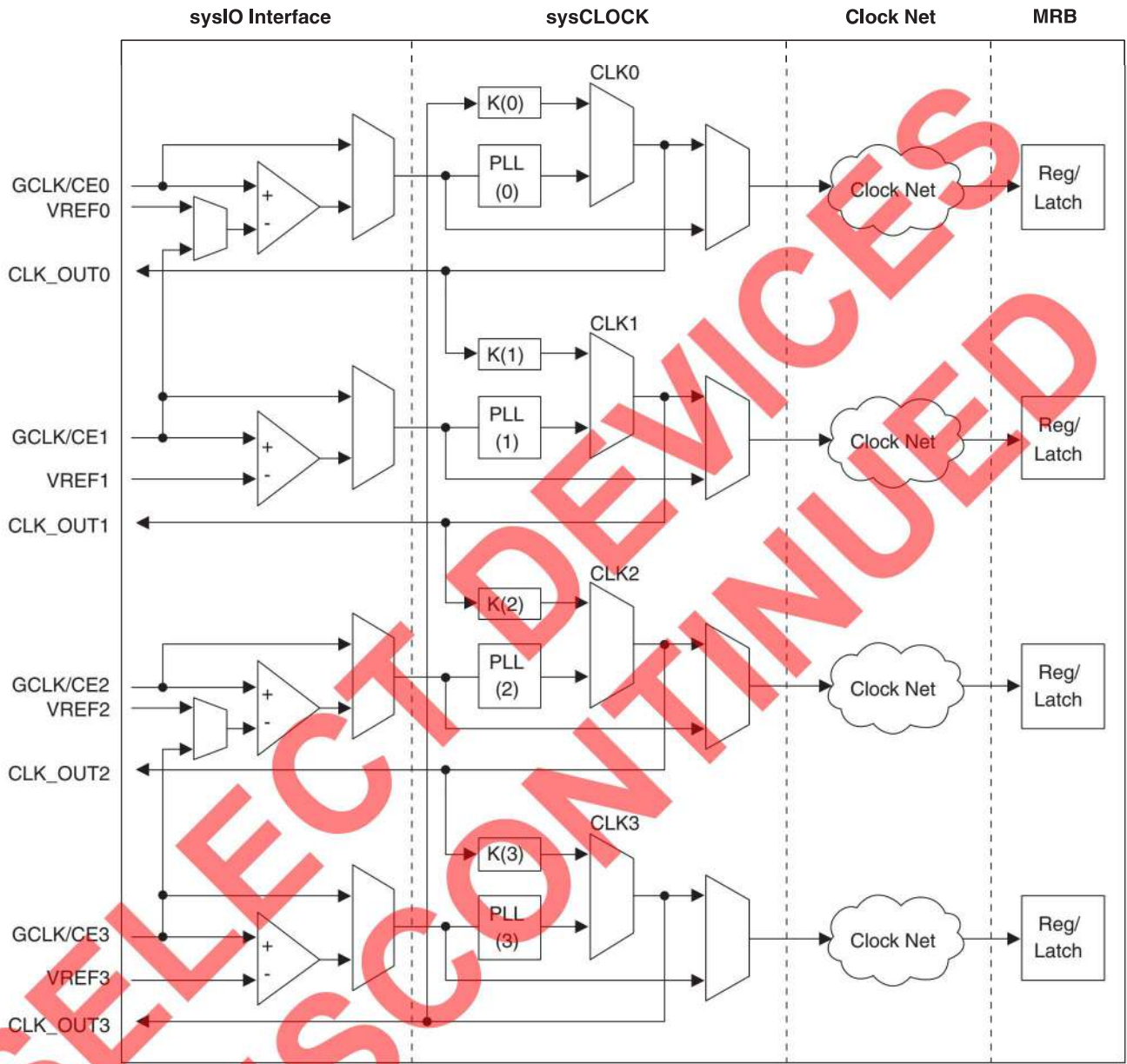


Figure 10. ispGDX2-256 CLOCK Network

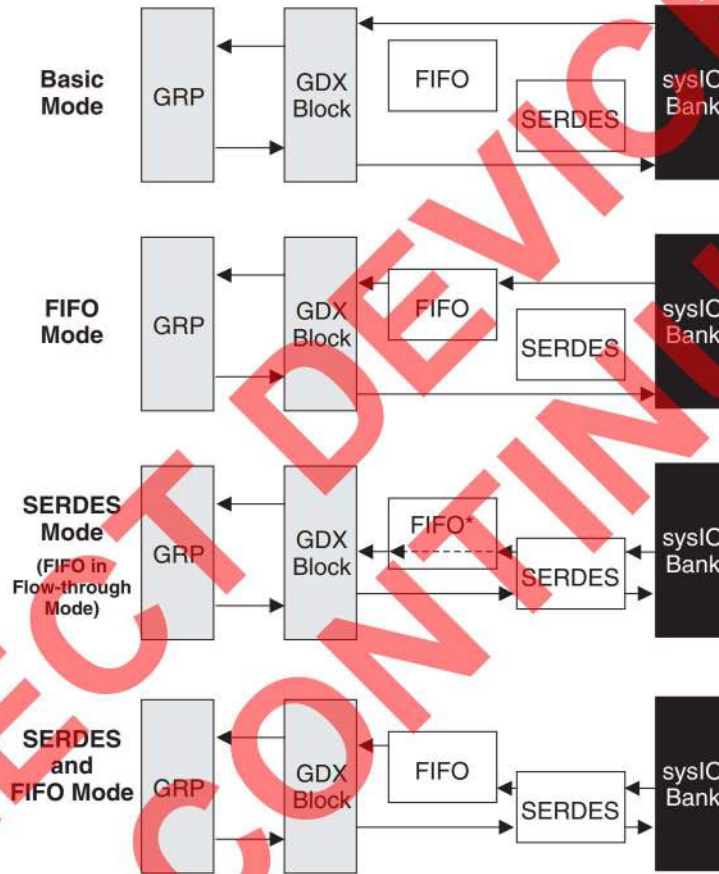


Operating Modes

All the GDx Blocks in the ispGDx2 family can be programmed in four modes: Basic, FIFO only, SERDES only, and FIFO with SERDES mode. In basic mode, the SERDES and FIFO are disabled and the MUX output of the MRB connects to the output register. Inputs are connected to the GRP via the MRB.

Figure 11 shows the four different operating modes. Precise detail of the FIFO and SERDES connections is provided in their respective sections.

Figure 11. Four Operating Modes of ispGDx2 Devices

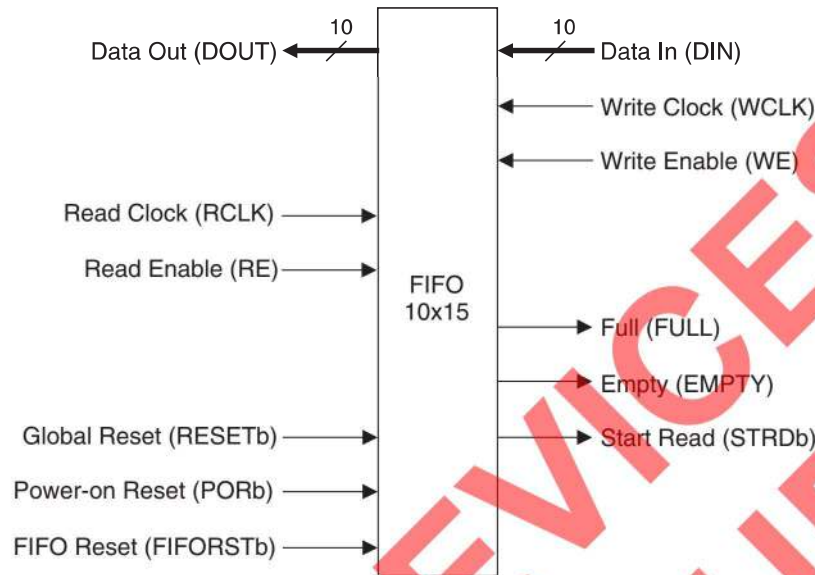


*FIFO held in RESET for SERDES-only mode.

FIFO Operations

Each GDx Block is associated with a 10-bit wide and 15-word deep (10x15) RAM. This RAM, combined with two address counters and two comparators, is used to implement a FIFO as a “circular queue”. The FIFO has separate clocks, the Read Clock (RCLK) and Write Clock (WCLK), for asynchronous operation. The FIFO has three additional control signals Write Enable, Read Enable and FIFO Reset. Three flags show the status of the FIFO: Empty, Full and Start Read. Each FIFO receives the global Power-on Reset and Reset signals. Figure 12 shows the connections to the FIFO.

Figure 12. ispGDX2 FIFO Signals

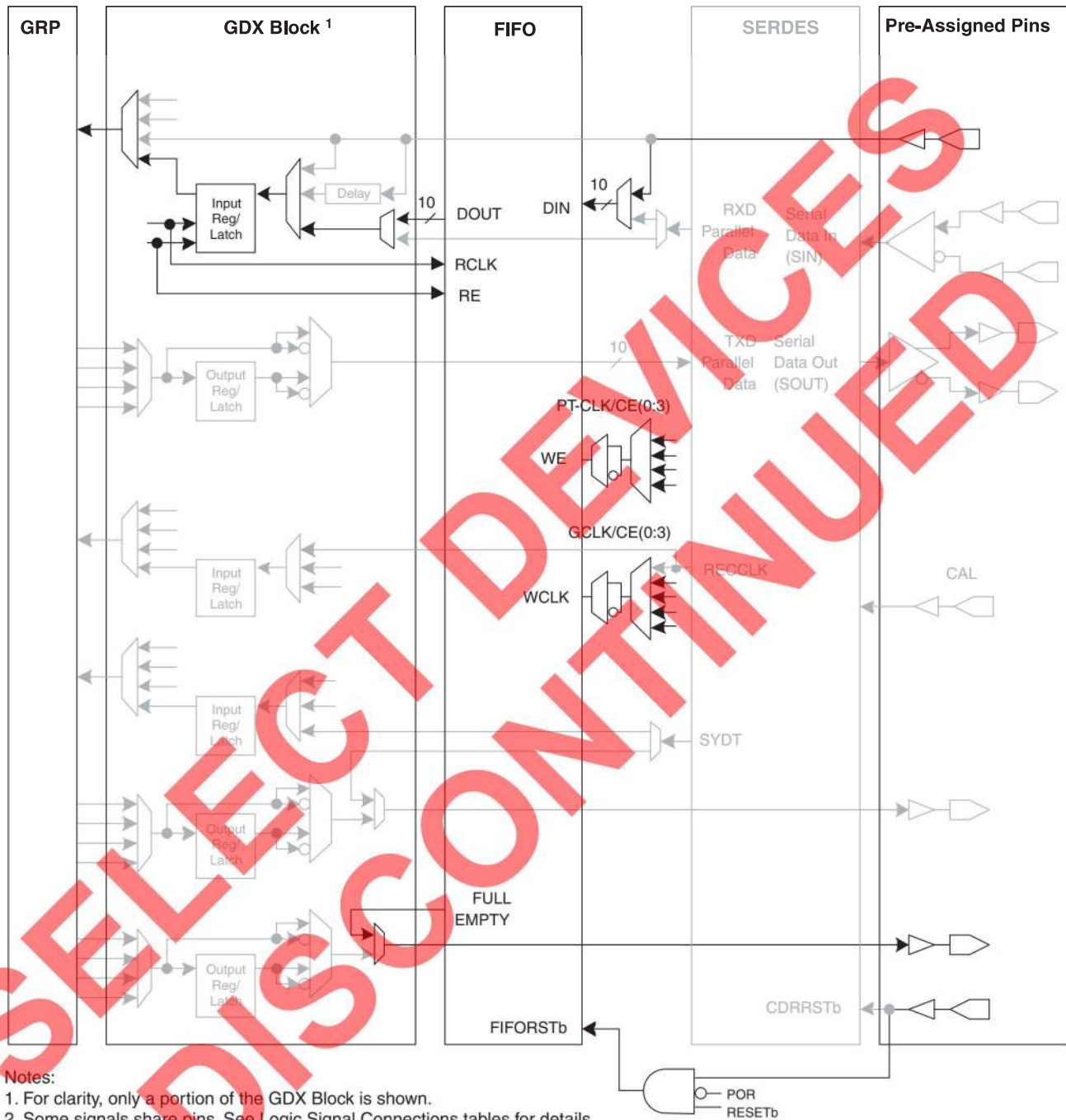


Read Clock and Read Enable are the same as the Clock and Clock Enable signals of the input registers of the associated MRB. These registers are used to register the FIFO outputs, and in modes that utilize the FIFO are configured to use the same clock and clock enable signals. The Write Clock is selected from one of the GCLK/CE signals or the RECCLK (Recovered Clock) signal from the associated SERDES. The Write Enable is selected from one of the local MRB product term CLK/CE signals. All FIFO operations occur on the rising edge of the clock although clock polarity of these signals can be programmed.

The flags from the FIFO, FULL, EMPTY and STRDb (Start Read) are each fed via a MUX in the MRB to an I/O buffer. The STRDb (half full) signal is used in conjunction with SERDES. STRDb is an active low signal, the signal is inactive (high) on FIFO RESET. After the FIFO reset when the FIFO contains data in five memory locations, at the following write clock transition the STRDb becomes active (low). Note, if the Read Clocks arrive before writing the sixth location, it may take longer than five write clocks before the STRDb becomes active. When the FIFO has data in the first six locations, at the next write clock transition the STRDb becomes inactive (high). Again, if the Read Clocks arrive before writing the seventh location, the STRDb may stay active for longer than one write clock period, even if the FIFO contains data in less than five locations. After this event, the STRDb stays inactive until the FIFO is RESET again. STRDb does not become active again even if less than six memory locations are occupied in the FIFO. It is the user's responsibility to monitor the FULL and EMPTY signals to avoid data underflow/overflow and to take appropriate actions.

Figure 13 shows how the FIFO is connected between the I/O banks and the GDX Blocks in FIFO mode. For more information on the FIFO, please refer to Lattice technical note number TN1020, *sysHSI Usage Guidelines*.

Figure 13. Operation in FIFO Mode²



Notes:

1. For clarity, only a portion of the GDX Block is shown.
2. Some signals share pins. See Logic Signal Connections tables for details.

High Speed Serial Interface Block (sysHSI Block)¹

The High Speed Serial Interface (sysHSI) allows high speed serial data transfer over a pair of LVDS I/O. The ispGDX2 devices have multiple sysHSI Blocks.

Each sysHSI Block has two SERDES blocks which contain two main sub-blocks, Transmitter (with a serializer) and Receiver (with a deserializer) including Clock/Data Recovery Circuit (CDR). Each SERDES can be used as a full duplex channel. The two SERDES in a given sysHSI Block share a common clock and must operate at the same nominal frequency. Figure 14 shows the sysHSI Block.

Device features support two data coding modes: 10B/12B and 8B/10B (for use with other encoding schemes, see Lattice's sysHSI application notes). The encoding and decoding of the 10B/12B standard are performed within the device in dedicated logic. For the 8B/10B standard, the symbol boundaries are aligned internally but the encoding and decoding are performed outside the device.

Each SERDES block receives a single high speed serial data input stream (with embedded clock) from an input, and provide a low speed 10-bit wide data stream and a recovered clock to the device. For transmitting, the SERDES converts a 10-bit wide low-speed data stream to a single high-speed data stream with embedded clock for output.

Additionally, multiple sysHSI Blocks can be grouped together to form a source synchronous interface of between 1-8 channels.

Figure 15 shows the connections of the SERDES block with the FIFO, sysIO block and the MRB. Table 6 provides the descriptions of the SERDES.

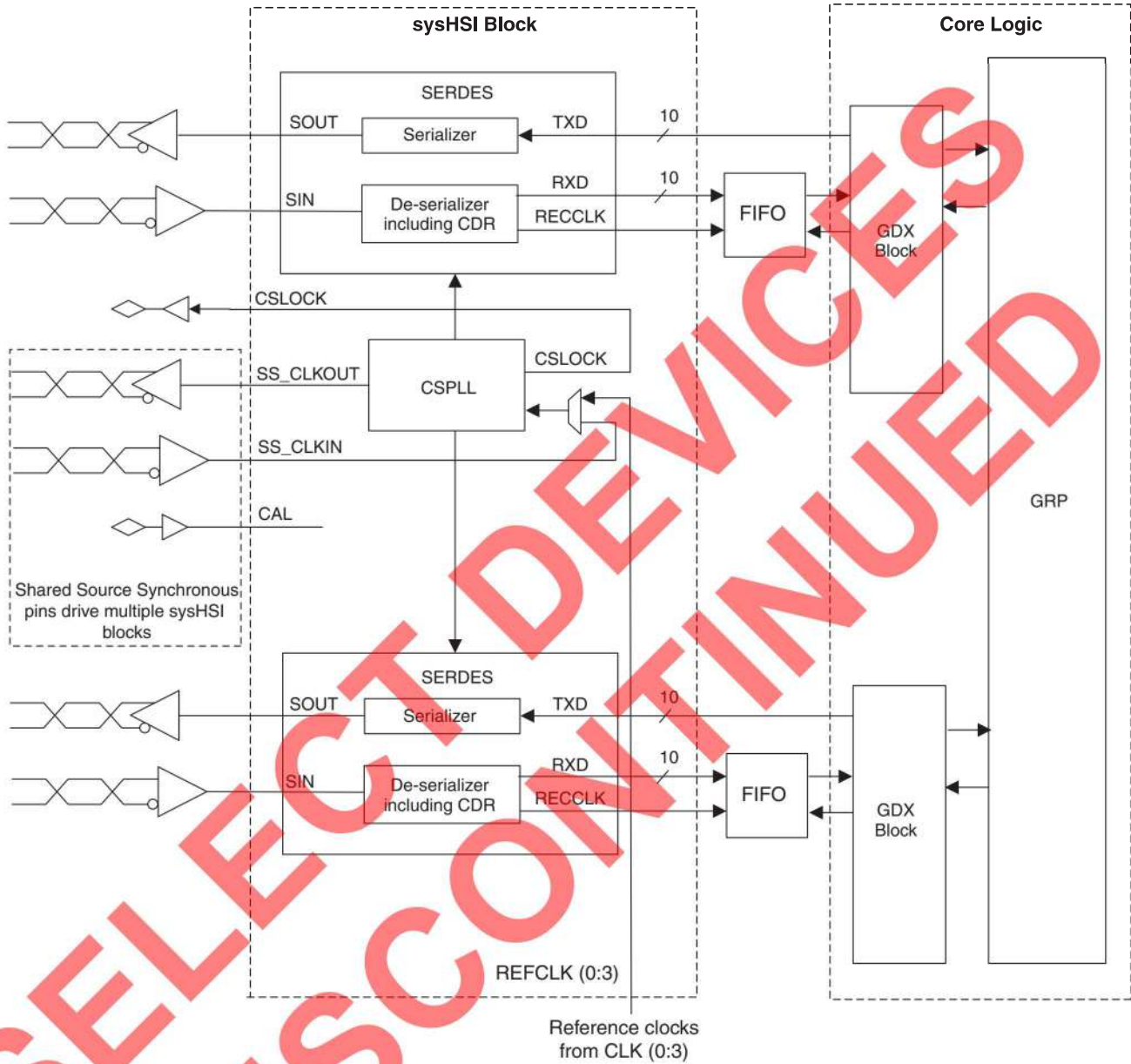
For more information on the SERDES/CDR, refer to Lattice technical note number TN1020, *sysHSI Usage Guidelines*.

Table 6. SERDES Signal Descriptions

| Signal | I/O | Description |
|-----------|----------|--|
| CDRRSTb | I | Resets the CDR circuit of sysHSI block |
| SYDT | O | Symbol alignment detect for sysHSI block |
| CAL | I | Initiates source synchronous calibration sequence |
| RXD | Internal | Parallel data in for sysHSI block |
| TXD | Internal | Parallel data out for sysHSI block |
| REFCLK | Internal | Reference clock received from the clock tree |
| SIN | I | Serial data input for sysHSI block (LVDS input) |
| SOUT | O | Serial data output for sysHSI block (LVDS output) |
| SS_CLKIN | I | Clock input for source synchronous group |
| SS_CLKOUT | O | Clock output for source synchronous group |
| RECCLK | Internal | Recovered clock from encoded data by CDR of sysHSI block |
| CSLOCK | Internal | Lock output of the PLL associated with sysHSI block |

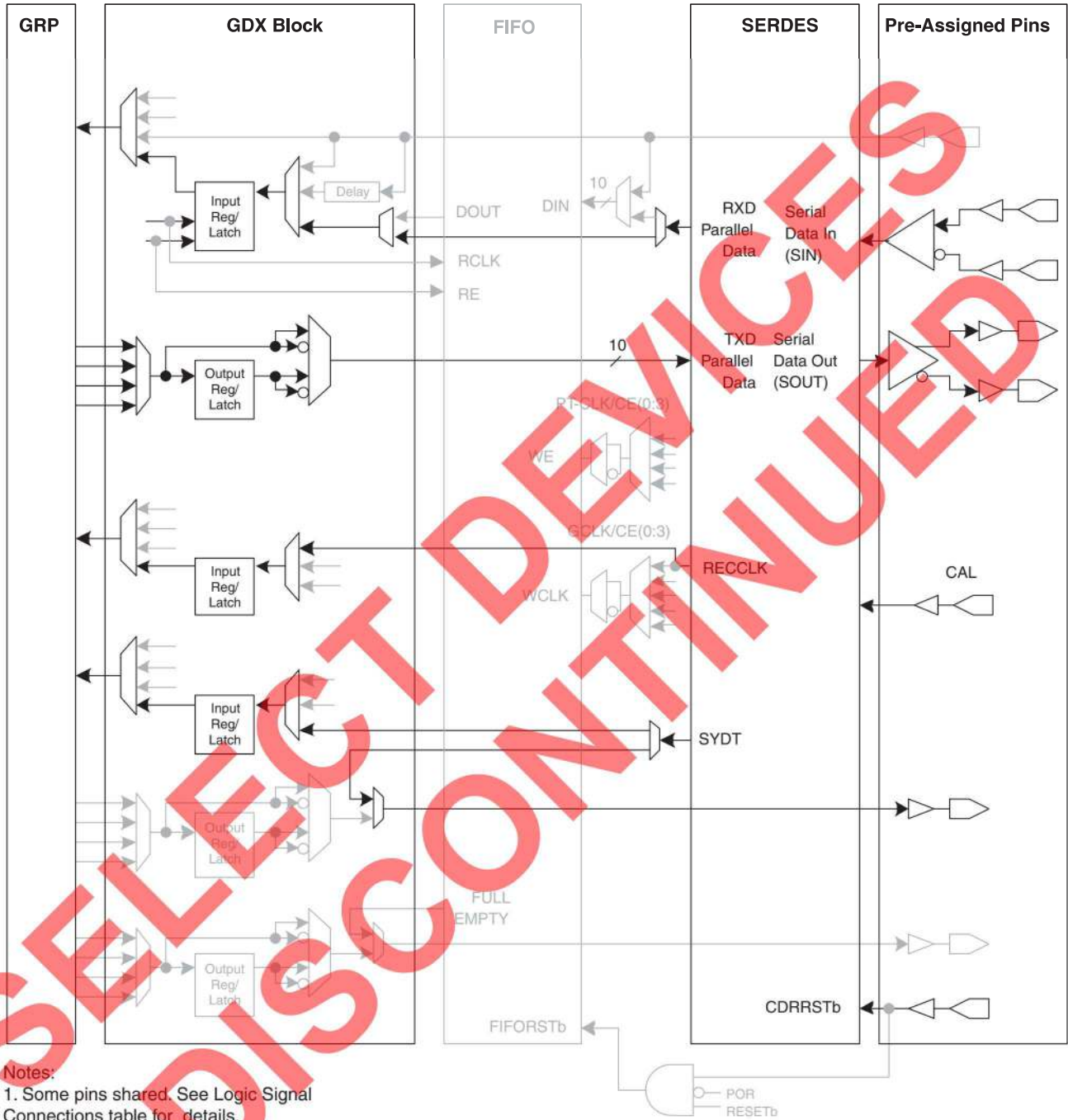
1. "E-Series" does not support sysHSI.

Figure 14. sysHSI Block with SERDES and FIFO



Note: Some pins are shared. See Logic Signal Connections table for details

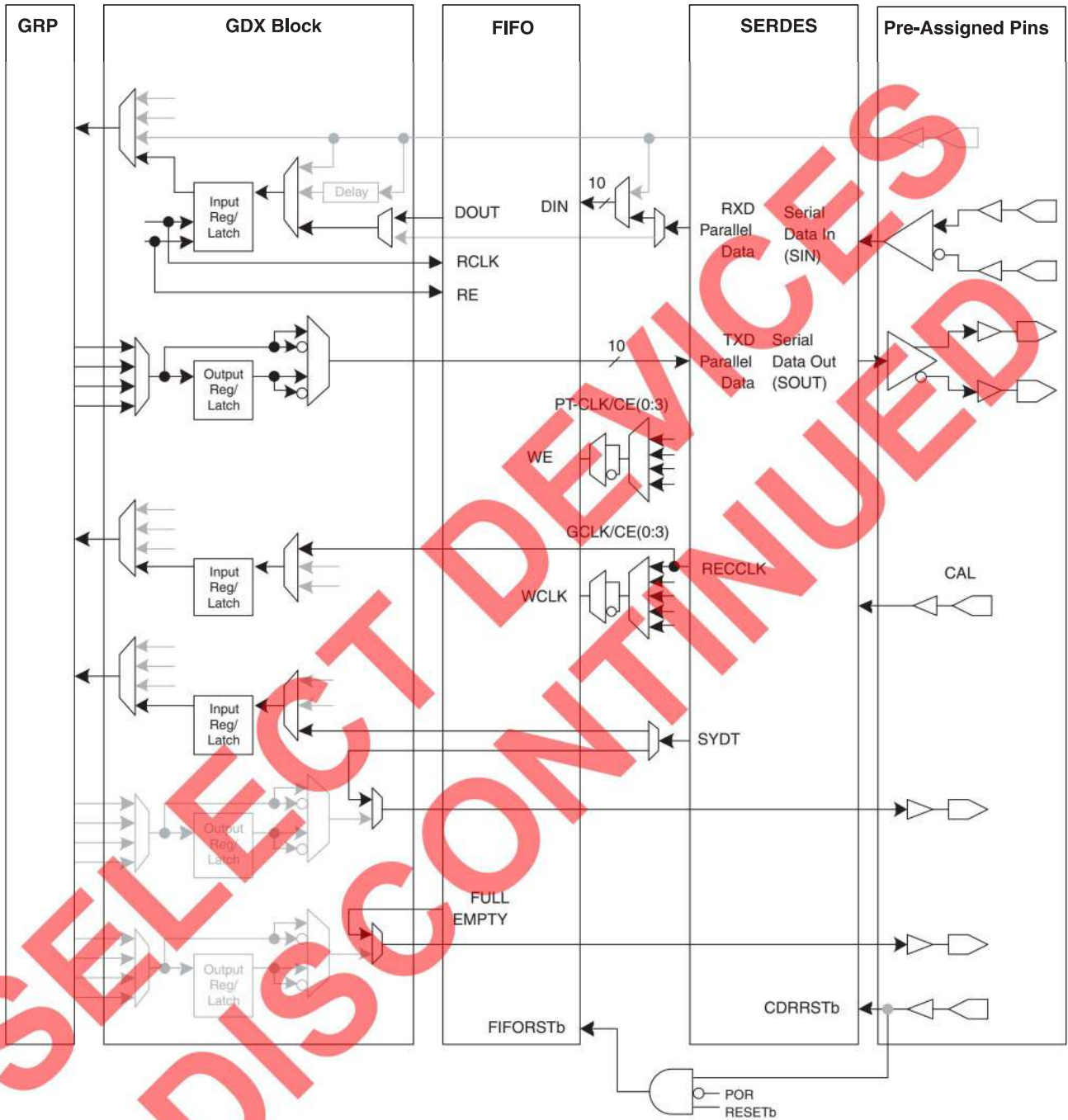
Figure 15. Operation in SERDES Only Mode^{1,2}



Notes:

1. Some pins shared. See Logic Signal Connections table for details.
2. For SERDES only mode programmable bit holds FIFO in reset. Input registers used for DOUT, and RECCLK configured as latches and held in pass through.

Figure 16. Operation in SERDES with FIFO Mode



IEEE 1149.1-Compliant Boundary Scan Testability

All ispGDX2 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port has its own supply voltage that can operate with LVCMOS3.3, 2.5 and 1.8 standards.

sysIO Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os' physical nature should be minimal so that board test time is minimized. The ispGDX2 family of devices allows this by offering the user the ability to quickly configure the physical nature of the sysIO cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice's ispVM™ System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

IEEE 1532-Compliant In-System Programming

In-system programming of devices provides a number of significant benefits including rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispGDX2 devices provide In-System Programming (ISP) capability through their Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains compliant to the IEEE 1532 standard. By using IEEE 1532 as the communication interface through which ISP is achieved, designers get the benefit of a standard, well defined interface.

The ispGDX2 devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispGDX2 devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispGDX2 devices during the testing of a circuit board.

Security Scheme

A programmable security scheme is provided on the ispGDX2 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this scheme prevents readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. The security scheme also prevents programming and verification. The entire device must be erased in order to reset the security scheme.

Hot Socketing

The ispGDX2 devices are well suited for those applications that require hot socketing capability. Hot socketing a device requires that the device, when powered down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of the powered-down device be minimal on active signals.

Absolute Maximum Ratings ^{1, 2, 3}

| | ispGDX2C (1.8V) | ispGDX2B/V (2.5/3.3V) |
|---|-----------------|-----------------------|
| Supply Voltage V_{CC} | -0.5 to 2.5V | -0.5 to 5.5V |
| PLL Supply Voltage V_{CCP} | -0.5 to 2.5V | -0.5 to 5.5V |
| Output Supply Voltage V_{CCO} | -0.5 to 4.5V | -0.5 to 4.5V |
| JTAG Supply Voltage (V_{CCJ}) | -0.5 to 4.5V | -0.5 to 4.5V |
| Input or I/O Tristate Voltage Applied ^{4, 5} | -0.5 to 5.5V | -0.5 to 5.5V |
| Storage Temperature | -65 to 150°C | -65 to 150°C |
| Junction Temp. (T_J) with Power Applied | -55 to 150°C | -55 to 150°C |

1. Stress above those listed under the Absolute Maximum Ratings may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied (while programming, following the programming specifications).
2. Compliance with the Lattice Thermal Management document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to (V_{IH} (MAX)+2) volts is permitted for a duration of <20ns.
5. A maximum of 64 I/Os per device with $V_{IN} > 3.6V$ is allowed.

Recommended Operating Conditions

| Symbol | Parameter | Min. | Max. | Units |
|-------------|---|------|------|-------|
| V_{CC} | Supply Voltage for 1.8V Devices ¹ | 1.65 | 1.95 | V |
| | Supply Voltage for 2.5V Devices | 2.3 | 2.7 | V |
| | Supply Voltage for 3.3V Devices | 3 | 3.6 | V |
| V_{CCP} | Supply Voltage for PLL and sysHSI Blocks, 1.8V Devices ¹ | 1.65 | 1.95 | V |
| | Supply Voltage for PLL and sysHSI Blocks, 2.5V Devices | 2.3 | 2.7 | V |
| | Supply Voltage for PLL and sysHSI Blocks, 3.3V Devices | 3 | 3.6 | V |
| V_{CCJ} | Power Supply Voltage for JTAG Programming 1.8V Operation | 1.65 | 1.95 | V |
| | Power Supply Voltage for JTAG Programming 2.5V Operation | 2.3 | 2.7 | V |
| | Power Supply Voltage for JTAG Programming 3.3V Operation | 3 | 3.6 | V |
| T_J (COM) | Junction Commercial Operation | 0 | 90 | °C |
| T_J (IND) | Junction Industrial Operation | -40 | 105 | °C |

1. sysHSI specification is valid for V_{CC} and $V_{CCP} = 1.7V$ to 1.9V.

Erase Reprogram Specifications

| Parameter | Min | Max | Units |
|-----------------------|-------|-----|--------|
| Erase/Reprogram Cycle | 1,000 | — | Cycles |

Note: Valid over commercial temperature range.

Hot Socketing Specifications ^{1, 2, 3}

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|-----------------------|--|---------------------------|-----|-------|--------|---------|
| I_{DK} ⁴ | Input or Tristated I/O Leakage Current | $0 \leq V_{IN} \leq 3.0V$ | — | +/-50 | +/-800 | μA |

1. Insensitive to sequence of V_{CC} and V_{CCO} . However, assumes monotonic rise/fall rates for V_{CC} and V_{CCO} , provided $(V_{IN} - V_{CCO}) \leq 3.6V$.
2. LVTTTL, LVCMOS only.
3. $0 < V_{CC} \leq V_{CC} (MAX)$, $0 < V_{CCO} \leq V_{CCO} (MAX)$.
4. I_{DK} is additive to I_{PU} , I_{PD} or I_{BH} . Device defaults to pull-up until fuse circuitry is active.

DC Electrical Characteristics

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|--------------------|---------------------------------------|--|------------------|------|------------------|---------|
| I_{IL}, I_{IH}^1 | Input or I/O Low Leakage | $0 \leq V_{IN} \leq (V_{CCO} - 0.2V)$ | — | — | 10 | μA |
| | | $(V_{CCO} - 0.2V) < V_{IN} \leq 3.6V$ | — | — | 30 | μA |
| I_{IH}^3 | Input High Leakage Current | $3.6V < V_{IN} \leq 5.5V$ and $3.0V \leq V_{CCO} \leq 3.6V$ | — | — | 3 | mA |
| I_{PU} | I/O Active Pull-up Current | $0 \leq V_{IN} \leq 0.7 V_{CCO}$ | -30 | — | -150 | μA |
| I_{PD} | I/O Active Pull-down Current | $V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$ | 30 | — | 150 | μA |
| I_{BHLS} | Bus Hold Low Sustaining Current | $V_{IN} = V_{IL} (MAX)$ | 30 | — | — | μA |
| I_{BHHS} | Bus Hold High Sustaining Current | $V_{IN} = 0.7 V_{CCO}$ | -30 | — | — | μA |
| I_{BHLO} | Bus Hold Low Overdrive Current | $0 \leq V_{IN} \leq V_{IH} (MAX)$ | — | — | 150 | μA |
| I_{BHLH} | Bus Hold High Overdrive Current | $0 \leq V_{IN} \leq V_{IH} (MAX)$ | — | — | -150 | μA |
| V_{BHT} | Bus Hold Trip Points | | $V_{CCO} * 0.35$ | — | $V_{CCO} * 0.65$ | V |
| C_1 | I/O Capacitance ² | $V_{CCO} = 3.3V, 2.5V, 1.8V$ | — | 8 | — | pf |
| | | $V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (MAX)$ | — | — | — | |
| C_2 | Clock Capacitance ² | $V_{CCO} = 3.3V, 2.5V, 1.8V$ | — | 6 | — | pf |
| | | $V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (MAX)$ | — | — | — | |
| C_3 | Global Input Capacitance ² | $V_{CCO} = 3.3V, 2.5V, 1.8V$ | — | 6 | — | pf |
| | | $V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (MAX)$ | — | — | — | |

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. $T_A = 25^\circ C$, $f = 1.0MHz$.

3. 5V tolerant inputs and I/Os should be placed in banks where $3.0V \leq V_{CCO} \leq 3.6V$. The JTAG ports are not included for the 5V tolerant interface.

Supply Current

Over Recommended Operating Conditions (ispGDX2-256)⁴

| Symbol | Description | Power Pins | Vcc (V) | Min. | Typ. | Max. | Units |
|----------------|--|------------|---------|------|-------|---------|-------|
| $I_{CC}^{1,2}$ | Core Logic Power Supply Current | V_{CC} | 3.3 | — | 59.6 | — | mA |
| | | | 2.5 | — | 58.7 | — | mA |
| | | | 1.8 | — | 60.0 | — | mA |
| | GPLL/sysHSI Logic Power Supply Current | | 3.3 | — | 118.7 | — | mA |
| | | | 2.5 | — | 118.7 | — | mA |
| | | | 1.8 | — | 117.5 | — | mA |
| I_{CCP}^2 | GPLL/sysHSI CSPLL Power Supply Current | V_{CCP} | 3.3 | — | 14.7 | — | mA |
| | | 2.5 | — | 14.7 | — | mA | |
| | | 1.8 | — | 17.4 | — | mA | |
| I_{CCO}^3 | Bank Power Supply Current | V_{CCO} | 3.3 | — | 35 | — | mA |
| | | 2.5 | — | 35 | — | mA | |
| | | 1.8 | — | 25 | — | mA | |
| I_{CCJ} | JTAG Programming Current | V_{CCJ} | 3.3 | — | 1.5 | — | mA |
| | | 2.5 | — | 1.0 | — | mA | |
| | | 1.8 | — | 800 | — | μA | |

1. 64-input switching frequency at 20 MHz, with one GRP fanout.

2. One GPLL with $f_{VCO} = 400$ MHz and one sysHSI Block (two receivers and two transmitters) at 622 MHz data rate.

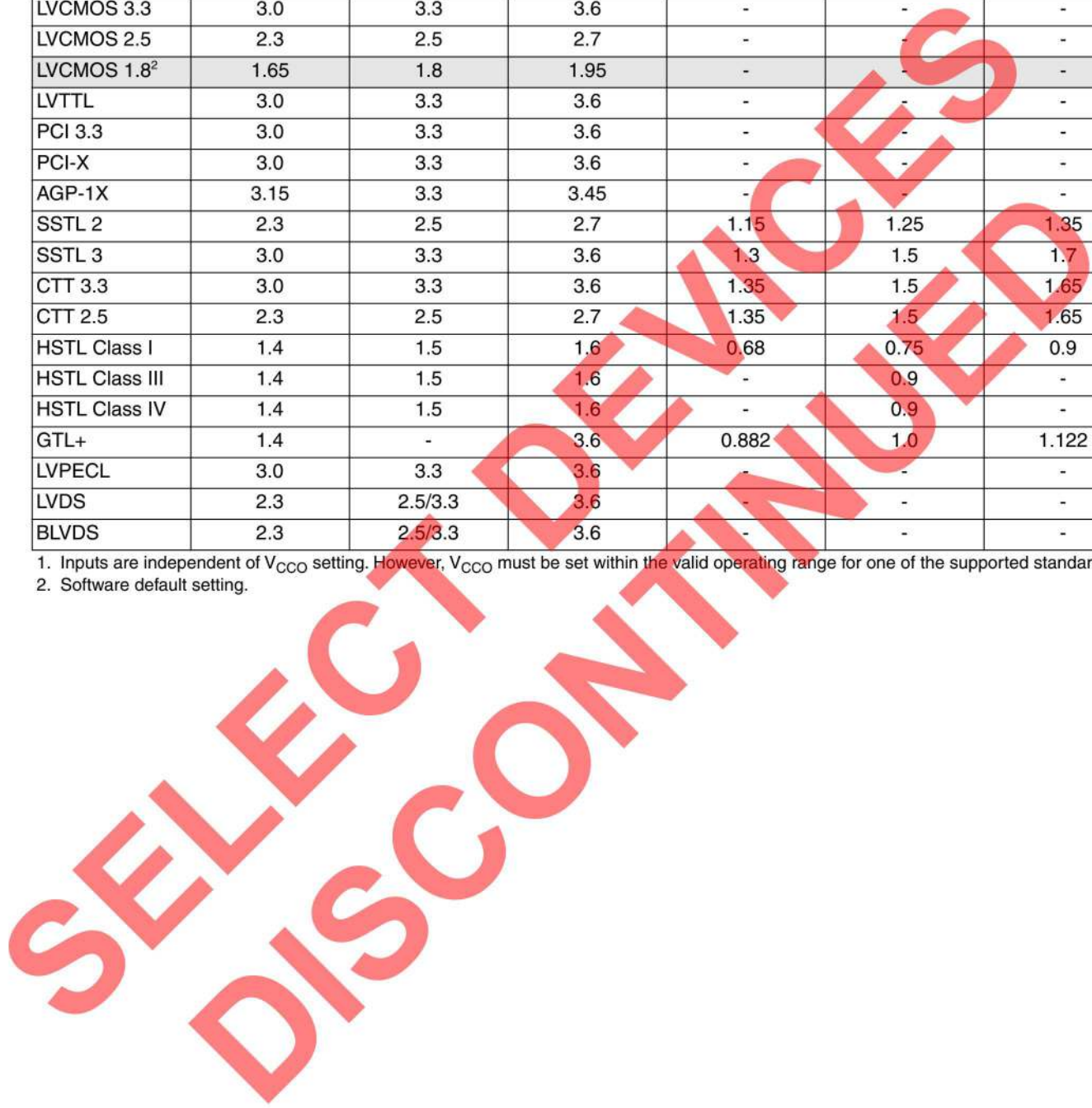
3. All 8-bank reference circuit currents, all I/Os in tristate, inputs held at valid logic levels, and bus maintenance circuits disabled.

4. $T_A = 25^\circ C$

sysIO Recommended Operating Conditions

| Standard | V _{CCO} (V) ¹ | | | V _{REF} (V) | | |
|--------------------------|-----------------------------------|---------|------|----------------------|------|-------|
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| LVC MOS 3.3 | 3.0 | 3.3 | 3.6 | - | - | - |
| LVC MOS 2.5 | 2.3 | 2.5 | 2.7 | - | - | - |
| LVC MOS 1.8 ² | 1.65 | 1.8 | 1.95 | - | - | - |
| LV TTL | 3.0 | 3.3 | 3.6 | - | - | - |
| PCI 3.3 | 3.0 | 3.3 | 3.6 | - | - | - |
| PCI-X | 3.0 | 3.3 | 3.6 | - | - | - |
| AGP-1X | 3.15 | 3.3 | 3.45 | - | - | - |
| SSTL 2 | 2.3 | 2.5 | 2.7 | 1.15 | 1.25 | 1.35 |
| SSTL 3 | 3.0 | 3.3 | 3.6 | 1.3 | 1.5 | 1.7 |
| CTT 3.3 | 3.0 | 3.3 | 3.6 | 1.35 | 1.5 | 1.65 |
| CTT 2.5 | 2.3 | 2.5 | 2.7 | 1.35 | 1.5 | 1.65 |
| HSTL Class I | 1.4 | 1.5 | 1.6 | 0.68 | 0.75 | 0.9 |
| HSTL Class III | 1.4 | 1.5 | 1.6 | - | 0.9 | - |
| HSTL Class IV | 1.4 | 1.5 | 1.6 | - | 0.9 | - |
| GTL+ | 1.4 | - | 3.6 | 0.882 | 1.0 | 1.122 |
| LVPECL | 3.0 | 3.3 | 3.6 | - | - | - |
| LVDS | 2.3 | 2.5/3.3 | 3.6 | - | - | - |
| BLVDS | 2.3 | 2.5/3.3 | 3.6 | - | - | - |

1. Inputs are independent of V_{CCO} setting. However, V_{CCO} must be set within the valid operating range for one of the supported standards.
 2. Software default setting.



sysIO Single Ended DC Electrical Characteristics
Over Recommended Operating Conditions

| Input/Output Standard | V _{IL} | | V _{IH} | | V _{OL} Max (V) | V _{OH} Min (V) | I _{OL} ² (mA) | I _{OH} ² (mA) |
|---------------------------|-----------------|-------------------------|-------------------------|---------|-------------------------|-------------------------|-----------------------------------|-----------------------------------|
| | Min (V) | Max (V) | Min (V) | Max (V) | | | | |
| LVCMOS 3.3 | -0.3 | 0.8 | 2.0 | 5.5 | 0.4 | 2.4 | 20, 16, 12, 8, 5.33, 4 | -20, -16, -12, -8, -5.33, -4 |
| | | | | | 0.2 | V _{CCO} - 0.2 | 0.1 | -0.1 |
| LVTTTL | -0.3 | 0.8 | 2.0 | 5.5 | 0.4 | 2.4 | 4 | -4 |
| | | | | | 0.2 | V _{CCO} - 0.2 | 0.1 | -0.1 |
| LVCMOS 2.5 | -0.3 | 0.7 | 1.7 | 3.6 | 0.4 | V _{CCO} - 0.4 | 16, 12, 8, 5.33, 4 | -16, -12, -8, -5.33, -4 |
| | | | | | 0.2 | V _{CCO} - 0.2 | 0.1 | -0.1 |
| LVCMOS 1.8 ^{1,3} | -0.3 | 0.68 | 1.07 | 3.6 | 0.4 | V _{CCO} - 0.4 | 8 | -8 |
| LVCMOS 1.8 ³ | -0.3 | 0.68 | 1.07 | 3.6 | 0.4 | V _{CCO} - 0.4 | 12, 5.33, 4 | -12, -5.33, -4 |
| | | | | | 0.2 | V _{CCO} - 0.2 | 0.1 | -0.1 |
| PCI 3.3 ⁴ | -0.3 | 1.08 | 1.5 | 3.6 | 0.1 V _{CCO} | 0.9 V _{CCO} | 1.5 | -0.5 |
| PCI -X ⁵ | -0.3 | 1.26 | 1.5 | 3.6 | 0.1 V _{CCO} | 0.9 V _{CCO} | 1.5 | -0.5 |
| AGP-1X ⁴ | -0.3 | 1.08 | 1.5 | 3.6 | 0.1 V _{CCO} | 0.9 V _{CCO} | 1.5 | -0.5 |
| SSTL3 class I | -0.3 | V _{REF} - 0.2 | V _{REF} + 0.2 | 3.6 | 0.7 | V _{CCO} - 1.1 | 8 | -8 |
| SSTL3 class II | -0.3 | V _{REF} - 0.2 | V _{REF} + 0.2 | 3.6 | 0.5 | V _{CCO} - 0.9 | 16 | -16 |
| SSTL2 class I | -0.3 | V _{REF} - 0.18 | V _{REF} + 0.18 | 3.6 | 0.54 | V _{CCO} - 0.62 | 7.6 | -7.6 |
| SSTL2 class II | -0.3 | V _{REF} - 0.18 | V _{REF} + 0.18 | 3.6 | 0.35 | V _{CCO} - 0.43 | 15.2 | -15.2 |
| CTT 3.3 | -0.3 | V _{REF} - 0.2 | V _{REF} + 0.2 | 3.6 | V _{REF} - 0.4 | V _{REF} + 0.4 | 8 | -8 |
| CTT 2.5 | -0.3 | V _{REF} - 0.3 | V _{REF} + 0.2 | 3.6 | V _{REF} - 0.4 | V _{REF} + 0.4 | 8 | -8 |
| HSTL class I | -0.3 | V _{REF} - 0.1 | V _{REF} + 0.1 | 3.6 | 0.4 | V _{CCO} - 0.4 | 8 | -8 |
| HSTL class III | -0.3 | V _{REF} - 0.2 | V _{REF} + 0.1 | 3.6 | 0.4 | V _{CCO} - 0.4 | 24 | -8 |
| HSTL class IV | -0.3 | V _{REF} - 0.3 | V _{REF} + 0.1 | 3.6 | 0.4 | V _{CCO} - 0.4 | 48 | -8 |
| GTL+ | -0.3 | V _{REF} - 0.2 | V _{REF} + 0.2 | 3.6 | 0.6 | n/a | 36 | n/a |

1. Software default setting.
2. The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed n*8mA. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.
3. For 1.8V devices (ispGDX2C) these specifications are V_{IL} = 0.35 V_{CC} and V_{IH} = 0.65V_{CC}
4. For 1.8V power supply devices these specifications are V_{IL} = 0.3 * V_{CC} * 3.3/1.8, V_{IH} = 0.5 * V_{CC} * 3.3/1.8
5. For 1.8V power supply devices these specifications are V_{IL} = 0.35 * V_{CC} * 3.3/1.8 and V_{IH} = 0.5 * V_{CC} * 3.3/1.8

sysIO Differential DC Electrical Characteristics

Over Recommended Operating Conditions

| Parameter Symbol | Parameter Description | Test Conditions | Min. | Typ. | Max. | Units |
|-----------------------------|--|---|--------|------|-------|---------|
| LVDS | | | | | | |
| $V_{INP} V_{INM}$ | Input Voltage | — | 0 | — | 2.4 | V |
| V_{THD} | Differential Input Threshold | $0.2V \leq V_{CM} \leq 1.8V$ | +/-100 | — | — | mV |
| I_{IN} | Input Current | Power On | — | — | +/-10 | μA |
| V_{OH} | Output High Voltage for V_{OP} or V_{OM} | $R_T = 100\Omega$ | — | 1.38 | 1.60 | V |
| V_{OL} | Output Low Voltage for V_{OP} or V_{OM} | $R_T = 100\Omega$ | 0.9 | 1.03 | — | V |
| V_{OD} | Output Voltage Differential | $(V_{OP} - V_{OM}), R_T = 100\Omega$ | 250 | 350 | 450 | mV |
| ΔV_{OD} | Change in V_{OD} Between High and Low | — | — | — | 50 | mV |
| V_{OS} | Output Voltage Offset | $(V_{OP} - V_{OM})/2, R_T = 100\Omega$ | 1.125 | 1.25 | 1.375 | V |
| ΔV_{OS} | Change in V_{OS} Between H and L | — | — | — | 50 | mV |
| I_{OSD} | Output Short Circuit Current | $V_{OD} = 0V$. Driver Outputs Shorted. | — | — | 24 | mA |
| Bus LVDS¹ | | | | | | |
| V_{OH} | Output High Voltage for V_{OP} or V_{OM} | $R_T = 27\Omega$ | — | 1.4 | 1.80 | V |
| V_{OL} | Output Low Voltage for V_{OP} or V_{OM} | $R_T = 27\Omega$ | 0.95 | 1.1 | — | V |
| V_{OD} | Output Voltage Differential | $ V_{OP} - V_{OM} , R_T = 27\Omega$ | 240 | 300 | 460 | mV |
| ΔV_{OD} | Change in V_{OD} Between H and L | — | — | — | 27 | mV |
| V_{OS} | Output Voltage Offset | $ V_{OP} - V_{OM} / 2, R_T = 27\Omega$ | 1.1 | 1.3 | 1.5 | V |
| ΔV_{OS} | Change in V_{OS} Between H and L | — | — | — | 27 | mV |
| I_{OSD} | Output Short Circuit Current | $V_{OD} = 0$. Driver Outputs Shorted. | — | 36 | 65 | mA |

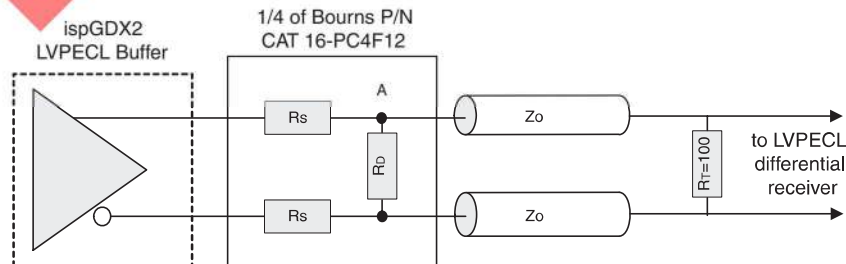
1. V_{OP} and V_{OM} are the two outputs of the LVDS output buffer.

LVPECL¹

| DC Parameter | Parameter Description | Min. | Max. | Min. | Max. | Min. | Max. | Units |
|--------------|----------------------------|------|-------|------|-------|------|-------|-------|
| V_{CCO} | Output Supply Voltage | 3.0 | — | 3.3 | — | 3.6 | — | V |
| V_{IH} | Input Voltage High | 1.49 | 2.72 | 1.49 | 2.72 | 1.49 | 2.72 | V |
| V_{IL} | Input Voltage Low | 0.86 | 2.125 | 0.86 | 2.125 | 0.86 | 2.125 | V |
| V_{OH} | Output Voltage High | 1.7 | 2.11 | 1.92 | 2.28 | 2.03 | 2.41 | V |
| V_{OL} | Output Voltage Low | 0.96 | 1.27 | 1.06 | 1.43 | 1.25 | 1.57 | V |
| V_{DIFF}^2 | Differential Input voltage | 0.3 | — | 0.3 | — | 0.3 | — | V |

- These values are valid at the output of the source termination pack as shown above with 100-ohm differential load only (see Figure 17). The V_{OH} levels are 200mV below the standard LVPECL levels and are compatible with devices tolerant of the lower common mode ranges.
- Valid for $0.2V \leq V_{CM} \leq 1.8V$.

Figure 17. LVPECL Driver with Three Resistor Pack



ispGDX2V/B/C, ispGDX2EV/EB/EC External Switching Characteristics Over Recommended Operating Conditions

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|------------------------------|---|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| Output Paths | | | | | | | | | | |
| t_{PD} | Data From Input Pin to Output Pin | — | 3.0 | — | 3.2 | — | 3.5 | — | 5.0 | ns |
| t_{PD_SEL} | Data From Global Select Pin to Output Pin | — | 2.8 | — | 3.0 | — | 3.3 | — | 4.7 | ns |
| t_{CO} | Global Clock to Output | — | 2.9 | — | 3.1 | — | 3.2 | — | 5.4 | ns |
| t_{OPS} | Set-up Time Before Global Clock | 2.0 | — | 2.0 | — | 2.0 | — | 3.0 | — | ns |
| t_{OPH} | Hold Time After Global Clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t_{OPCES} | PT Clock Enable Setup Time Before Global Clock | 3.0 | — | 3.0 | — | 4.1 | — | 6.9 | — | ns |
| t_{OPCEH} | PT Clock Enable Hold Time After Global Clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t_{OPRSTO} | External Reset Pin to Output Delay | — | 5.3 | — | 6.0 | — | 6.0 | — | 10.0 | ns |
| Input Paths | | | | | | | | | | |
| t_{IPS} | Set-up Time Before Global Clock | 0.5 | — | 0.5 | — | 0.5 | — | 0.9 | — | ns |
| t_{IPSZ} | Set-up Time Before Global Clock (Zero Hold Time) | 2.0 | — | 2.0 | — | 2.0 | — | 3.0 | — | ns |
| t_{IPH} | Hold Time After Global Clock | 1.0 | — | 1.0 | — | 1.0 | — | 1.7 | — | ns |
| t_{IPHZ} | Hold Time After Global Clock (Zero Hold Time) | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t_{IPCES} | PT Clock Enable Setup Time Before Global Clock | 3.1 | — | 3.1 | — | 3.1 | — | 5.1 | — | ns |
| t_{IPCEH} | PT Clock Enable Hold Time After Global Clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t_{IPRSTO} | External Reset Pin to Output Delay | — | 5.6 | — | 6.5 | — | 7.5 | — | 12.5 | ns |
| Output Enable Paths | | | | | | | | | | |
| t_{OECO} | Global Clock to Output Enabled Pin | — | 4.2 | — | 4.5 | — | 5.5 | — | 9.1 | ns |
| t_{OES} | Output Enable Register Set-up Time Before Global Clock | 1.6 | — | 1.6 | — | 2.0 | — | 3.4 | — | ns |
| t_{OEH} | Hold Time After Global Clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t_{OECES} | PT Clock Enable Setup Time Before Global Clock | 3.5 | — | 3.5 | — | 4.1 | — | 6.9 | — | ns |
| t_{OECEH} | PT Clock Enable Hold Time After Global Clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| $t_{GOE/DIS}$ | Global OE Input to Output Enable/Disable | — | 3.5 | — | 3.8 | — | 4.5 | — | 7.5 | ns |
| $t_{TOE/DIS}$ | Test OE Input to Output Enable/Disable | — | 5.2 | — | 5.5 | — | 6.2 | — | 10.3 | ns |
| $t_{EN/DIS}$ | Input to Output Enable/Disable | — | 5.2 | — | 5.5 | — | 6.2 | — | 10.3 | ns |
| Clock and Reset Paths | | | | | | | | | | |
| t_{RW} | Width of Reset Pulse | 2.5 | — | 2.5 | — | 2.5 | — | 4.1 | — | ns |
| t_{CW} | Clock Width | 1.3 | — | 1.5 | — | 1.6 | — | 2.7 | — | ns |
| t_{GW} | Clock Width | 1.5 | — | 1.6 | — | 1.6 | — | 2.7 | — | ns |
| $f_{MAX} (Ext)$ | Clock Frequency with External Feedback $1/(t_{OPS} + t_{CO})$ | — | 204 | — | 196 | — | 192 | — | 119 | MHz |
| $f_{MAX} (Tog, No PLL)$ | Clock Frequency Maximum Toggle (No PLL) | — | 360 | — | 330 | — | 300 | — | 180 | MHz |

ispGDX2V/B/C, ispGDX2EV/EB/EC External Switching Characteristics
 Over Recommended Operating Conditions

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|--------------------------------|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| f _{MAX} (Tog, PLL) | Clock Frequency Maximum Toggle (With PLL) | — | 360 | — | 330 | — | 300 | — | 180 | MHz |

Timing v.2.2

SELECT DEVICES
 DISCONTINUED

Timing Model

The task of determining the timing through the ispGDX2 family is relatively simple. The timing model provided in Figure 18 shows the specific delay paths. Once the implementation of a given function is determined either conceptually or from the software report file, the delay path of the function can easily be determined from the timing model. The Lattice design tools report the timing delays based on the same timing model for a particular design. Note that the internal timing parameters are given for reference only, and are not tested. The external timing parameters are tested and guaranteed for every device.

Figure 18. ispGDX2 Timing Model Diagram (I/O Cell)

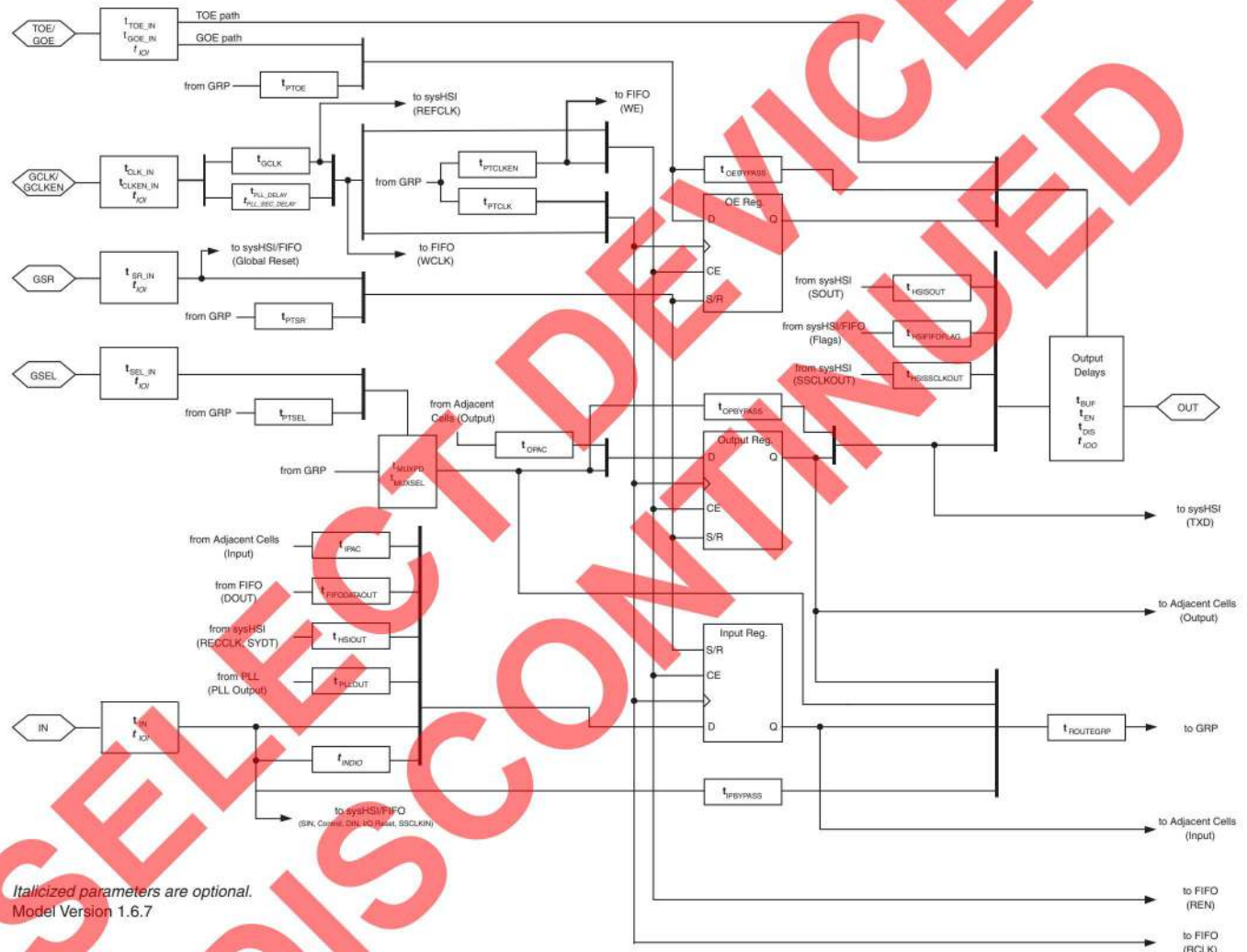


Figure 19. ispGDX2 Timing Model Diagram (with sysHSI and FIFO Receive Mode)

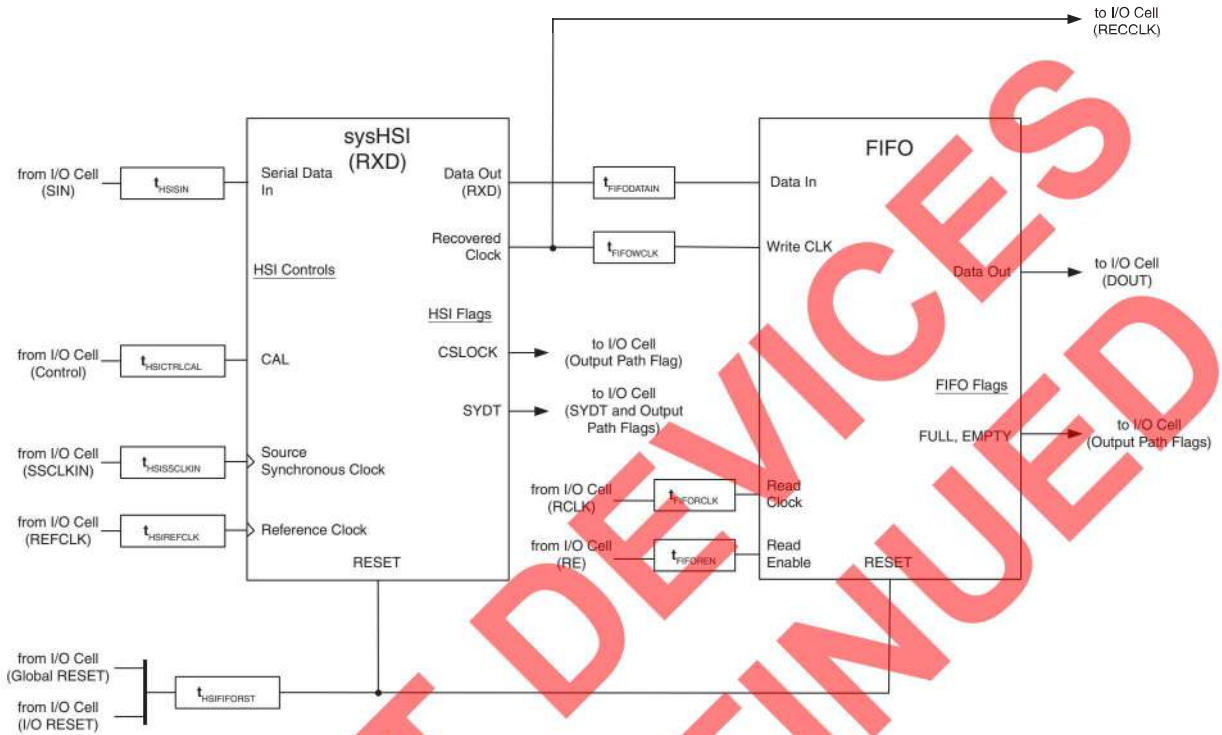


Figure 20. ispGDX2 Timing Model Diagram (with sysHSI Transmit Mode)

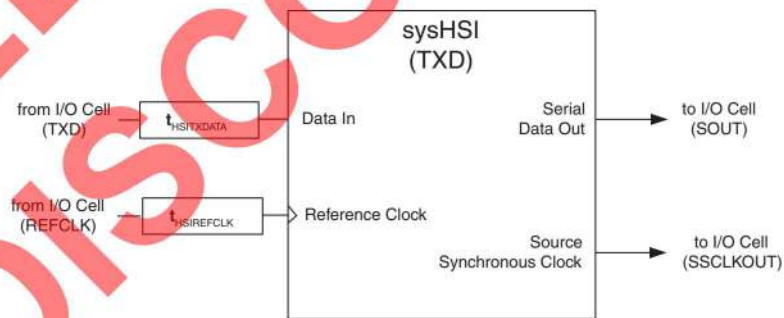
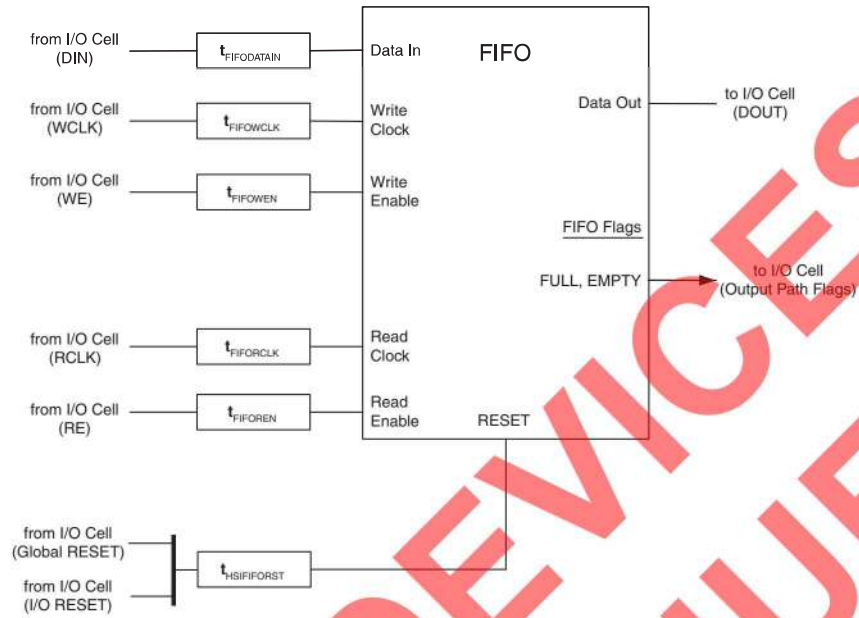


Figure 21. ispGDX2 Timing Model Diagram (in FIFO Only Mode)



SELECT DEVICES DISCONTINUED

Sample External Timing Calculations

The following equations illustrate the task of determining the timing through the ispGDX2 family. These are only a sample of equations to calculate the timing through the ispGDX2.

Figure 18 shows the specific delay paths and the Internal Timing Parameters table provides the parameter values. Note that the internal timing parameters are given for reference only and are not tested. The external timing parameters are tested and guaranteed for every device.

Data from global select pin to output pin:

$$t_{PD_SEL} = t_{SEL_IN} + t_{MUXSEL} + t_{OPBYPASS} + t_{BUF}$$

Global clock to output:

$$t_{CO} = t_{CLK_IN} + t_{GCLK} + t_{OPCOI} + t_{BUF}$$

Input register or latch set-up time before global clock:

$$t_{IPS} = t_{IN} + t_{IPS} - (t_{CLK} + t_{GCLK})$$

Input register or latch hold time after global clock:

$$t_{IPH} = (t_{CLK_IN} + t_{GCLK}) + t_{IPHi} - t_{IN}$$

Data from product term select to output pin:

$$t_{PD_PTSEL} = t_{IN} + t_{IPBYPASS} + t_{ROUTEGRP} + t_{PTSEL} + t_{MUXSEL} + t_{OPBYPASS} + t_{BUF}$$

Product term clock to output:

$$t_{CO_PT} = t_{IN} + t_{IPBYPASS} + t_{ROUTEGRP} + t_{PTCLK} + t_{OPCOI} + t_{BUF}$$

Input register or latch set-up time before product term clock:

$$t_{IPS_PT} = t_{IN} + t_{IPSi_PT} - (t_{IN} + t_{IPBYPASS} + t_{ROUTEGRP} + t_{PTCLK})$$

Input register or latch hold time after product term clock:

$$t_{IPH_PT} = (t_{IN} + t_{IPBYPASS} + t_{ROUTEGRP} + t_{PTCLK}) + t_{IPHi} - t_{IN}$$

Global OE input to output enable/disable:

$$t_{GOE/DIS} = t_{GOE_IN} + t_{OEByPASS} + t_{EN}$$

External reset pin to output delay:

$$t_{OPRSTO} = t_{SR_IN} + t_{OPASROI} + t_{BUF}$$

ispGDX2V/B/C, ispGDX2EV/EB/EC Internal Timing Parameters¹ Over Recommended Operating Conditions

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|--|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| Input/Output Delays | | | | | | | | | | |
| t _{BUF} | Output Buffer Delay | — | 0.80 | — | 0.80 | — | 0.80 | — | 1.14 | ns |
| t _{CLK_IN} | Global Clock Input Delay | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | ns |
| t _{CLKEN_IN} | Global Clock Enable Input Delay | — | 1.80 | — | 1.80 | — | 1.80 | — | 3.00 | ns |
| t _{DIS} | Output Disable Delay | — | 1.80 | — | 1.80 | — | 2.50 | — | 4.17 | ns |
| t _{EN} | Output Enable Delay | — | 1.50 | — | 1.80 | — | 2.50 | — | 4.17 | ns |
| t _{GOE_IN} | Global Output Enable Path Delay | — | 2.00 | — | 2.00 | — | 2.00 | — | 3.33 | ns |
| t _{IN} | Input Pin Delay | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.57 | ns |
| t _{SEL_IN} | Global MUX Select Input Delay | — | 1.60 | — | 1.60 | — | 1.60 | — | 2.29 | ns |
| t _{SR_IN} | Global Set/Reset Path Delay | — | 2.00 | — | 2.70 | — | 2.70 | — | 4.50 | ns |
| t _{TOE_IN} | Test Output Enable Path Delay | — | 3.70 | — | 3.70 | — | 3.70 | — | 6.17 | ns |
| Shift Register and MUX Delays | | | | | | | | | | |
| t _{IPAC} | Input Path Adjacent I/O Cell Delay (Shift Register) | — | 0.80 | — | 0.80 | — | 0.80 | — | 1.33 | ns |
| t _{OPAC} | Output Path Adjacent I/O Cell Delay (Shift Register) | — | 1.30 | — | 1.30 | — | 1.30 | — | 2.17 | ns |
| t _{MUXPD} | MUX Data Path Delay | — | 0.90 | — | 0.90 | — | 0.90 | — | 1.29 | ns |
| t _{MUXSEL} | MUX Select Path Delay | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.57 | ns |
| AND Arrays and Routing Delays | | | | | | | | | | |
| t _{FIFODATAOUT} | FIFO Output to I/O Block Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{GCLK} | Clock Tree Delay | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.67 | ns |
| t _{HSIFIFOFLAG} | HSI/FIFO Flag to I/O Block Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{HSIOUT} | HSI Output to I/O Cell Block Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{HSISSCLKOUT} | HSI Source Synchronous Clock to I/O Cell Block Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{PLL_DELAY} | PLL Delay Increment | — | 0.33 | — | 0.33 | — | 0.33 | — | 0.33 | ns |
| t _{PTCLK} | Clock AND Array Delay | — | 2.20 | — | 2.20 | — | 2.20 | — | 3.67 | ns |
| t _{PTCLKEN} | Clock Enable AND Array Delay | — | 2.10 | — | 2.10 | — | 2.10 | — | 3.50 | ns |
| t _{PTOE} | OE AND Array Delay | — | 2.40 | — | 2.40 | — | 2.40 | — | 4.00 | ns |
| t _{PTSEL} | Select AND Array Delay | — | 1.70 | — | 1.70 | — | 1.70 | — | 2.83 | ns |
| t _{PTSR} | Set/Reset AND Array Delay | — | 1.40 | — | 1.40 | — | 2.70 | — | 4.50 | ns |
| t _{ROUTEGRP} | Global Routing Pool Delay | — | 0.90 | — | 0.90 | — | 0.90 | — | 1.29 | ns |
| Register/Latch Delays, Output Paths | | | | | | | | | | |
| t _{OPASROi} | Asynchronous Set/Reset to Output | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| t _{OPASRRi} | Asynchronous Set/Reset Recovery | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| t _{OPBYPASS} | Register/Latch Bypass Delay | — | 0.00 | — | 0.20 | — | 0.50 | — | 0.71 | ns |
| t _{OPCEHi} | Register Clock Enable Hold Time | 1.30 | — | 1.30 | — | 1.30 | — | 2.17 | — | ns |
| t _{OPCESi} | Register Clock Enable Setup Time (Global Clock Enable) | 1.10 | — | 1.10 | — | 1.10 | — | 1.83 | — | ns |
| t _{OPCESi_PT} | Register Clock Enable Setup Time (Product Term Clock Enable) | 1.00 | — | 1.00 | — | 2.10 | — | 3.50 | — | ns |
| t _{OPCOi} | Register Clock to Output Delay | — | 0.70 | — | 0.90 | — | 1.00 | — | 1.67 | ns |
| t _{OPHi} | Register Hold Time | 0.80 | — | 0.80 | — | 0.80 | — | 1.33 | — | ns |

ispGDX2V/B/C, ispGDX2EV/EB/EC Internal Timing Parameters¹ (Continued)
 Over Recommended Operating Conditions

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|---|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{OPLGOi} | Latch Gate to Output Delay | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | ns |
| t _{OPLHi} | Latch Hold Time | 0.80 | — | 0.80 | — | 0.80 | — | 1.33 | — | ns |
| t _{OPLPDi} | Latch Propagation Delay (Transparent Mode) | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.50 | ns |
| t _{OPLSi} | Latch Setup Time (Global Gate) | 1.20 | — | 1.20 | — | 1.20 | — | 2.00 | — | ns |
| t _{OPLSi_PT} | Latch Setup Time (Product Term Gate) | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | — | ns |
| t _{OPSi} | Register Setup Time (Global Clock) | 1.20 | — | 1.20 | — | 1.20 | — | 2.00 | — | ns |
| t _{OPSi_PT} | Register Setup Time (Product Term Clock) | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | — | ns |
| t _{OPSRPWi} | Asynchronous Set/Reset Pulse Width | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| Register/Latch Delays, Input Paths | | | | | | | | | | |
| t _{iPASROi} | Asynchronous Set/Reset to Output | — | 1.00 | — | 1.00 | — | 1.70 | — | 2.83 | ns |
| t _{iPASRRi} | Asynchronous Set/Reset Recovery | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| t _{iPBYPASS} | Register/Latch Bypass Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{iPCEHi} | Register Clock Enable Hold Time | 1.30 | — | 1.30 | — | 1.30 | — | 2.17 | — | ns |
| t _{iPCESi} | Register Clock Enable Setup Time (Global Clock Enable) | 1.10 | — | 1.10 | — | 1.10 | — | 1.83 | — | ns |
| t _{iPCESi_PT} | Register Clock Enable Setup Time (Product Term Clock Enable) | 1.10 | — | 1.10 | — | 1.10 | — | 1.83 | — | ns |
| t _{iPCOi} | Register Clock to Output Delay | — | 0.80 | — | 1.00 | — | 1.00 | — | 1.67 | ns |
| t _{iPHi} | Register Hold Time | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| t _{iPLGOi} | Latch Gate to Output Delay | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | ns |
| t _{iPLHi} | Latch Hold Time | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| t _{iPLPDi} | Latch Propagation Delay (Transparent Mode) | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.50 | ns |
| t _{iPLSi} | Latch Setup Time (Global Term) | 1.50 | — | 1.50 | — | 1.50 | — | 2.50 | — | ns |
| t _{iPLSi_PT} | Latch Setup Time (Product Term Gate) | 1.50 | — | 1.50 | — | 1.50 | — | 2.50 | — | ns |
| t _{iPSi} | Register Setup Time (Global Clock) | 1.50 | — | 1.50 | — | 1.50 | — | 2.50 | — | ns |
| t _{iPSi_PT} | Register Setup Time (Product Term Clock) | 1.50 | — | 1.50 | — | 1.50 | — | 2.50 | — | ns |
| t _{iPSRPWi} | Asynchronous Set/Reset Pulse Width | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| OE Paths | | | | | | | | | | |
| t _{OEASROi} | Asynchronous Set/Reset to Output | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| t _{OEASRRi} | Asynchronous Set/Reset Recovery | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |
| t _{OEByPASS} | Register/Latch Bypass Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{OECEHi} | Register Clock Enable Hold Time | 1.30 | — | 1.30 | — | 0.80 | — | 1.33 | — | ns |
| t _{OECESi} | Register Clock Enable Setup Time (Global Clock Enable) | 1.20 | — | 1.20 | — | 1.20 | — | 2.00 | — | ns |
| t _{OECESi_PT} | Register Clock Enable Setup Time (Product Term Clock Enable) | 1.50 | — | 1.50 | — | 2.10 | — | 3.50 | — | ns |
| t _{OECoI} | Register Clock to Output Delay | — | 1.30 | — | 1.30 | — | 1.60 | — | 2.67 | ns |
| t _{OEHi} | Register Hold Time | 0.40 | — | 0.40 | — | 0.40 | — | 0.67 | — | ns |
| t _{OEiLGOi} | Latch Gate to Output Delay | — | 1.60 | — | 1.60 | — | 1.60 | — | 2.67 | ns |
| t _{OEiLHi} | Latch Hold Time | 0.40 | — | 0.40 | — | 0.40 | — | 0.67 | — | ns |
| t _{OEiLPDi} | Latch Propagation Delay (Transparent Mode) | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.50 | ns |

ispGDX2V/B/C, ispGDX2EV/EB/EC Internal Timing Parameters¹ (Continued)
Over Recommended Operating Conditions

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|----------------------|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{OELSi} | Latch Setup Time (Global Gate) | 1.40 | — | 1.40 | — | 1.40 | — | 2.33 | — | ns |
| t _{OELSLPT} | Latch Setup Time (Product Term Gate) | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | — | ns |
| t _{OESi} | Register Setup Time (Global Clock) | 1.00 | — | 1.00 | — | 1.40 | — | 2.33 | — | ns |
| t _{OESi_PT} | Register Setup Time (Product Term Clock) | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | — | ns |
| t _{OESRPWi} | Asynchronous Set/Reset Pulse Width | — | 2.50 | — | 2.50 | — | 2.50 | — | 4.17 | ns |

Timing v.2.2

1. Internal parameters are not tested and are for reference only. Refer to the timing model in this data sheet for details.
2. t_{PLL_DELAY} is the unit of increment by which the clock signal can be incremented. The PLL can adjust the clock signal by up to t_{PLLRANGE} (as given in the sysCLOCK PLL Timing section) in either direction in steps of size t_{PLL_DELAY}.

SELECTED DEVICES DISCONTINUED

ispGDX2V/B/C, ispGDX2EV/EB/EC Timing Adjusters

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|---|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| Optional Adders | | | | | | | | | | |
| t _{INDIO} | Input Delay | — | 1.50 | — | 1.50 | — | 1.50 | — | 2.50 | ns |
| t _{PLL_SEC_DELAY} | Secondary PLL Output Delay | — | 1.30 | — | 1.30 | — | 1.30 | — | 1.30 | ns |
| t₁₀₀ Output Adjusters | | | | | | | | | | |
| Slow Slew | Using Slow Slew (LVTTTL and LVCMOS Outputs Only) | — | 0.90 | — | 0.90 | — | 0.90 | — | 0.90 | ns |
| LVTTTL_out | Using 3.3V TTL Drive | — | 1.20 | — | 1.20 | — | 1.20 | — | 1.20 | ns |
| LVCMOS_18_4mA_out | Using 1.8V CMOS Standard, 4mA Drive | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.30 | ns |
| LVCMOS_18_5.33mA_out | Using 1.8V CMOS Standard, 5.33mA Drive | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.30 | ns |
| LVCMOS_18_8mA_out | Using 1.8V CMOS Standard, 8mA Drive | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| LVCMOS_18_12mA_out | Using 1.8V CMOS Standard, 12mA Drive | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| LVCMOS_25_4mA_out | Using 2.5V CMOS Standard, 4mA Drive | — | 1.20 | — | 1.20 | — | 1.20 | — | 1.20 | ns |
| LVCMOS_25_5.33mA_out | Using 2.5V CMOS Standard, 5.33mA Drive | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| LVCMOS_25_8mA_out | Using 2.5V CMOS Standard, 8mA Drive | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.40 | ns |
| LVCMOS_25_12mA_out | Using 2.5V CMOS Standard, 12mA Drive | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.40 | ns |
| LVCMOS_25_16mA_out | Using 2.5V CMOS Standard, 16mA Drive | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.40 | ns |
| LVCMOS_33_4mA_out | Using 3.3V CMOS Standard, 4mA Drive | — | 1.20 | — | 1.20 | — | 1.20 | — | 1.20 | ns |
| LVCMOS_33_5.33mA_out | Using 3.3V CMOS Standard, 5.33mA Drive | — | 1.20 | — | 1.20 | — | 1.20 | — | 1.20 | ns |
| LVCMOS_33_8mA_out | Using 3.3V CMOS Standard, 8mA Drive | — | 0.80 | — | 0.80 | — | 0.80 | — | 0.80 | ns |
| LVCMOS_33_12mA_out | Using 3.3V CMOS Standard, 12mA Drive | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS_33_16mA_out | Using 3.3V CMOS Standard, 16mA Drive | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS_33_20mA_out | Using 3.3V CMOS Standard, 20mA Drive | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.30 | ns |
| AGP_1X_out | Using AGP 1x Standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| BLVDS_out | Using Bus Low Voltage Differential Signaling (BLVDS) | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| CTT25_out | Using CTT 2.5v | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.30 | ns |
| CTT33_out | Using CTT 3.3v | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| GTL+_out | Using GTL+ | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| HSTL_I_out | Using HSTL 2.5V, Class I | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| HSTL_III_out | Using HSTL 2.5V, Class III | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| HSTL_IV_out | Using HSTL 2.5V, Class IV | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |

ispGDX2V/B/C, ispGDX2EV/EB/EC Timing Adjusters (Continued)

| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|--|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| LVPECL_out | Using LVPECL Differential Signaling | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.30 | ns |
| LVDS_out | Using Low Voltage Differential Signaling (LVDS) | — | 0.80 | — | 0.80 | — | 0.80 | — | 0.80 | ns |
| PCI_out | Using PCI Standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| PCI_X_out | Using PCI-X Standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| SSTL2_I_out | Using SSTL 2.5V, Class I | — | 0.30 | — | 0.30 | — | 0.30 | — | 0.30 | ns |
| SSTL2_II_out | Using SSTL 2.5V, Class II | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| SSTL3_I_out | Using SSTL 3.3V, Class I | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| SSTL3_II_out | Using SSTL 3.3V, Class II | — | 0.40 | — | 0.40 | — | 0.40 | — | 0.40 | ns |
| t_{IOI} Input Adjusters | | | | | | | | | | |
| LVTTL_in | Using 3.3V TTL | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| LVCNOS_18_in | Using 1.8V CMOS | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| LVCNOS_25_in | Using 2.5V CMOS | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| LVCNOS_33_in | Using 3.3V CMOS | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| AGP_1X_in | Using AGP 1x | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| BLVDS_in | Using Bus Low Voltage Differential Signaling (BLVDS) | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| CTT25_in | Using CTT 2.5V | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| CTT33_in | Using CTT 3.3V | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| GTL+_in | Using GTL+ | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| HSTL_I_in | Using HSTL 2.5V, Class I | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| HSTL_III_in | Using HSTL 2.5V, Class III | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| HSTL_IV_in | Using HSTL 2.5V, Class IV | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVPECL_in | Using Differential Signaling (LVPECL) | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| LVDS_in | Using Low Voltage Differential Signaling (LVDS) | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| PCI_in | Using PCI | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| PCI_X_in | Using PCI-X | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| SSTL2_I_in | Using SSTL 2.5V, Class I | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| SSTL2_II_in | Using SSTL 2.5V, Class II | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.50 | ns |
| SSTL3_I_in | Using SSTL 3.3V, Class I | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| SSTL3_II_in | Using SSTL 3.3V, Class II | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |

Timing v.2.2

ispGDX2V/B/C, ispGDX2EV/EB/EC FIFO Internal Timing

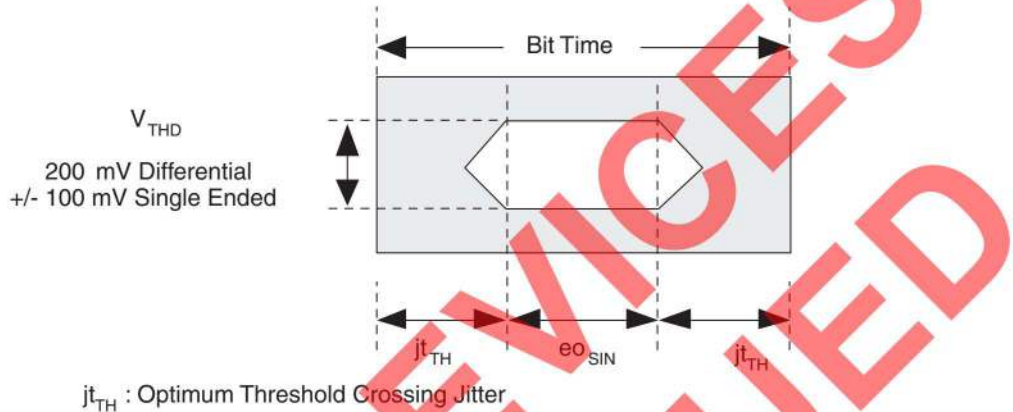
| Parameter | Description | -3 | | -32 | | -35 | | -5 | | Units |
|--------------------------|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| Routing Delays | | | | | | | | | | |
| t _{FIFODATAIN} | FIFO Input Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFODATAOUT} | FIFO Output to I/O Core Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFORCLK} | Read Clock Input Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFOREN} | Read Clock Enable Input Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFOWCLK} | Write Clock Input Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFOWEN} | Write Clock Enable Input Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| Core Delays | | | | | | | | | | |
| t _{FIFOCLKSKEW} | Global Read Clock to Write Clock Skew | — | 2.00 | — | 2.00 | — | 2.00 | — | 3.33 | ns |
| t _{FIFOEMPTY} | Read Clock to Empty Flag Delay | — | 1.30 | — | 1.80 | — | 1.80 | — | 3.00 | ns |
| t _{FIFOFULL} | Write Clock to Full Flag Delay | — | 1.30 | — | 1.80 | — | 1.80 | — | 3.00 | ns |
| t _{FIFORCEH} | Read Clock Hold after Read Clock Enable Time | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFORCES} | Read Clock Setup before Read Clock Enable Time | — | 1.50 | — | 1.50 | — | 1.50 | — | 2.50 | ns |
| t _{FIFORCLKO} | Read Clock to FIFO Out Delay | — | 0.50 | — | 0.50 | — | 0.50 | — | 0.83 | ns |
| t _{FIFORSTO} | Reset to Output Delay | — | 0.70 | — | 0.70 | — | 0.70 | — | 1.17 | ns |
| t _{FIFORSTPW} | Reset Pulse Width | — | 2.00 | — | 2.00 | — | 2.00 | — | 3.33 | ns |
| t _{FIFORSTR} | Reset Recovery Time | — | 1.20 | — | 1.50 | — | 2.00 | — | 3.33 | ns |
| t _{FIFOSTRD} | Write Clock to Start Read Flag Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFOTHRU} | Flow Through Delay | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFOWCEH} | Write Clock hold after Write Clock Enable Time | — | 2.00 | — | 2.00 | — | 2.00 | — | 3.33 | ns |
| t _{FIFOWCES} | Write Clock Setup before Write Clock Enable Time | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| t _{FIFOWCLKH} | Write Data Hold after Write Clock Time | — | 0.50 | — | 0.50 | — | 0.70 | — | 1.17 | ns |
| t _{FIFOWCLKS} | Write Data Setup before Write Clock Time | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.67 | ns |

Timing v.2.2

sysHSI Block Timing

Figure 22 provides a graphical representation of the SERDES receiver input requirements. It provides guidance on a number of input parameters, including signal amplitude and rise time limits, noise and jitter limits, and P and N input skew tolerance.

Figure 22. Receive Data Eye Diagram Template (Differential)



The data pattern eye opening at the receive end of a link is considered the ultimate measure of received signal quality. Almost all detrimental characteristics of a transmit signal and the interconnection link design result in eye closure. This combined with the eye-opening limitations of the line receiver can provide a good indication of a link’s ability to transfer error-free data.

Signal jitter is of special interest to system designers. It is often the primary limiting characteristic of long digital links and of systems with high noise level environments. An interesting characteristic of the clock and data recovery (CDR) portion of the ispGDX2 SERDES receiver is its ability to filter incoming signal jitter that is below the clock recovery PLL bandwidth. For signals with high levels of low frequency jitter, the receiver can detect incoming data error free, with eye openings significantly less than that shown in Figure 22.

sysHSI Block AC Specifications

Operating Frequency Ranges

| Symbol | Description | Mode | Test Condition | Min. | Max. | Units |
|--------------------------------|---------------------------|--------|---|------|------------------|-------|
| f _{CLK} | Reference Clock Frequency | SS:CAL | | 50 | 200 | MHz |
| | | 10B12B | | 33 | 67 | MHz |
| | | 8B10B | | 40 | 80 | MHz |
| f _{SIN} ² | Serial Input | SS:CAL | with e _{oSIN} | 400 | 800 ¹ | Mbps |
| | | 10B12B | with e _{oSIN} | 400 | 800 ¹ | Mbps |
| | | 8B10B | with e _{oSIN} | 400 | 800 ¹ | Mbps |
| f _{SOUT} ² | Serial Out | LVDS | C _L = 5 pF, R _L = 100 Ohms, f _{CLK} with no jitter | 400 | 800 ¹ | Mbps |

1. f_{SIN} (8B/10B and 10B/12B) 800Mbps limit applicable only to the fastest speed grade. Limit is 700Mbps for the lower speed grade.
 2. f_{SIN} and f_{SOUT} speeds are supported at V_{CC} and V_{CCP} at 1.7V to 1.9V for ispGDX2C devices.

LOCKIN Time

| Symbol | Description | Mode | Condition | Min. | Max. | Units |
|---------------|----------------------------|--------|---------------------------|------|------|-------------|
| t_{SCLOCK} | CSPLL Lock Time | All | After input is stabilized | | 25 | μ S |
| $t_{CDRLOCK}$ | CDRPLL Lock-in Time | SS | With SS mode sync pattern | | 1024 | t_{RCP}^1 |
| | | 10B12B | With 10B12B sync pattern | | 1024 | t_{RCP} |
| | | 8B10B | With 8B10B idle pattern | | 960 | t_{RCP} |
| t_{SYNC} | SyncPat Length | SS | | 1200 | | t_{RCP} |
| t_{CAL} | CAL Duration | SS | | 1100 | | t_{RCP} |
| t_{SUSYNC} | SyncPat Set-up Time to CAL | SS | | 50 | | t_{RCP} |
| t_{HDSYNC} | SyncPat Hold Time from CAL | SS | | 50 | | t_{RCP} |

1. REFCLK clock period.

REFCLK and SS_CLKIN Timing

| Symbol | Description | Mode | Condition | Min. | Max. | Units |
|-----------------|---|------------------|---------------|------|------|-------|
| $t_{DREFCLK}$ | Frequency Deviation Between TX REFCLK and CDRX REFCLK on One Link | 8B10B/ 10B12B | | -100 | 100 | ppm |
| $t_{JPPREFCLK}$ | REFCLK, SS_CLKIN Peak-to-Peak Period Jitter | All | Random Jitter | | 0.01 | UIPP |
| $t_{PWREFCLK}$ | REFCLK, SS_CLKIN Pulse Width, (80% to 80% or 20% to 20%). | All | | 1 | | ns |
| $t_{RFREFCLK}$ | REFCLK, SS_CLKIN Rise/Fall Time (20% to 80% or 80% to 20%) | All | | | 2 | ns |

Serializer Timing²

| Symbol | Description | Mode | Condition | Min. | Max. | Units |
|-------------------|--|----------|--------------------------|--------------------|--------------------|-------|
| $t_{JPPSOUT}$ | SOUT Peak-to-Peak Output Data Jitter | All | f_{CLK} with no jitter | | 0.25 | UIPP |
| $t_{JPP8B10B}$ | SOUT Peak-to-Peak Random Jitter | 8B10B | 800 Mbps w/K28.7- | | 130 | ps |
| | SOUT Peak-to-Peak Deterministic Jitter | 8B10B | 800 Mbps w/K28.5+ | | 160 | ps |
| t_{RFSOUT} | SOUT Output Data Rise/Fall Time (20%, 80%) | LVDS | | | 700 | ps |
| | | BLVDS | | | 900 | ps |
| t_{COSOUT} | REFCLK to SOUT Delay | SS/8B10B | | $2Bt^1 + 2$ | $2Bt^1 + 10$ | ns |
| | | 10B12B | | $1Bt^1 + 2$ | $1Bt^1 + 10$ | ns |
| t_{SKTX} | Skew of SOUT with Respect to SS_CLKOUT | SS | | | 250 | ps |
| $t_{CKOSOUT}$ | SS_CLKOUT to bit0 of SOUT | SS | | $2Bt^1 - t_{SKTX}$ | $2Bt^1 + t_{SKTX}$ | ns |
| $t_{HSITXDDATAS}$ | TXD Data Setup Time | All | Note 3 | 1.5 | | ns |
| $t_{HSITXDDATAH}$ | TXD Data Hold Time | All | Note 3 | | 1.0 | ns |

1. Bt: Bit Time Period. High Speed Serial Bit Time.

2. The SIN and SOUT jitter specifications listed above are under the condition that the clock tree that drives the REFCLK to sysHSI Block is in sysCLOCK PLL BYPASS mode.

3. Internal timing for reference only.

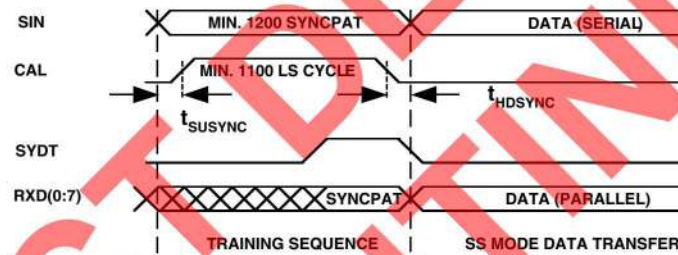
Deserializer Timing

| Symbol | Description | Mode | Conditions | Min. | Max. | Units |
|-----------------------|--|------------------|------------|---------------------------|----------------------------|-------|
| f_{DSIN} | SIN Frequency Deviation from REFCLK | 8B10B/ 10B12B | | -100 | 100 | ppm |
| e_{OSIN} | SIN Eye Opening Tolerance | All | Notes 1, 2 | 0.45 | | UIPP |
| ber | Bit Error Rate | All | | | 10^{-12} | Bits |
| $t_{HSIOUTVALIDPRE}$ | RXD, SYDT Valid Time Before RECCLK Falling Edge | All | Note 3 | $t_{RCP}/2 - 0.7$ | | ns |
| $t_{HSIOUTVALIDPOST}$ | RXD, SYDT Valid Time After RECCLK Falling Edge | All | Note 3 | $t_{RCP}/2 - 0.7$ | | ns |
| t_{DSIN} | Bit 0 of SIN Delay to RXD Valid at RECCLK Falling edge | All | | $1.5 t_{RCP} + 4.5Bt + 2$ | $1.5 t_{RCP} + 4.5Bt + 10$ | ns |

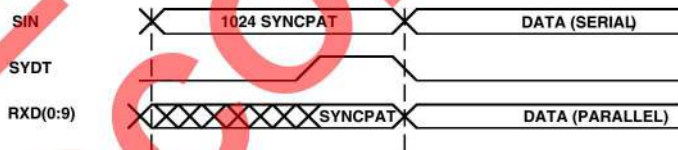
1. Eye opening based on jitter frequency of 100KHz.
2. Lower frequency operation assumes maximum eye closure of 800ps.
3. Internal timing for reference only.

Lock-in Timing

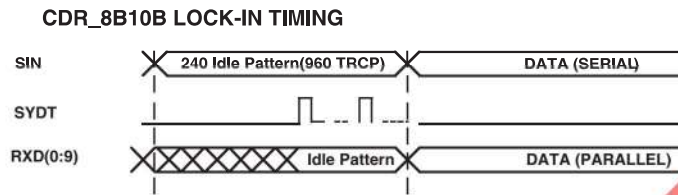
CDRX_SS LOCK-IN (DE-SKEW) TIMING



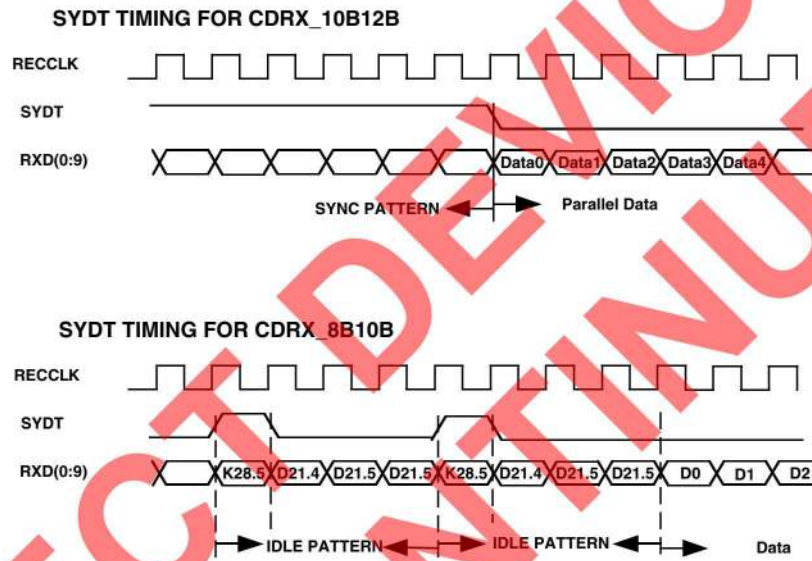
CDR_10B12B LOCK-IN TIMING



Lock-in Timing (Continued)



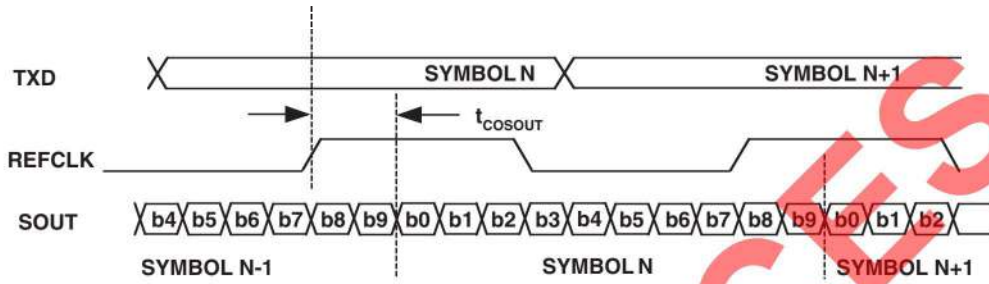
SYDT Timing



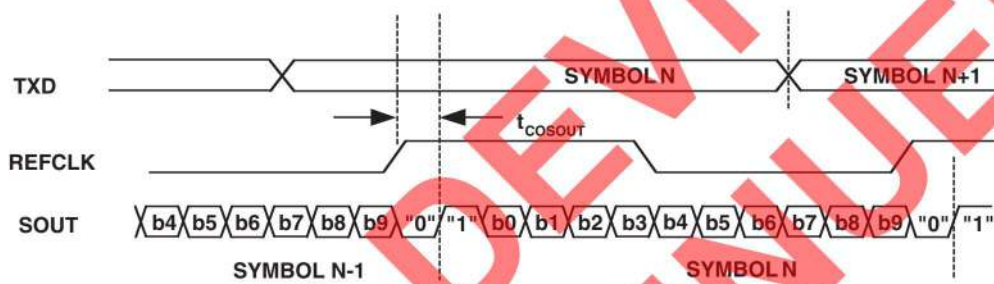
SELECTED DEVICES DISCONTINUED

Serializer Timing

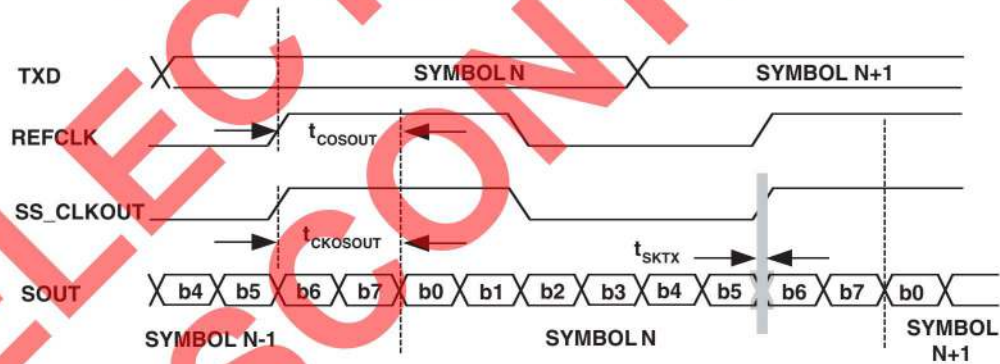
8B/10B SERIALIZER DELAY TIMING



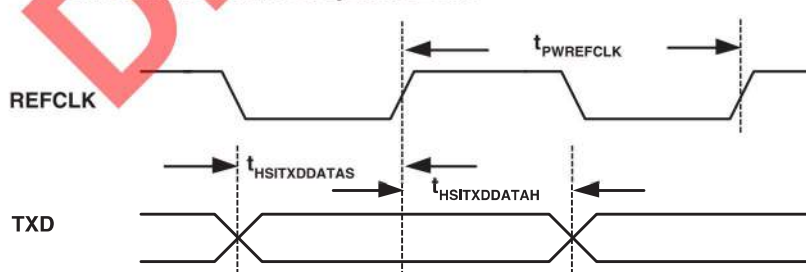
10B/12B SERIALIZER DELAY TIMING



SS Mode SERIALIZER DELAY TIMING

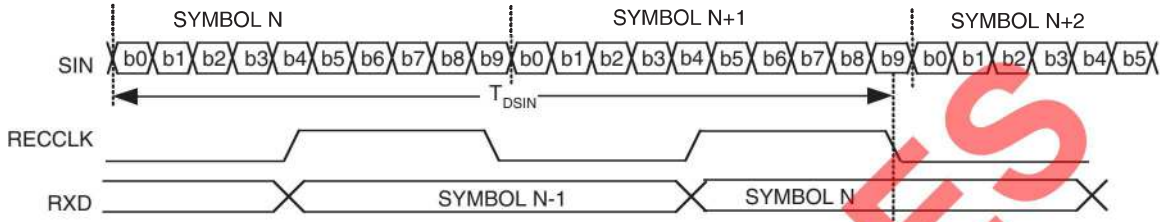


INTERNAL TIMING FOR sysHSI BLOCK

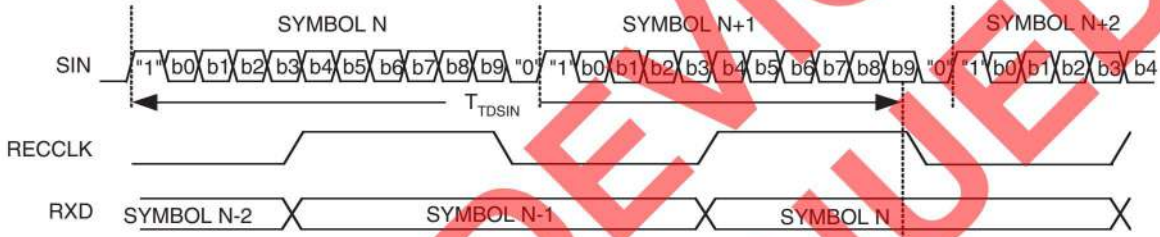


Deserializer Timing

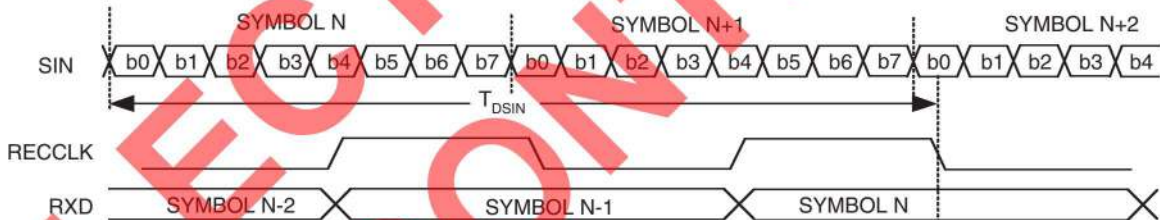
8B/10B DESERIALIZER DELAY TIMING



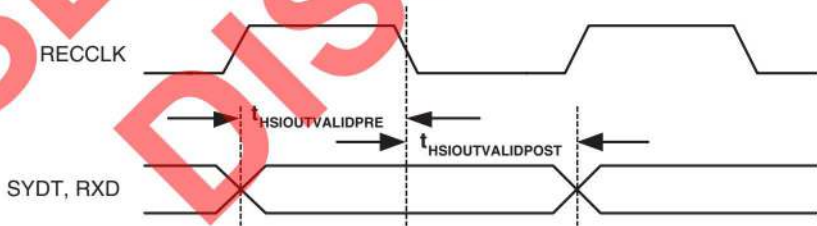
10B/12B DESERIALIZER DELAY TIMING



CDRX_SS DESERIALIZER DELAY TIMING



INTERNAL TIMING FOR sysHSI BLOCK



sysCLOCK PLL Timing

Over Recommended Operating Conditions

| Symbol | Parameter | Conditions | Min | Max | Units |
|---------------------|---|--|----------|----------|-------|
| t_{PWH} | Input clock, high time | 80% to 80% | 0.5 | — | ns |
| t_{PWL} | Input clock, low time | 20% to 20% | 0.5 | — | ns |
| t_R, t_F | Input Clock, rise and fall time | 20% to 80% | — | 3.0 | ns |
| t_{INSTB} | Input clock stability, cycle to cycle (peak) | | — | +/- 300 | ps |
| f_{MDIVIN} | M Divider input, frequency range | | 10 | 320 | MHz |
| $f_{MDIVOUT}$ | M Divider output, frequency range | | 10 | 320 | MHz |
| f_{NDIVIN} | N Divider input, frequency range | | 10 | 320 | MHz |
| $f_{NDIVOUT}$ | N Divider output, frequency range | | 10 | 320 | MHz |
| f_{VDIVIN} | V Divider input, frequency range | | 100 | 400 | MHz |
| $f_{VDIVOUT}$ | V Divider output, frequency range | | 10 | 320 | MHz |
| $t_{OUTDUTY}$ | Output clock, duty cycle | | 40 | 60 | % |
| $t_{JIT(CC)}$ | Output clock, cycle to cycle jitter (peak) | Clean reference ¹ : 10 MHz \leq $f_{MDIVOUT}$ \leq 40 MHz or 100 MHz \leq f_{VDIVIN} \leq 160 MHz | — | +/- 600 | ps |
| | | Clean reference ¹ : 40 MHz \leq $f_{MDIVOUT}$ \leq 320 MHz and 160 MHz \leq f_{VDIVIN} \leq 400 MHz | — | +/- 150 | ps |
| $T_{JIT(PERIOD)}^2$ | Output clock, period jitter (peak) | Clean reference ¹ : 10 MHz \leq $f_{MDIVOUT}$ \leq 40 MHz or 100 MHz \leq f_{VDIVIN} \leq 160 MHz | — | +/- 600 | ps |
| | | Clean reference ¹ : 40 MHz \leq $f_{MDIVOUT}$ \leq 320 MHz and 160 MHz \leq f_{VDIVIN} \leq 400 MHz | — | +/- 150 | ps |
| $t_{CLK_OUT_DLY}$ | Input clock to CLK_OUT delay | Internal feedback | — | 3.4 | ns |
| t_{PHASE} | Input clock to external feedback delta | External feedback | — | 500 | ps |
| t_{LOCK} | Time to acquire phase lock after input stable | | — | 25 | us |
| t_{PLL_DELAY} | Delay increment (Lead/Lag) | Typical = +/- 250ps | +/- 120 | +/- 550 | ps |
| t_{RANGE} | Total output delay range (lead/lag) | | +/- 0.84 | +/- 3.85 | ns |
| t_{PLL_RSTW} | Minimum reset pulse width | | 1.8 | — | ns |

1. This condition assures that the output phase jitter will remain within specification. Jitter specification is based on optimized M, N and V settings determined by the ispLEVER software.

2. Accumulated jitter measured over 10,000 waveform samples

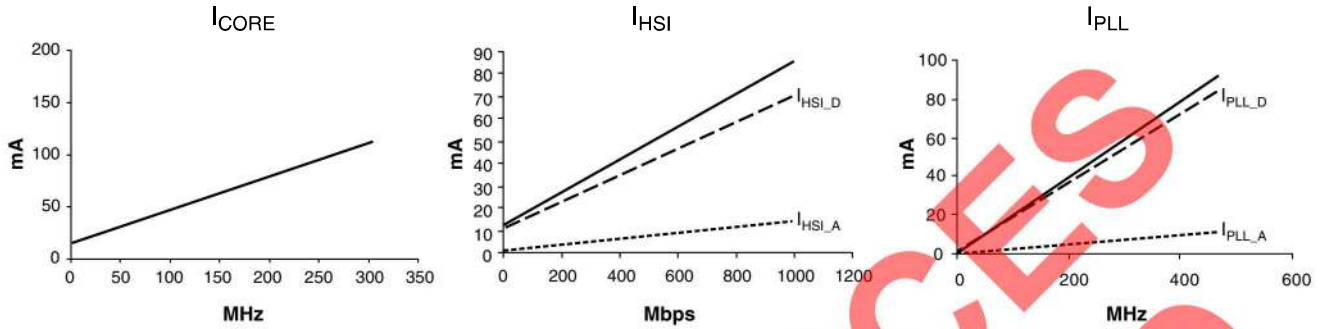
Boundary Scan Timing Specifications

Over Recommended Operating Conditions

| Parameter | Description | Min | Max | Units |
|---------------|--|-----|-----|-------|
| t_{BTCP} | TCK [BSCAN] clock pulse width | 40 | — | ns |
| t_{BTCPH} | TCK [BSCAN] clock pulse width high | 20 | — | ns |
| t_{BTCPL} | TCK [BSCAN] clock pulse width low | 20 | — | ns |
| t_{BTS} | TCK [BSCAN] setup time | 8 | — | ns |
| t_{BTH} | TCK [BSCAN] hold time | 10 | — | ns |
| t_{BTRF} | TCK [BSCAN] rise/fall time | 50 | — | mV/ns |
| t_{BTCO} | TAP controller falling edge of clock to valid output | — | 10 | ns |
| $t_{BTCODIS}$ | TAP controller falling edge of clock to valid disable | — | 10 | ns |
| t_{BTCOEN} | TAP controller falling edge of clock to valid enable | — | 10 | ns |
| t_{BTCRS} | BSCAN test capture register setup time | 8 | — | ns |
| t_{BTCRH} | BSCAN test capture register hold time | 10 | — | ns |
| t_{BUTCO} | BSCAN test update register, falling edge of clock to valid output | — | 25 | ns |
| $t_{BTUODIS}$ | BSCAN test update register, falling edge of clock to valid disable | — | 25 | ns |
| $t_{BTUPOEN}$ | BSCAN test update register, falling edge of clock to valid enable | — | 25 | ns |

SELECT DEVICES DISCONTINUED

Power Consumption



Power Estimation Coefficients – Core and PLL

| Device | V _{CC} | I _{DC} (mA) | K _{REF} | K _{IN} | K _{CORE} | K _{PLLD} | K _{PLLA} |
|-------------|-----------------|----------------------|------------------|-----------------|-------------------|-------------------|-------------------|
| ispGDX2-256 | 3.3 | 10.0 | 3.25 | 0.0139 | 0.292 | 0.157 | 0.024 |
| | 2.5 | 10.0 | 3.13 | 0.0139 | 0.292 | 0.157 | 0.024 |
| | 1.8 | 4.0 | 3.00 | 0.0213 | 0.239 | 0.179 | 0.024 |

- I_{DC}: Blank chip background current
- K_{REF}: Reference voltage circuit current per bank
- K_{IN}: I/O current per input per MHz
- K_{CORE}: Core current per MHz with GRP fanout of 1
- K_{PLLD}: PLL logic current per MHz per PLL
- K_{PLLA}: PLL analog portion current per MHz per PLL

Power Estimation Coefficients – sysHSI

| Device | V _{CC} | K _{RXD} | K _{RXSTBY} | K _{RXA} | K _{TXD} | K _{TXSTBY} | K _{TXA} |
|-------------|-----------------|------------------|---------------------|------------------|------------------|---------------------|------------------|
| ispGDX2-256 | 3.3 | 0.027 | 1.3 | 0.0023 | 0.011 | 2.4 | 0.0018 |
| | 2.5 | 0.027 | 1.3 | 0.0023 | 0.011 | 2.4 | 0.0018 |
| | 1.8 | 0.019 | 3.7 | 0.0040 | 0.011 | 1.2 | 0.0023 |

- K_{RXD}: Receiver Logic current per Mbps
- K_{RXSTBY}: Receiver Logic standby current
- K_{RXA}: Receiver Analog portion current per Mbps
- K_{TXD}: Transmitter Logic current per Mbps
- K_{TXSTBY}: Transmitter Logic standby current
- K_{TXA}: Transmitter Analog portion current per Mbps

Power Consumption (Continued)

Power consumption in the ispGDX2 family is the sum of three components:

$$I_{CC-TOTAL} = I_{CORE} + I_{PLL} + I_{HSI} \quad (I_{CC-TOTAL} \text{ combines current supplied via } V_{CC} \text{ pins and } V_{CCP} \text{ pins})$$

$$\begin{aligned} I_{CORE} &= I_{DC} + I_{REF} + I_{IN} \\ &= \text{Blank chip background current} \\ &\quad + K_{REF} * \text{Number of Banks with } V_{REF} \text{ active} \\ &\quad + (K_{IN} * \text{Number of inputs} + K_{CORE}) * \text{Average Input Switching Frequency (MHz)} \end{aligned}$$

$$\begin{aligned} I_{PLL} &= I_{PLL_D} + I_{PLL_A} \\ &= [K_{PLLD} * F_{VCO} * \text{Number of PLLs used}] + [K_{PLLA} * F_{VCO} * \text{Number of PLLs used}] \\ &= [(K_{PLLD} + K_{PLLA}) * F_{VCO}] * \text{Number of PLLs used} \end{aligned}$$

$$\begin{aligned} I_{HSI} &= I_{RX} + I_{TX} \\ &= [(K_{RXD} + K_{RXA}) * F_{RX} + I_{RXSTBY}] * \text{Number of Receiver Channels} \\ &\quad + [(K_{TXD} + K_{TXA}) * F_{TX} + I_{TXSTBY}] * \text{Number of Transmitter Channels} \end{aligned}$$

Where:

F_{VCO} : sysClock PLL VCO Frequency in MHz

F_{RX} : sysHSI Receiver Serial Data Rate

F_{TX} : sysHSI Transmitter Serial Data Rate

I_{HSI} can also be determined by calculating I_{HSI_D} , the current supplied by the V_{CC} pin, and I_{HSI_A} , the current supplied by the V_{CCP0} and V_{CCP1} .

$$\begin{aligned} I_{HSI} &= I_{HSI_D} + I_{HSI_A} \\ &= [(K_{RXD} * F_{RX} + I_{RXSTBY}) * \text{Number of Receiver Channels} \\ &\quad + (K_{TXD} * F_{TX} + I_{TXSTBY}) * \text{Number of Transmitter Channels}] \\ &\quad + [(K_{RXA} * F_{RX}) * \text{Number of Receiver Channels} \\ &\quad + (K_{TXA} * F_{TX}) * \text{Number of Transmitter Channels}] \end{aligned}$$

The I_{CCP} is supplied through V_{CCP0} and V_{CCP1} pins for PLL and sysHSI analog portion. The equation for I_{CCP} can be derived from the equations below.

$$\begin{aligned} I_{CCP} &= I_{PLL_A} + I_{HSI_A} \\ &= [(K_{PLLA} * F_{VCO}) * \text{Number of PLLs used}] \\ &\quad + [(K_{RXA} * F_{RX}) * \text{Number of Receiver Channels} \\ &\quad + (K_{TXA} * F_{TX}) * \text{Number of Transmitter Channels}] \end{aligned}$$

Where:

I_{PLL_A} : PLL Analog Portion Current

I_{HSI_A} : HSI Analog Portion Current

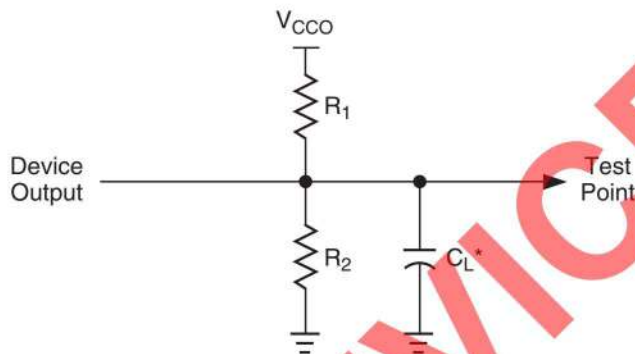
Note: For further information about the use of these coefficients, refer to Technical Note TN1034, *Power Estimation in the ispGDX2 Family*.

$I_{CC-TOTAL}$ estimates are based on typical conditions. These values are for estimates only. Since the value of $I_{CC-TOTAL}$ is sensitive to operating conditions and the program in the device, the actual current should be verified.

Switching Test Conditions

Figure 23 shows the output test load used for AC testing. Specific values for resistance, capacitance, voltage and other test conditions are shown in Table 7.

Figure 23. Output Test Load, LVTTTL and LVCMOS Standards (1.8V)



*C_L includes Test Fixture and Probe Capacitance.

Table 7. Test Fixture Required Components

| Test Condition | R ₁ | R ₂ | C _L | Timing Ref. | V _{CC0} |
|---|----------------|----------------|----------------|----------------------------------|--------------------|
| Default LVCMOS 1.8 I/O (L -> H, H -> L) | 106 | 106 | 35pF | V _{CC0} /2 | 1.8V |
| LVCMOS I/O (L -> H, H -> L) | — | — | 35pF | LVC MOS3.3 = 1.5V | LVC MOS3.3 = 3.0V |
| | | | | LVC MOS2.5 = V _{CC0} /2 | LVC MOS2.5 = 2.3V |
| | | | | LVC MOS1.8 = V _{CC0} /2 | LVC MOS1.8 = 1.65V |
| Default LVCMOS 1.8 I/O (Z -> H) | — | 106 | 35pF | V _{CC0} /2 | 1.65V |
| Default LVCMOS 1.8 I/O (Z -> L) | 106 | — | 35pF | V _{CC0} /2 | 1.65V |
| Default LVCMOS 1.8 I/O (H -> Z) | — | 106 | 5pF | V _{OH} - 0.15 | 1.65V |
| Default LVCMOS 1.8 I/O (L -> Z) | 106 | — | 5pF | V _{OL} + 0.15 | 1.65V |

Note: Output test conditions for all other interfaces are determined by the respective standards.

Signal Descriptions¹

| Signal Names | Description |
|---|---|
| General Purpose | |
| BKx_IOy | Input/Output – General purpose I/O number y in I/O Bank X. |
| GCLK/CE0, GCLK/CE1, GCLK/CE2, GCLK/CE3 | Input – Global clock/clock enable inputs. |
| SEL0, SEL1, SEL2 ² , SEL3 ² | Input – Global MUX select inputs. |
| GOE0, GOE1, GOE2 ² , GOE3 ² | Input – Global output enable inputs. |
| RESETb | Input – Global RESET signal (active low). |
| NC | No connect. |
| GND | GND – Ground. |
| V _{CC} | VCC – The power supply pins for core logic. |
| V _{CCJ} | VCC – The power supply for the JTAG logic. |
| V _{CCOx} | VCC – The power supply pins for I/O Bank X. |
| V _{REFx} | Input – Defines the reference voltage for I/O Bank X. |
| Testing and Programming | |
| TMS | Input – Test Mode Select input, used to control the 1149.1 state machine. |
| TCK | Input – Test Clock Input pin, used to clock the 1149.1 state machine. |
| TDI | Input – Test Data In pin, used to load data into device using 1149.1 state machine. |
| TDO | Output – Test Data Out pin used to shift data out of device using 1149.1. |
| TOE | Input – Test Output Enable pin. TOE tristates all I/O pins when driven low. |
| PLL Functions | |
| PLL_FBKz | Input – Optional feedback input allows external feedback for PLL z. |
| PLL_RSTz | Input – Optional input resets the M divider in PLL z. |
| CLK_OUTz | Output – Optional clock output from PLL z (clock signal occupies the input path of this I/O pad). |
| PLL_LOCKz | Output – Optional lock output from PLL z (lock signal occupies the input path of this I/O pad). |
| GND _{P0} , GND _{P1} | GND – Ground for PLLs. |
| V _{CCP0} , V _{CCP1} | VCC – The power supply pins for PLLs. |
| FIFO Functions | |
| FIFOy_DINw | Input – DATA IN Bit w of FIFO y. |
| FIFOy_DOUTw | Internal Signal – DATA OUT Bit w of FIFO y |
| FIFOy_FIFORSTb | Input – Reset input for FIFO y (active low). |
| FIFOy_FULL | Output – FULL flag for FIFO y. |
| FIFOy_EMPTY | Output – EMPTY flag for FIFO y. |
| FIFOy_STRDb | Output – Start read (STRDb) flag for FIFO y. |
| SERDES Functions | |
| HSImA_SINP, HSImB_SINP | Input – Positive sense serial input for sysHSI BLOCK m channel A, B. |
| HSImA_SINN, HSImB_SINN | Input – Negative (minus) sense serial input for sysHSI BLOCK m channel A, B. |
| HSImA_SOUTP, HSImB_SOUTP | Output – Positive sense serial output for sysHSI BLOCK m channel A, B. |
| HSImA_SOUTN, HSImB_SOUTN | Output – Negative (minus) sense serial output for sysHSI BLOCK m channel A, B. |
| HSImA_SYDT, HSImB_SYDT | Output – Symbol alignment detect for sysHSI BLOCK m channel A, B. |
| HSImA_RECCLK, HSImB_RECCLK | Internal Signal – Recovered clock for sysHSI BLOCK m channel A, B. |
| HSImA_CDRRSTb, HSImB_CDRRSTb | Input – Resets the CDR circuit of sysHSI BLOCK m channel A, B. |
| HSIm_CSLOCK | Output – LOCK output of the PLL associated with channel m. |

Signal Descriptions¹ (Continued)

| Signal Names | Description |
|-------------------------------------|---|
| HSImA_TXDw, HSImB_TXDw | Internal Signal – Parallel data in bit w for sysHSI BLOCK m channel A, B. |
| HSImA_RXDw, HSImB_RXDw | Internal Signal – Parallel data out bit w for sysHSI BLOCK m channel A, B. |
| Source Synchronous Functions | |
| SS_SCLKIN0P, SS_SCLKIN1P | Input – Positive sense clock input for Source Synchronous group A, B. |
| SS_SCLKIN0N, SS_SCLKIN1N | Input – Negative (minus) sense clock input for Source Synchronous group A, B. |
| SS_CLKOUT0N, SS_CLKOUT1P | Output – Positive sense clock output for Source Synchronous group A, B. |
| SS_CLKOUT0N, SS_CLKOUT1N | Output – Negative (minus) sense clock output for Source Synchronous group A, B. |
| CAL | Input – Initiates source synchronous calibration sequence. |

1. m, w, x, y and z are variables.
2. Not on ispGDX2-64

ispGDX2-64 Power Supply and NC Connections¹

| Signal | ispGDX2-64 (100-Ball fpBGA) ² |
|-------------------|--|
| V _{CC} | A1, K10 |
| V _{CC00} | J7 |
| V _{CC01} | F10 |
| V _{CC02} | E10 |
| V _{CC03} | B7 |
| V _{CC04} | B4 |
| V _{CC05} | E1 |
| V _{CC06} | F1 |
| V _{CC07} | K4 |
| V _{CCJ} | K1 |
| V _{CCP0} | G6 |
| GND _{P0} | G5 |
| GND | A10, B9, C8, E6, E5, F6, F5, H3, J2 |

1. All grounds must be electrically connected at the board level.
2. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispGDX2 Power Supply and NC Connections¹

| Signal | ispGDX2-128 (208-Ball fpBGA) ³ | ispGDX2-256 (484-Ball fpBGA) ³ |
|-------------------|--|--|
| V _{CC} | B15, C14, R15, B2, C3, P3, R2, | AA3, AA20, B3, B20, C2, C11, C12, C21, H9, H10, H11, H12, H13, H14, J8, J15, K8, K15, L8, L15, L20, M3, M8, M15, M20, N8, N15, P8, P15, R9, R10, R11, R12, R13, R14, Y2, Y11, Y12, Y21 |
| V _{CC00} | N11, T12 | AA14, AB20, Y17 |
| V _{CC01} | L13, M16 | P21, U20, Y22 |
| V _{CC02} | E16, F13 | C22, E20, J21 |
| V _{CC03} | A12, D11 | A20, B14, C17 |
| V _{CC04} | A5, D6 | A3, B9, C6 |
| V _{CC05} | E1, F4 | C1, F3, J2 |
| V _{CC06} | L4, M1 | P2, U3, Y1 |
| V _{CC07} | N6, T5 | AA9, AB3, Y6 |
| V _{CCJ} | P14 | L3 |
| V _{CCP0} | J1 | K1 |
| V _{CCP1} | J16 | N22 |
| GND _{P0} | H1 | J1 |
| GND _{P1} | H16 | K22 |
| GND | A16, D13, H15, J15, N13, T16, A1, B9, B8, D4, H2, J2, N4, R8, R9, T1, G7, G8, G9, G10, H7, H8, H9, H10, J7, J8, J9, J10, K7, K8, K9, K10 | A2, A11, A12, A21, A1, A22, AA1, AA2, AA11, AA12, AA21, AA22, AB1, AB2, AB11, AB12, AB21, AB22, B1, B2, B11, B12, B21, B22, C3, C20, D4, D19, E5, E18, F6, F17, G7, G16, H8, H15, J9, J10, J11, J12, J13, J14, K9, K10, K11, K12, K13, K14, L1, L2, L7, L9, L10, L11, L12, L13, L14, L16, L21, L22, M1, M2, M7, M9, M10, M11, M12, M13, M14, M16, M21, M22, N9, N10, N11, N12, N13, N14, P9, P10, P11, P12, P13, P14, R8, R15, T7, T16, U6, U17, V5, V18, W4, W19, Y3, Y20 |
| NC ² | A11, B16 | D8, D11, E6, E7, E8, E9, E12, E13, E14, E15, E16, F7, F16, G5, G6, G18, G19, H19, K4, K19, L19, M4, M19, N4, P4, P19, R4, R18, T4, T5, T17, T18, U5, U7, U16, V7, V8, V9, V10, V11, V12, V15, V16, V17, W14, Y18 |

1. All grounds must be electrically connected at the board level.
2. NC pins should not be connected to any active signals, V_{CC} or GND.
3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispGDX2-64 Logic Signal Connections

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 100 fpBGA |
|--------------------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| GOE0 | - | - | - | - | - | - | - | H6 |
| BK0_IO0/PLL_LOCK0 | 0 | 0N | 0A | 0 | - | - | FIFO0_FULL | J6 |
| BK0_IO1 | 0 | 0P | 0A | 1 | HSI0A_CDRRSTb | - | FIFO0_FIFORSTb | K6 |
| GND | 0 | - | - | - | - | - | - | GND |
| BK0_IO2 | 0 | 1N | 0A | 2 | HSI0A_SINN | HSI0A_RECCLK | - | G7 |
| BK0_IO3 | 0 | 1P | 0A | 3 | HSI0A_SINP | - | - | H7 |
| GND | 0 | - | - | - | - | - | - | GND |
| BK0_IO4/PLL_RST0 | 0 | 2N | 0A | 4 | - | HSI0A_RXD0/TXD0 | FIFO0_DIN0/DOUT0 | K7 |
| BK0_IO5 | 0 | 2P | 0A | 5 | - | HSI0A_RXD1/TXD1 | FIFO0_DIN1/DOUT1 | K8 |
| BK0_IO6 | 0 | 3N | 0A | 6 | - | HSI0A_RXD2/TXD2 | FIFO0_DIN2/DOUT2 | J8 |
| BK0_IO7 | 0 | 3P | 0A | 7 | Note 4 | HSI0A_RXD3/TXD3 | FIFO0_DIN3/DOUT3 | K9 |
| GND | 0 | - | - | - | - | - | - | GND |
| TCK | - | - | - | - | - | - | - | J10 |
| RESETb | - | - | - | - | - | - | - | J9 |
| BK1_IO0/PLL_FBK0 | 1 | 4P | 0A | 8 | HSI0A_SYDT ⁵ | HSI0A_RXD4/TXD4 | FIFO0_DIN4/DOUT4 | H10 |
| BK1_IO1 | 1 | 4N | 0A | 9 | - | HSI0A_RXD5/TXD5 | FIFO0_DIN5/DOUT5 | H9 |
| BK1_IO2 | 1 | 5P | 0A | 10 | - | HSI0A_RXD6/TXD6 | FIFO0_DIN6/DOUT6 | H8 |
| BK1_IO3/VREF(0,1) | 1 | 5N | 0A | 11 | FIFO0_STRDb ⁶ | HSI0A_RXD7/TXD7 | FIFO0_DIN7/DOUT7 | G10 |
| GND | 1 | - | - | - | - | - | - | GND |
| BK1_IO4 | 1 | 6P | 0A | 12 | HSI0A_SOUTP | HSI0A_RXD8/TXD8 | FIFO0_DIN8/DOUT8 | G9 |
| BK1_IO5 | 1 | 6N | 0A | 13 | HSI0A_SOUTN | HSI0A_RXD9/TXD9 | FIFO0_DIN9/DOUT9 | G8 |
| GND | 1 | - | - | - | - | - | - | GND |
| BK1_IO6 | 1 | 7P | 0A | 14 | SS_CLKIN1P | HSI0A_SYDT ⁵ | - | F9 |
| BK1_IO7 | 1 | 7N | 0A | 15 | SS_CLKIN1N | - | FIFO0_EMPTY | F8 |
| GCLK/CE2 | - | CLK2P | - | - | - | - | - | F7 |
| GCLK/CE3 | - | CLK2N | - | - | - | - | - | E7 |
| BK2_IO0 | 2 | 8N | 0B | 0 | SS_CLKOUT0N | - | FIFO1_FULL | E8 |
| BK2_IO1 | 2 | 8P | 0B | 1 | SS_CLKOUT0P | - | FIFO1_EMPTY | E9 |
| GND | 2 | - | - | - | - | - | - | GND |
| BK2_IO2 | 2 | 9N | 0B | 2 | HSI0B_SOUTN | HSI0BA_SYDT ⁵ | - | D8 |
| BK2_IO3 | 2 | 9P | 0B | 3 | HSI0B_SOUTP | HSI0B_RXD0/TXD0 | FIFO1_DIN0 | D9 |
| GND | 2 | - | - | - | - | - | - | GND |
| BK2_IO4/V _{REF} (2,3) | 2 | 10N | 0B | 4 | - | HSI0B_RXD1/TXD1 | FIFO1_DIN1/DOUT1 | D10 |
| BK2_IO5 | 2 | 10P | 0B | 5 | - | HSI0B_RXD2/TXD2 | FIFO1_DIN2/DOUT2 | C9 |
| BK2_IO6 | 2 | 11N | 0B | 6 | HSI0_CSLOCK | HSI0B_RXD3/TXD3 | FIFO1_DIN3/DOUT3 | C10 |
| BK2_IO7 | 2 | 11P | 0B | 7 | Note 4 | HSI0B_RXD4/TXD4 | FIFO1_DIN4/DOUT4 | B10 |
| BK3_IO0 | 3 | 12P | 0B | 8 | - | HSI0B_RXD5/TXD5 | FIFO1_DIN5/DOUT5 | A9 |
| BK3_IO1 | 3 | 12N | 0B | 9 | HSI0B_SYDT ⁵ | HSI0B_RXD6/TXD6 | FIFO1_DIN6/DOUT6 | B8 |
| BK3_IO2 | 3 | 13P | 0B | 10 | - | HSI0B_RXD7/TXD7 | FIFO1_DIN7/DOUT7 | A8 |
| BK3_IO3 | 3 | 13N | 0B | 11 | - | HSI0B_RXD8/TXD8 | FIFO1_DIN8/DOUT8 | A7 |
| GND | 3 | - | - | - | - | - | - | GND |
| BK3_IO4 | 3 | 14P | 0B | 12 | HSI0B_SINP | HSI0B_RXD9/TXD9 | FIFO1_DIN9/DOUT9 | C7 |
| BK3_IO5 | 3 | 14N | 0B | 13 | HSI0B_SINN | HSI0B_RECCLK | - | D7 |
| GND | 3 | - | - | - | - | - | - | GND |
| BK3_IO6 | 3 | 15P | 0B | 14 | FIFO1_STRDb ⁶ | - | - | B6 |
| BK3_IO7/CLK_OUT0 | 3 | 15N | 0B | 15 | HSI0B_CDRRSTb | - | FIFO1_FIFORSTb | C6 |

ispGDX2-64 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 100 fpBGA |
|-----------------------|------------|--------------------|-----------------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| SEL0 | - | - | - | - | - | - | - | D6 |
| SEL1 | - | - | - | - | - | - | - | D5 |
| BK4_IO0/CLK_OUT2 | 4 | 16N | 1A ⁷ | 0 | HSI1A_CDRRSTb | - | FIFO2_FIFORSTb | C5 |
| BK4_IO1 | 4 | 16P | 1A ⁷ | 1 | FIFO2_STRDb ⁵ | - | - | B5 |
| GND | 4 | - | - | - | - | - | - | GND |
| BK4_IO2 | 4 | 17N | 1A ⁷ | 2 | HSI1A_SINN | HSI1A_RECCLK | - | D4 |
| BK4_IO3 | 4 | 17P | 1A ⁷ | 3 | HSI1A_SINP | HSI1A_RXD9/TXD9 | FIFO2_DIN9/DOU9 | C4 |
| GND | 4 | - | - | - | - | - | - | GND |
| BK4_IO4 | 4 | 18N | 1A ⁷ | 4 | - | HSI1A_RXD8/TXD8 | FIFO2_DIN8/DOU8 | A6 |
| BK4_IO5 | 4 | 18P | 1A ⁷ | 5 | CAL | HSI1A_RXD7/TXD7 | FIFO2_DIN7/DOU7 | A5 |
| BK4_IO6 | 4 | 19N | 1A ⁷ | 6 | HSI1A_SYDT ⁵ | HSI1A_RXD6/TXD6 | FIFO2_DIN6/DOU6 | A4 |
| BK4_IO7 | 4 | 19P | 1A ⁷ | 7 | - | HSI1A_RXD5/TXD5 | FIFO2_DIN5/DOU5 | A3 |
| TMS | - | - | - | - | - | - | - | B3 |
| TDI | - | - | - | - | - | - | - | A2 |
| GND | - | - | - | - | - | - | - | GND |
| TDO | - | - | - | - | - | - | - | B1 |
| TOE | - | - | - | - | - | - | - | B2 |
| BK5_IO0 | 5 | 20P | 1A ⁷ | 8 | Note 4 | HSI1A_RXD4/TXD4 | FIFO2_DIN4/DOU4 | C1 |
| BK5_IO1 | 5 | 20N | 1A ⁷ | 9 | HSI1_CSLOCK | HSI1A_RXD3/TXD3 | FIFO2_DIN3/DOU3 | C2 |
| BK5_IO2 | 5 | 21P | 1A ⁷ | 10 | - | HSI1A_RXD2/TXD2 | FIFO2_DIN2/DOU2 | C3 |
| BK5_IO3/Vref(4,5) | 5 | 21N | 1A ⁷ | 11 | - | HSI1A_RXD1/TXD1 | FIFO2_DIN1/DOU1 | D1 |
| GND | 5 | - | - | - | - | - | - | GND |
| BK5_IO4 | 5 | 22P | 1A ⁷ | 12 | HSI1A_SOUTP | HSI1A_RXD0/TXD0 | FIFO2_DIN0/DOU0 | D3 |
| BK5_IO5 | 5 | 22N | 1A ⁷ | 13 | HSI1A_SOUTN | HSI1A_SYDT ⁵ | - | D2 |
| GND | 5 | - | - | - | - | - | - | GND |
| BK5_IO6 | 5 | 23P | 1A ⁷ | 14 | SS_CLKIN1P | - | FIFO2_EMPTY | E2 |
| BK5_IO7 | 5 | 23N | 1A ⁷ | 15 | SS_CLKIN1N | - | FIFO2_FULL | E3 |
| GCLK/CE0 | - | CLK0P | - | - | - | - | - | E4 |
| GCLK/CE1 | - | CLK0N | - | - | - | - | - | F4 |
| BK6_IO0 | 6 | 24N | 1B | 0 | SS_CLKOUT1N | - | FIFO3_EMPTY | F3 |
| BK6_IO1 | 6 | 24P | 1B | 1 | SS_CLKOUT1P | HSI1B_SYDT ⁵ | - | F2 |
| GND | 6 | - | - | - | - | - | - | GND |
| BK6_IO2 | 6 | 25N | 1B | 2 | HSI1B_SOUTN | HSI1B_RXD9/TXD9 | FIFO3_DIN9/DOU9 | G3 |
| BK6_IO3 | 6 | 25P | 1B | 3 | HSI1B_SOUTP | HSI1B_RXD8/TXD8 | FIFO3_DIN8/DOU8 | G2 |
| GND | 6 | - | - | - | - | - | - | GND |
| BK6_IO4/Vref(Bank6,7) | 6 | 26N | 1B | 4 | FIFO3_STRDb ⁶ | HSI1B_RXD7/TXD7 | FIFO3_DIN7/DOU7 | G1 |
| BK6_IO5 | 6 | 26P | 1B | 5 | - | HSI1B_RXD6/TXD6 | FIFO3_DIN6/DOU6 | H1 |
| BK6_IO6 | 6 | 27N | 1B | 6 | - | HSI1B_RXD5/TXD5 | FIFO3_DIN5/DOU5 | H2 |
| BK6_IO7/PLL_FBK2 | 6 | 27P | 1B | 7 | HSI1B_SYDT ⁵ | HSI1B_RXD4/TXD4 | FIFO3_DIN4/DOU4 | J1 |
| BK7_IO0 | 7 | 28P | 1B | 8 | Note 4 | HSI1B_RXD3/TXD3 | FIFO3_DIN3/DOU3 | J3 |
| BK7_IO1 | 7 | 28N | 1B | 9 | - | HSI1B_RXD2/TXD2 | FIFO3_DIN2/DOU2 | K2 |
| BK7_IO2 | 7 | 29P | 1B | 10 | - | HSI1B_RXD1/TXD1 | FIFO3_DIN1/DOU1 | J4 |
| BK7_IO3/PLL_RST2 | 7 | 29N | 1B | 11 | - | HSI1B_RXD0/TXD0 | FIFO3_DIN0/DOU0 | K3 |
| GND | 7 | - | - | - | - | - | - | GND |
| BK7_IO4 | 7 | 30P | 1B | 12 | HSI1B_SINP | - | - | G4 |
| BK7_IO5 | 7 | 30N | 1B | 13 | HSI1B_SINN | HSI1B_RECCLK | - | H4 |

ispGDX2-64 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 100 fpBGA |
|-------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| GND | 7 | - | - | - | - | - | - | GND |
| BK7_IO6 | 7 | 31P | 1B | 14 | HSI1B_CDRRSTb | - | FIFO3_FIFORSTb | K5 |
| BK7_IO7/PLL_LOCK2 | 7 | 31N | 1B | 15 | - | - | FIFO3_FULL | J5 |
| GOE1 | 7 | - | - | - | - | - | - | H5 |

1. The signals in this column route to/from the assigned pins of the associated I/O cell.
2. The signals in this column use the I/O cell. If a receiver signal is present in the I/O cell, the associated pin is available for output only. When transmit data (TXD) is present in the cell, the associated pin is available for input only.
3. The DOUT outputs are routed to GRP through the input register of the cell and the DIN inputs are routed direct from the associated pins in FIFO only mode. In SERDES with FIFO mode, the FULL and EMPTY flags are routed to the associated pins through the output MUX and the pins.
4. If the Source Synchronous Receiver is used in the HSI Block, this pin is unavailable for another use and must be left unconnected.
5. The SYDT signal has two routing options. If direct output through the dedicated pin is used, the I/O cell (the whole HSI Block) is not available for transmitter. The SYDT in the I/O Cell column is routed to the GRP through the input register of the cell and frees the I/O cell for transmitter.
6. FIFO_STRDb flag output is used in SERDES with FIFO Mode only.
7. sysHSI Source Synchronous Receive Mode is not available for channel 1A.

SELECTED DEVICES DISCONTINUED

ispGDX2-128 Logic Signal Connections

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 208 fpBGA |
|--------------------------------|------------|--------------------|-----------------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| TOE | - | | - | - | - | - | - | P8 |
| BK0_IO0 | 0 | 0N | 0A | 0 | - | - | FIFO0A_FULL | P9 |
| BK0_IO1 | 0 | 0P | 0A | 1 | - | - | - | T10 |
| BK0_IO2 / PLL_LOCK2 / PLL_RST2 | 0 | 1N | 0A | 2 | - | - | - | R10 |
| BK0_IO3 | 0 | 1P | 0A | 3 | - | HSI0A_SYDT ⁵ | FIFO0A_EMPTY | T11 |
| GND | 0 | | - | - | - | - | - | GND |
| BK0_IO4 | 0 | 2N | 0A | 4 | HSI0A_SINN | HSI0A_RXD0/TXD0 | FIFO0A_DIN0/DOUT0 | P10 |
| BK0_IO5 | 0 | 2P | 0A | 5 | HSI0A_SINP | HSI0A_RXD1/TXD1 | FIFO0A_DIN1/DOUT1 | N10 |
| BK0_IO6 | 0 | 3N | | 6 | - | HSI0A_RXD2/TXD2 | FIFO0A_DIN2/DOUT2 | R11 |
| BK0_IO7 | 0 | 3P | 0A | 7 | - | HSI0A_RXD3/TXD3 | FIFO0A_DIN3/DOUT3 | T13 |
| BK0_IO8 | 0 | 4N | 0A | 8 | Note 4 | HSI0A_RXD4/TXD4 | FIFO0A_DIN4/DOUT4 | P11 |
| BK0_IO9 / PLL_FB2 | 0 | 4P | 0A | 9 | - | HSI0A_RXD5/TXD5 | FIFO0A_DIN5/DOUT5 | R12 |
| BK0_IO10 | 0 | 5N | 0A | 10 | HSI0A_SOUTN | HSI0A_RXD6/TXD6 | FIFO0A_DIN6/DOUT6 | P12 |
| BK0_IO11 | 0 | 5P | 0A | 11 | HSI0A_SOUTP | HSI0A_RXD7/TXD7 | FIFO0A_DIN7/DOUT7 | N12 |
| GND | 0 | | - | - | - | - | - | GND |
| BK0_IO12 | 0 | 6N | 0A | 12 | - | HSI0A_RXD8/TXD8 | FIFO0A_DIN8/DOUT8 | T14 |
| BK0_IO13 | 0 | 6P | 0A | 13 | HSI0A_SYDT ⁵ | HSI0A_RXD9/TXD9 | FIFO0A_DIN9/DOUT9 | R13 |
| BK0_IO14 | 0 | 7N | 0A | 14 | HSI0A_CDRRSTb | HSI0A_RECCLK | FIFO0A_FIFORSTb | T15 |
| BK0_IO15 / VREF0 | 0 | 7P | 0A | 15 | FIFO0A_STRDb ⁶ | - | - | P13 |
| GOE3 | - | | - | - | - | - | - | T9 |
| TDO | - | | - | - | - | - | - | R16 |
| GND | 1 | | - | - | - | - | - | GND |
| BK1_IO0 / VREF1 | 1 | 8P | 0B | 0 | - | HSI0B_SYDT ⁵ | FIFO0B_FULL | N14 |
| BK1_IO1 | 1 | 8N | 0B | 1 | - | HSI0B_RXD0/TXD0 | FIFO0B_DIN0/DOUT0 | P15 |
| BK1_IO2 | 1 | 9P | 0B | 2 | Note 4 | HSI0B_RXD1/TXD1 | FIFO0B_DIN1/DOUT1 | N15 |
| BK1_IO3 | 1 | 9N | 0B | 3 | - | HSI0B_RXD2/TXD2 | FIFO0B_DIN2/DOUT2 | L14 |
| BK1_IO4 | 1 | 10P | 0B | 4 | HSI0B_SOUTP | HSI0B_RXD3/TXD3 | FIFO0B_DIN3/DOUT3 | M14 |
| BK1_IO5 | 1 | 10N | 0B | 5 | HSI0B_SOUTN | HSI0B_RXD4/TXD4 | FIFO0B_DIN4/DOUT4 | M13 |
| BK1_IO6 | 1 | 11P | 0B | 6 | HSI0_CSLOCK | HSI0B_RXD5/TXD5 | FIFO0B_DIN5/DOUT5 | M15 |
| BK1_IO7 | 1 | 11N | 0B | 7 | HSI0B_SYDT ⁵ | HSI0B_RXD6/TXD6 | FIFO0B_DIN6/DOUT6 | L15 |
| BK1_IO8 | 1 | 12P | 0B | 8 | - | HSI0B_RXD7/TXD7 | FIFO0B_DIN7/DOUT7 | P16 |
| BK1_IO9 | 1 | 12N | 0B | 9 | - | HSI0B_RXD8/TXD8 | FIFO0B_DIN8/DOUT8 | N16 |
| BK1_IO10 | 1 | 13P | 0B | 10 | HSI0B_SINP | HSI0B_RXD9/TXD9 | FIFO0B_DIN9/DOUT9 | K14 |
| BK1_IO11 | 1 | 13N | 0B | 11 | HSI0B_SINN | HSI0B_RECCLK | - | K13 |
| GND | 1 | | - | - | - | - | - | GND |
| BK1_IO12 | 1 | 14P | 0B | 12 | FIFO0B_STRDb ⁶ | - | - | K15 |
| BK1_IO13 | 1 | 14N | 0B | 13 | HSI0B_CDRRSTb | - | FIFO0B_FIFORSTb | L16 |
| BK1_IO14 | 1 | 15P | 0B | 14 | SS_CLKIN1P | - | - | J14 |
| BK1_IO15 / CLK_OUT2 | 1 | 15N | 0B | 15 | SS_CLKIN1N | - | FIFO0B_EMPTY | J13 |
| GCLK/CE2 | - | | - | - | - | - | - | N8 |
| SEL2 | - | | - | - | - | - | - | K16 |
| SEL3 | - | | - | - | - | - | - | G16 |
| GCLK/CE3 | - | | - | - | - | - | - | N9 |
| BK2_IO0 | 2 | 16N | 1A ⁷ | 0 | SS_CLKOUT1N | - | FIFO1A_FULL | H13 |
| BK2_IO1 | 2 | 16P | 1A ⁷ | 1 | SS_CLKOUT1P | - | - | H14 |
| BK2_IO2 | 2 | 17N | 1A ⁷ | 2 | - | HSI1A_SYDT ⁵ | - | G15 |

ispGDX2-128 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDx Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 208 fpBGA |
|--------------------------------|------------|--------------------|-----------------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK2_IO3 | 2 | 17P | 1A ⁷ | 3 | - | HSI1A_RXD0/TXD0 | FIFO1A_DIN0/DOUT0 | F16 |
| GND | 2 | | - | - | - | - | - | GND |
| BK2_IO4 | 2 | 18N | 1A ⁷ | 4 | HSI1A_SINN | HSI1A_RXD1/TXD1 | FIFO1A_DIN1/DOUT1 | G13 |
| BK2_IO5 | 2 | 18P | 1A ⁷ | 5 | HSI1A_SINP | HSI1A_RXD2/TXD2 | FIFO1A_DIN2/DOUT2 | G14 |
| BK2_IO6 | 2 | 19N | 1A ⁷ | 6 | HSI1_CSLOCK | HSI1A_RXD3/TXD3 | FIFO1A_DIN3/DOUT3 | F14 |
| BK2_IO7 | 2 | 19P | 1A ⁷ | 7 | Note 4 | HSI1A_RXD4/TXD4 | FIFO1A_DIN4/DOUT4 | F15 |
| BK2_IO8 | 2 | 20N | 1A ⁷ | 8 | CAL | HSI1A_RXD5/TXD5 | FIFO1A_DIN5/DOUT5 | D16 |
| BK2_IO9 | 2 | 20P | 1A ⁷ | 9 | - | HSI1A_RXD6/TXD6 | FIFO1A_DIN6/DOUT6 | E15 |
| BK2_IO10 | 2 | 21N | 1A ⁷ | 10 | HSI1A_SOUTN | HSI1A_RXD7/TXD7 | FIFO1A_DIN7/DOUT7 | E13 |
| BK2_IO11 | 2 | 21P | 1A ⁷ | 11 | HSI1A_SOUTP | HSI1A_RXD8/TXD8 | FIFO1A_DIN8/DOUT8 | E14 |
| GND | 2 | | - | - | - | - | - | GND |
| BK2_IO12 | 2 | 22N | 1A ⁷ | 12 | HSI1A_SYDT ⁵ | HSI1A_RXD9/TXD9 | FIFO1A_DIN9/DOUT9 | C16 |
| BK2_IO13 | 2 | 22P | 1A ⁷ | 13 | HSI1A_CDRRSTb | HSI1A_RECCLK | FIFO1A_FIFORSTb | D15 |
| BK2_IO14 | 2 | 23N | 1A ⁷ | 14 | FIFO1A_STRDb ⁶ | - | - | C15 |
| BK2_IO15 / VREF2 | 2 | 23P | 1A ⁷ | 15 | - | - | FIFO1A_EMPTY | D14 |
| TCK | - | | - | - | - | - | - | R14 |
| GOE2 | - | | - | - | - | - | - | A9 |
| BK3_IO0 / VREF3 | 3 | 24P | 1B | 0 | - | HSI1B_RXD0/TXD0 | FIFO1B_DIN0/DOUT0 | C13 |
| BK3_IO1 | 3 | 24N | 1B | 1 | Note 4 | HSI1B_RXD1/TXD1 | FIFO1B_DIN1/DOUT1 | B14 |
| BK3_IO2 | 3 | 25P | 1B | 2 | - | HSI1B_RXD2/TXD2 | FIFO1B_DIN2/DOUT2 | A15 |
| BK3_IO3 | 3 | 25N | 1B | 3 | - | HSI1B_RXD3/TXD3 | FIFO1B_DIN3/DOUT3 | B13 |
| GND | 3 | | - | - | - | - | - | GND |
| BK3_IO4 | 3 | 26P | 1B | 4 | HSI1B_SOUTP | HSI1B_RXD4/TXD4 | FIFO1B_DIN4/DOUT4 | D12 |
| BK3_IO5 | 3 | 26N | 1B | 5 | HSI1B_SOUTN | HSI1B_RXD5/TXD5 | FIFO1B_DIN5/DOUT5 | C12 |
| BK3_IO6 | 3 | 27P | 1B | 6 | - | HSI1B_RXD6/TXD6 | FIFO1B_DIN6/DOUT6 | A14 |
| BK3_IO7 | 3 | 27N | 1B | 7 | - | HSI1B_RXD7/TXD7 | FIFO1B_DIN7/DOUT7 / FIFO1B_STRDb | A13 |
| BK3_IO8 | 3 | 28P | 1B | 8 | - | HSI1B_RXD8/TXD8 | FIFO1B_DIN8/DOUT8 | B12 |
| BK3_IO9 | 3 | 28N | 1B | 9 | HSI1B_SYDT ⁵ | HSI1B_RXD9/TXD9 | FIFO1B_DIN9/DOUT9 | C11 |
| BK3_IO10 | 3 | 29P | 1B | 10 | HSI1B_SINP | HSI1B_RECCLK | - | D10 |
| BK3_IO11 | 3 | 29N | 1B | 11 | HSI1B_SINN | - | - | C10 |
| GND | 3 | | - | - | - | - | - | GND |
| BK3_IO12 | 3 | 30P | 1B | 12 | - | HSI1B_SYDT ⁵ | FIFO1B_FULL | B11 |
| BK3_IO13 | 3 | 30N | 1B | 13 | HSI1B_CDRRSTb | - | FIFO1B_FIFORSTb | B10 |
| BK3_IO14 | 3 | 31P | 1B | 14 | - | - | - | A10 |
| BK3_IO15 | 3 | 31N | 1B | 15 | - | - | FIFO1B_EMPTY | C9 |
| RESET | - | | - | - | - | - | - | A7 |
| BK4_IO0 | 4 | 32N | 2A | 0 | - | - | FIFO2A_EMPTY | C8 |
| BK4_IO1 / PLL_LOCK0 / PLL_RST0 | 4 | 32P | 2A | 1 | - | - | - | B7 |
| BK4_IO2 | 4 | 33N | 2A | 2 | HSI2A_CDRRSTb | - | FIFO2A_FIFORSTb | A6 |
| BK4_IO3 | 4 | 33P | 2A | 3 | - | HSI2A_SYDT ⁵ | FIFO2A_FULL | B6 |
| GND | 4 | | - | - | - | - | - | GND |
| BK4_IO4 | 4 | 34N | 2A | 4 | HSI2A_SINN | - | - | C7 |
| BK4_IO5 | 4 | 34P | 2A | 5 | HSI2A_SINP | HSI2A_RECCLK | - | D7 |
| BK4_IO6 | 4 | 35N | 2A | 6 | HSI2A_SYDT ⁵ | HSI2A_RXD9/TXD9 | FIFO2A_DIN9/DOUT9 | C6 |
| BK4_IO7 | 4 | 35P | 2A | 7 | - | HSI2A_RXD8/TXD8 | FIFO2A_DIN8/DOUT8 | B5 |

ispGDX2-128 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 208 fpBGA |
|---------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK4_IO8 | 4 | 36N | 2A | 8 | FIFO2A_STRDb ⁶ | HSI2A_RXD7/TXD7 | FIFO2A_DIN7/DOUT7 | A4 |
| BK4_IO9 / PLL_FB0 | 4 | 36P | 2A | 9 | - | HSI2A_RXD6/TXD6 | FIFO2A_DIN6/DOUT6 | A3 |
| BK4_IO10 | 4 | 37N | 2A | 10 | HSI2A_SOUTN | HSI2A_RXD5/TXD5 | FIFO2A_DIN5/DOUT5 | C5 |
| BK4_IO11 | 4 | 37P | 2A | 11 | HSI2A_SOUTP | HSI2A_RXD4/TXD4 | FIFO2A_DIN4/DOUT4 | D5 |
| GND | 4 | | | - | - | - | - | GND |
| BK4_IO12 | 4 | 38N | 2A | 12 | - | HSI2A_RXD3/TXD3 | FIFO2A_DIN3/DOUT3 | B4 |
| BK4_IO13 | 4 | 38P | 2A | 13 | - | HSI2A_RXD2/TXD2 | FIFO2A_DIN2/DOUT2 | A2 |
| BK4_IO14 | 4 | 39N | 2A | 14 | Note 4 | HSI2A_RXD1/TXD1 | FIFO2A_DIN1/DOUT1 | B3 |
| BK4_IO15 / VREF4 | 4 | 39P | 2A | 15 | - | HSI2A_RXD0/TXD0 | FIFO2A_DIN0/DOUT0 | C4 |
| GOE1 | - | | | - | - | - | - | A8 |
| TMS | - | | | - | - | - | - | R1 |
| GND | 5 | | | - | - | - | - | GND |
| BK5_IO0 / VREF5 | 5 | 40P | 2B | 0 | - | - | FIFO2B_EMPTY | D3 |
| BK5_IO1 | 5 | 40N | 2B | 1 | FIFO2B_STRDb ⁶ | - | - | C2 |
| BK5_IO2 | 5 | 41P | 2B | 2 | HSI2B_CDRRSTb | HSI2B_RECCLK | FIFO2B_FIFORSTb | D2 |
| BK5_IO3 | 5 | 41N | 2B | 3 | HSI2B_SYDT ⁵ | HSI2B_RXD9/TXD9 | FIFO2B_DIN9/DOUT9 | B1 |
| BK5_IO4 | 5 | 42P | 2B | 4 | HSI2B_SOUTP | HSI2B_RXD8/TXD8 | FIFO2B_DIN8/DOUT8 | E3 |
| BK5_IO5 | 5 | 42N | 2B | 5 | HSI2B_SOUTN | HSI2B_RXD7/TXD7 | FIFO2B_DIN7/DOUT7 | E4 |
| BK5_IO6 | 5 | 43P | 2B | 6 | - | HSI2B_RXD6/TXD6 | FIFO2B_DIN6/DOUT6 | F3 |
| BK5_IO7 | 5 | 43N | 2B | 7 | - | HSI2B_RXD5/TXD5 | FIFO2B_DIN5/DOUT5 | E2 |
| BK5_IO8 | 5 | 44P | 2B | 8 | Note 4 | HSI2B_RXD4/TXD4 | FIFO2B_DIN4/DOUT4 | F2 |
| BK5_IO9 | 5 | 44N | 2B | 9 | HSI2B_CSLOCK | HSI2B_RXD3/TXD3 | FIFO2B_DIN3/DOUT3 | C1 |
| BK5_IO10 | 5 | 45P | 2B | 10 | HSI2B_SINP | HSI2B_RXD2/TXD2 | FIFO2B_DIN2/DOUT2 | G3 |
| BK5_IO11 | 5 | 45N | 2B | 11 | HSI2B_SINN | HSI2B_RXD1/TXD1 | FIFO2B_DIN1/DOUT1 | G4 |
| GND | 5 | | | - | - | - | - | GND |
| BK5_IO12 | 5 | 46P | 2B | 12 | - | HSI2B_RXD0/TXD0 | FIFO2B_DIN0/DOUT0 | D1 |
| BK5_IO13 | 5 | 46N | 2B | 13 | - | HSI2B_SYDT ⁵ | - | G2 |
| BK5_IO14 | 5 | 47P | 2B | 14 | SS_CLKIN0P | - | - | H4 |
| BK5_IO15 / CLK_OUT0 | 5 | 47N | 2B | 15 | SS_CLKIN0N | - | FIFO2B_FULL | H3 |
| GCLK/CE0 | - | CLK0P | - | - | - | - | - | D9 |
| SEL0 | - | | | - | - | - | - | F1 |
| SEL1 | - | | | - | - | - | - | G1 |
| GCLK/CE1 | - | CLK0N | - | - | - | - | - | D8 |
| BK6_IO0 | 6 | 48N | 3A | 0 | SS_CLKOUT0N | - | FIFO3A_EMPTY | J4 |
| BK6_IO1 | 6 | 48P | 3A | 1 | SS_CLKOUT0P | - | - | J3 |
| BK6_IO2 | 6 | 49N | 3A | 2 | HSI3A_CDRRSTb | - | FIFO3A_FIFORSTb | K1 |
| BK6_IO3 | 6 | 49P | 3A | 3 | FIFO3A_STRDb ⁶ | - | - | K2 |
| GND | 6 | | | - | - | - | - | GND |
| BK6_IO4 | 6 | 50N | 3A | 4 | HSI3A_SINN | HSI3A_RECCLK | - | K4 |
| BK6_IO5 | 6 | 50P | 3A | 5 | HSI3A_SINP | HSI3A_RXD9/TXD9 | FIFO3A_DIN9/DOUT9 | K3 |
| BK6_IO6 | 6 | 51N | 3A | 6 | - | HSI3A_RXD8/TXD8 | FIFO3A_DIN8/DOUT8 | L1 |
| BK6_IO7 | 6 | 51P | 3A | 7 | - | HSI3A_RXD7/TXD7 | FIFO3A_DIN7/DOUT7 | L2 |
| BK6_IO8 | 6 | 52N | 3A | 8 | HSI3A_SYDT ⁵ | HSI3A_RXD6/TXD6 | FIFO3A_DIN6/DOUT6 | N1 |
| BK6_IO9 | 6 | 52P | 3A | 9 | HSI3_CSLOCK | HSI3A_RXD5/TXD5 | FIFO3A_DIN5/DOUT5 | M2 |
| BK6_IO10 | 6 | 53N | 3A | 10 | HSI3A_SOUTN | HSI3A_RXD4/TXD4 | FIFO3A_DIN4/DOUT4 | M4 |
| BK6_IO11 | 6 | 53P | 3A | 11 | HSI3A_SOUTP | HSI3A_RXD3/TXD3 | FIFO3A_DIN3/DOUT3 | M3 |

ispGDX2-128 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDx Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 208 fpBGA |
|------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| GND | 6 | | - | - | - | - | - | GND |
| BK6_IO12 | 6 | 54N | 3A | 12 | - | HSI3A_RXD2/TXD2 | FIFO3A_DIN2/DOUT2 | L3 |
| BK6_IO13 | 6 | 54P | 3A | 13 | Note 4 | HSI3A_RXD1/TXD1 | FIFO3A_DIN1/DOUT1 | N2 |
| BK6_IO14 | 6 | 55N | 3A | 14 | - | HSI3A_RXD0/TXD0 | FIFO3A_DIN0/DOUT0 | P1 |
| BK6_IO15 / VREF6 | 6 | 55P | 3A | 15 | - | HSI3A_SYDT ⁵ | FIFO3A_FULL | P2 |
| TDI | - | | - | - | - | - | - | N3 |
| GOE0 | - | | - | - | - | - | - | T8 |
| GND | 7 | | - | - | - | - | - | GND |
| BK7_IO0 / VREF7 | 7 | 56P | 3B | 0 | FIFO3B_STRDb ⁶ | - | - | T2 |
| BK7_IO1 | 7 | 56N | 3B | 1 | HSI3B_CDRRSTb | HSI3B_RECCLK | FIFO3B_FIFORSTb | R3 |
| BK7_IO2 | 7 | 57P | 3B | 2 | HSI3B_SYDT ⁵ | HSI3B_RXD9/TXD9 | FIFO3B_DIN9/DOUT9 | P4 |
| BK7_IO3 | 7 | 57N | 3B | 3 | - | HSI3B_RXD8/TXD8 | FIFO3B_DIN8/DOUT8 | T3 |
| BK7_IO4 | 7 | 58P | 3B | 4 | HSI3B_SOUTP | HSI3B_RXD7/TXD7 | FIFO3B_DIN7/DOUT7 | N5 |
| BK7_IO5 | 7 | 58N | 3B | 5 | HSI3B_SOUTN | HSI3B_RXD6/TXD6 | FIFO3B_DIN6/DOUT6 | P5 |
| BK7_IO6 | 7 | 59P | 3B | 6 | - | HSI3B_RXD5/TXD5 | FIFO3B_DIN5/DOUT5 | R4 |
| BK7_IO7 | 7 | 59N | 3B | 7 | Note 4 | HSI3B_RXD4/TXD4 | FIFO3B_DIN4/DOUT4 | T4 |
| BK7_IO8 | 7 | 60P | 3B | 8 | - | HSI3B_RXD3/TXD3 | FIFO3B_DIN3/DOUT3 | R5 |
| BK7_IO9 | 7 | 60N | 3B | 9 | - | HSI3B_RXD2/TXD2 | FIFO3B_DIN2/DOUT2 | P6 |
| BK7_IO10 | 7 | 61P | 3B | 10 | HSI3B_SINP | HSI3B_RXD1/TXD1 | FIFO3B_DIN1/DOUT1 | N7 |
| BK7_IO11 | 7 | 61N | 3B | 11 | HSI3B_SINN | HSI3B_RXD0/TXD0 | FIFO3B_DIN0/DOUT0 | P7 |
| GND | 7 | | - | - | - | - | - | GND |
| BK7_IO12 | 7 | 62P | 3B | 12 | - | HSI3B_SYDT ⁵ | FIFO3B_EMPTY | R6 |
| BK7_IO13 | 7 | 62N | 3B | 13 | - | - | - | T6 |
| BK7_IO14 | 7 | 63P | 3B | 14 | - | - | - | R7 |
| BK7_IO15 | 7 | 63N | 3B | 15 | - | - | FIFO3B_FULL | T7 |

1. The signals in this column route to/from the assigned pins of the associated I/O cell.
2. The signals in this column use the I/O cell. If a receiver signal is present in the I/O cell, the associated pin is available for output only. When transmit data (TXD) is present in the cell, the associated pin is available for input only.
3. The DOUT outputs are routed to GRP through the input register of the cell and the DIN inputs are routed direct from the associated pins in FIFO only mode. In SERDES with FIFO mode, the FULL and EMPTY flags are routed to the associated pins through the output MUX and the pins.
4. If the Source Synchronous Receiver is used in the HSI Block, this pin is unavailable for another use and must be left unconnected.
5. The SYDT signal has two routing options. If direct output through the dedicated pin is used, the I/O cell (the whole HSI Block) is not available for transmitter. The SYDT in the I/O Cell column is routed to the GRP through the input register of the cell and frees the I/O cell for transmitter.
6. FIFO_STRDb flag output is used in SERDES with FIFO Mode only.
7. sysHSI Source Synchronous Receive Mode is not available for channel 1A.

ispGDX2-256 Logic Signal Connections

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|-----------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK0_IO0 | 0 | 0N | 0A | 0 | - | - | FIFO0A_FULL | AB13 |
| BK0_IO1 | 0 | 0P | 0A | 1 | - | - | - | AA13 |
| BK0_IO2/ PLL_LOCK2 | 0 | 1N | 0A | 2 | - | - | - | V13 |
| BK0_IO3 | 0 | 1P | 0A | 3 | - | - | FIFO0A_EMPTY | V14 |
| GND | 0 | - | - | - | - | SYDT_HSI0A ⁵ | - | GND |
| BK0_IO4 | 0 | 2N | 0A | 4 | HSI0A_SINN | HSI0A_RXD0/TXD0 | FIFO0A_DIN0/DOUT0 | U12 |
| BK0_IO5 | 0 | 2P | 0A | 5 | HSI0A_SINP | HSI0A_RXD1/TXD1 | FIFO0A_DIN1/DOUT1 | U13 |
| BK0_IO6 | 0 | 3N | - | 6 | - | HSI0A_RXD2/TXD2 | FIFO0A_DIN2/DOUT2 | W12 |
| BK0_IO7 | 0 | 3P | 0A | 7 | - | HSI0A_RXD3/TXD3 | FIFO0A_DIN3/DOUT3 | Y13 |
| BK0_IO8 | 0 | 4N | 0A | 8 | Note 4 | HSI0A_RXD4/TXD4 | FIFO0A_DIN4/DOUT4 | W13 |
| BK0_IO9/ PLL_FB2 | 0 | 4P | 0A | 9 | - | HSI0A_RXD5/TXD5 | FIFO0A_DIN5/DOUT5 | Y14 |
| BK0_IO10 | 0 | 5N | 0A | 10 | HSI0A_SOUTN | HSI0A_RXD6/TXD6 | FIFO0A_DIN6/DOUT6 | T12 |
| BK0_IO11 | 0 | 5P | 0A | 11 | HSI0A_SOUTP | HSI0A_RXD7/TXD7 | FIFO0A_DIN7/DOUT7 | T13 |
| GND | 0 | - | - | - | - | - | - | GND |
| BK0_IO12 | 0 | 6N | 0A | 12 | - | HSI0A_RXD8/TXD8 | FIFO0A_DIN8/DOUT8 | AB14 |
| BK0_IO13 | 0 | 6P | 0A | 13 | HSI0A_SYDT ⁵ | HSI0A_RXD9/TXD9 | FIFO0A_DIN9/DOUT9 | AB15 |
| BK0_IO14 | 0 | 7N | 0A | 14 | HSI0A_CDRRSTb | HSI0A_RECCLK | FIFO0A_FIFORSTb | Y15 |
| BK0_IO15 | 0 | 7P | 0A | 15 | FIFO0A_STRDb ⁶ | - | - | W15 |
| BK0_IO16 | 0 | 8N | 1A | 0 | - | - | FIFO1A_FULL | AA15 |
| BK0_IO17/ PLL_RST2 | 0 | 8P | 1A | 1 | - | - | - | AA16 |
| BK0_IO18 | 0 | 9N | 1A | 2 | - | HSI1A_SYDT ⁵ | - | Y16 |
| BK0_IO19 | 0 | 9P | 1A | 3 | - | HSI1A_RXD0/TXD0 | FIFO1A_DIN0/DOUT0 | W16 |
| GND | 0 | - | - | - | - | - | - | GND |
| BK0_IO20 | 0 | 10N | 1A | 4 | HSI1A_SOUTN | HSI1A_RXD1/TXD1 | FIFO1A_DIN1/DOUT1 | U14 |
| BK0_IO21/ VREF0 | 0 | 10P | 1A | 5 | HSI1A_SOUTP | HSI1A_RXD2/TXD2 | FIFO1A_DIN2/DOUT2 | U15 |
| BK0_IO22 | 0 | 11N | 1A | 6 | - | HSI1A_RXD3/TXD3 | FIFO1A_DIN3/DOUT3 | AB16 |
| BK0_IO23 | 0 | 11P | 1A | 7 | Note 4 | HSI1A_RXD4/TXD4 | FIFO1A_DIN4/DOUT4 | AB17 |
| BK0_IO24 | 0 | 12N | 1A | 8 | - | HSI1A_RXD5/TXD5 | FIFO1A_DIN5/DOUT5 | AA17 |
| BK0_IO25 | 0 | 12P | 1A | 9 | - | HSI1A_RXD6/TXD6 | FIFO1A_DIN6/DOUT6 | W17 |
| BK0_IO26 | 0 | 13N | 1A | 10 | HSI1A_SINN | HSI1A_RXD7/TXD7 | FIFO1A_DIN7/DOUT7 | T14 |
| BK0_IO27 | 0 | 13P | 1A | 11 | HSI1A_SINP | HSI1A_RXD8/TXD8 | FIFO1A_DIN8/DOUT8 | T15 |
| BK0_IO28 | 0 | 14N | 1A | 12 | HSI1A_SYDT ⁵ | HSI1A_RXD9/TXD9 | FIFO1A_DIN9/DOUT9 | AA18 |
| BK0_IO29 | 0 | 14P | 1A | 13 | HSI1A_CDRRSTb ⁵ | HSI1A_RECCLK | FIFO1A_FIFORSTb | AB18 |
| BK0_IO30 | 0 | 15N | 1A | 14 | FIFO1A_STRDb ⁶ | - | - | W18 |
| BK0_IO31 | 0 | 15P | 1A | 15 | - | - | FIFO1A_EMPTY | Y19 |
| GND | 0 | - | - | - | - | - | - | GND |
| GOE3 | - | - | - | - | - | - | - | AA19 |
| TDO | - | - | - | - | - | - | - | AB19 |
| GND | 1 | - | - | - | - | - | - | GND |
| BK1_IO0 | 1 | 16P | 0B | 0 | - | - | FIFO0B_FULL | W21 |
| BK1_IO1 | 1 | 16N | 0B | 1 | - | HSI0B_SYDT ⁵ | - | W20 |
| BK1_IO2 | 1 | 17P | 0B | 2 | - | HSI0B_RXD0/TXD0 | FIFO0B_DIN0/DOUT0 | V22 |
| BK1_IO3 | 1 | 17N | 0B | 3 | Note 4 | HSI0B_RXD1/TXD1 | FIFO0B_DIN1/DOUT1 | W22 |
| BK1_IO4 | 1 | 18P | 0B | 4 | HSI0B_SINP | HSI0B_RXD2/TXD2 | FIFO0B_DIN2/DOUT2 | P16 |

ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|-----------------------|------------|--------------------|-----------------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK1_IO5 | 1 | 18N | 0B | 5 | HSI0B_SINN | HSI0B_RXD3/TXD3 | FIFO0B_DIN3/DOUT3 | P17 |
| BK1_IO6 | 1 | 19P | 0B | 6 | HSI0_CSLOCK | HSI0B_RXD4/TXD4 | FIFO0B_DIN4/DOUT4 | U18 |
| BK1_IO7 | 1 | 19N | 0B | 7 | - | HSI0B_RXD5/TXD5 | FIFO0B_DIN5/DOUT5 | V19 |
| BK1_IO8 | 1 | 20P | 0B | 8 | - | HSI0B_RXD6/TXD6 | FIFO0B_DIN6/DOUT6 | V20 |
| BK1_IO9 | 1 | 20N | 0B | 9 | HSI0B_SYDT ⁵ | HSI0B_RXD7/TXD7 | FIFO0B_DIN7/DOUT7 | V21 |
| BK1_IO10/ VREF1 | 1 | 21P | 0B | 10 | HSI0B_SOUTP | HSI0B_RXD8/TXD8 | FIFO0B_DIN8/DOUT8 | R16 |
| BK1_IO11 | 1 | 21N | 0B | 11 | HSI0B_SOUTN | HSI0B_RXD9/TXD9 | FIFO0B_DIN9/DOUT9 | R17 |
| GND | 1 | - | - | - | - | - | - | GND |
| BK1_IO12 | 1 | 22P | 0B | 12 | HSI0B_CDRRSTb | HSI0B_RECCLK | FIFO0B_FIFORSTb | U19 |
| BK1_IO13 | 1 | 22N | 0B | 13 | FIFO0B_STRDb ⁶ | - | - | T19 |
| BK1_IO14 | 1 | 23P | 0B | 14 | - | - | - | U21 |
| BK1_IO15 | 1 | 23N | 0B | 15 | - | - | FIFO0B_EMPTY | U22 |
| BK1_IO16 | 1 | 24P | 1B | 0 | - | HSI1B_SYDT ⁵ | FIFO1B_FULL | R19 |
| BK1_IO17 | 1 | 24N | 1B | 1 | - | HSI1B_RXD0/TXD0 | FIFO1B_DIN0/DOUT0 | T20 |
| BK1_IO18 | 1 | 25P | 1B | 2 | Note 4 | HSI1B_RXD1/TXD1 | FIFO1B_DIN1/DOUT1 | T21 |
| BK1_IO19 | 1 | 25N | 1B | 3 | - | HSI1B_RXD2/TXD2 | FIFO1B_DIN2/DOUT2 | T22 |
| GND | 1 | - | - | - | - | - | - | GND |
| BK1_IO20 | 1 | 26P | 1B | 4 | HSI1B_SOUTP | HSI1B_RXD3/TXD3 | FIFO1B_DIN3/DOUT3 | N16 |
| BK1_IO21 | 1 | 26N | 1B | 5 | HSI1B_SOUTN | HSI1B_RXD4/TXD4 | FIFO1B_DIN4/DOUT4 | N17 |
| BK1_IO22 | 1 | 27P | 1B | 6 | HSI1_CSLOCK | HSI1B_RXD5/TXD5 | FIFO1B_DIN5/DOUT5 | R20 |
| BK1_IO23 | 1 | 27N | 1B | 7 | HSI1B_SYDT ⁵ | HSI1B_RXD6/TXD6 | FIFO1B_DIN6/DOUT6 | R21 |
| BK1_IO24 | 1 | 28P | 1B | 8 | - | HSI1B_RXD7/TXD7 | FIFO1B_DIN7/DOUT7 | N19 |
| BK1_IO25 | 1 | 28N | 1B | 9 | - | HSI1B_RXD8/TXD8 | FIFO1B_DIN8/DOUT8 | P20 |
| BK1_IO26 | 1 | 29P | 1B | 10 | HSI1B_SINP | HSI1B_RXD9/TXD9 | FIFO1B_DIN9/DOUT9 | P18 |
| BK1_IO27 | 1 | 29N | 1B | 11 | HSI1B_SINN | HSI1B_RECCLK | - | N18 |
| GND | 1 | - | - | - | - | - | - | GND |
| BK1_IO28 | 1 | 30P | 1B | 12 | FIFO1B_STRDb ⁶ | - | - | R22 |
| BK1_IO29 | 1 | 30N | 1B | 13 | HSI1B_CDRRSTb | - | FIFO1B_FIFORSTb | P22 |
| BK1_IO30 | 1 | 31P | 1B | 14 | SS_CLKIN1P | - | - | M18 |
| BK1_IO31/ CLK_OUT2 | 1 | 31N | 1B | 15 | SS_CLKIN1N | - | FIFO1B_EMPTY | M17 |
| GCLK/CE2 | - | CLK2P | - | - | - | - | - | N20 |
| SEL2 | - | - | - | - | - | - | - | N21 |
| SEL3 | - | - | - | - | - | - | - | K21 |
| GCLK/CE3 | - | CLK2N | - | - | - | - | - | K20 |
| BK2_IO0/ CLK_OUT3 | 2 | 32N | 3A ⁷ | 0 | SS_CLKOUT1N | - | FIFO3A_FULL | K17 |
| BK2_IO1 | 2 | 32P | 3A ⁷ | 1 | SS_CLKOUT1P | - | - | K18 |
| BK2_IO2 | 2 | 33N | 3A ⁷ | 2 | - | HSI3A_SYDT ⁵ | - | L17 |
| BK2_IO3 | 2 | 33P | 3A ⁷ | 3 | - | HSI3A_RXD0/TXD0 | FIFO3A_DIN0/DOUT0 | L18 |
| GND | 2 | - | - | - | - | - | - | GND |
| BK2_IO4 | 2 | 34N | 3A ⁷ | 4 | HSI3A_SINN | HSI3A_RXD1/TXD1 | FIFO3A_DIN1/DOUT1 | J17 |
| BK2_IO5 | 2 | 34P | 3A ⁷ | 5 | HSI3A_SINP | HSI3A_RXD2/TXD2 | FIFO3A_DIN2/DOUT2 | J18 |
| BK2_IO6 | 2 | 35N | 3A ⁷ | 6 | HSI3_CSLOCK | HSI3A_RXD3/TXD3 | FIFO3A_DIN3/DOUT3 | J22 |
| BK2_IO7 | 2 | 35P | 3A ⁷ | 7 | Note 4 | HSI3A_RXD4/TXD4 | FIFO3A_DIN4/DOUT4 | J20 |
| BK2_IO8 | 2 | 36N | 3A ⁷ | 8 | CAL | HSI3A_RXD5/TXD5 | FIFO3A_DIN5/DOUT5 | H22 |
| BK2_IO9 | 2 | 36P | 3A ⁷ | 9 | - | HSI3A_RXD6/TXD6 | FIFO3A_DIN6/DOUT6 | H21 |

ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|-----------------------|------------|--------------------|-----------------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK2_IO10 | 2 | 37N | 3A ⁷ | 10 | HSI3A_SOUTN | HSI3A_RXD7/TXD7 | FIFO3A_DIN7/DOUT7 | K16 |
| BK2_IO11 | 2 | 37P | 3A ⁷ | 11 | HSI3A_SOUTP | HSI3A_RXD8/TXD8 | FIFO3A_DIN8/DOUT8 | J16 |
| GND | 2 | - | - | - | - | - | - | GND |
| BK2_IO12 | 2 | 38N | 3A ⁷ | 12 | HSI3A_SYDT ⁵ | HSI3A_RXD9/TXD9 | FIFO3A_DIN9/DOUT9 | J19 |
| BK2_IO13 | 2 | 38P | 3A ⁷ | 13 | HSI3A_CDRRSTb | HSI3A_RECCLK | FIFO3A_FIFORSTb | H20 |
| BK2_IO14 | 2 | 39N | 3A ⁷ | 14 | FIFO3A_STRDb ⁶ | - | - | G21 |
| BK2_IO15 | 2 | 39P | 3A ⁷ | 15 | - | - | FIFO3A_EMPTY | G20 |
| BK2_IO16 | 2 | 40N | 2A | 0 | - | - | FIFO2A_FULL | G22 |
| BK2_IO17 | 2 | 40P | 2A | 1 | - | HSI2A_SYDT ⁵ | - | F22 |
| BK2_IO18 | 2 | 41N | 2A | 2 | - | HSI2A_RXD0/TXD0 | FIFO2A_DIN0/DOUT0 | F20 |
| BK2_IO19 | 2 | 41P | 2A | 3 | Note 4 | HSI2A_RXD1/TXD1 | FIFO2A_DIN1/DOUT1 | F21 |
| GND | 2 | - | - | - | - | - | - | GND |
| BK2_IO20/ PLL_FB3 | 2 | 42N | 2A | 4 | HSI2A_SOUTN | HSI2A_RXD2/TXD2 | FIFO2A_DIN2/DOUT2 | H18 |
| BK2_IO21/ VREF2 | 2 | 42P | 2A | 5 | HSI2A_SOUTP | HSI2A_RXD3/TXD3 | FIFO2A_DIN3/DOUT3 | G17 |
| BK2_IO22 | 2 | 43N | 2A | 6 | HSI2_CSLOCK | HSI2A_RXD4/TXD4 | FIFO2A_DIN4/DOUT4 | E21 |
| BK2_IO23 | 2 | 43P | 2A | 7 | - | HSI2A_RXD5/TXD5 | FIFO2A_DIN5/DOUT5 | F19 |
| BK2_IO24 | 2 | 44N | 2A | 8 | - | HSI2A_RXD6/TXD6 | FIFO2A_DIN6/DOUT6 | E22 |
| BK2_IO25 | 2 | 44P | 2A | 9 | HSI2A_SYDT ⁵ | HSI2A_RXD7/TXD7 | FIFO2A_DIN7/DOUT7 | D22 |
| BK2_IO26 | 2 | 45N | 2A | 10 | HSI2A_SINN | HSI2A_RXD8/TXD8 | FIFO2A_DIN8/DOUT8 | H17 |
| BK2_IO27 | 2 | 45P | 2A | 11 | HSI2A_SINP | HSI2A_RXD9/TXD9 | FIFO2A_DIN9/DOUT9 | H16 |
| BK2_IO28 | 2 | 46N | 2A | 12 | HSI2A_CDRRSTb | HSI2A_RECCLK | FIFO2A_FIFORSTb | E19 |
| BK2_IO29 | 2 | 46P | 2A | 13 | FIFO2A_STRDb ⁶ | - | - | F18 |
| BK2_IO30 | 2 | 47N | 2A | 14 | - | - | - | D20 |
| BK2_IO31 | 2 | 47P | 2A | 15 | - | - | FIFO2A_EMPTY | D21 |
| GND | 2 | - | - | - | - | - | - | GND |
| TCK | - | - | - | - | - | - | - | B19 |
| GOE2 | - | - | - | - | - | - | - | C19 |
| BK3_IO0 | 3 | 48P | 3B | 0 | - | HSI3B_SYDT ⁵ | FIFO3B_FULL | E17 |
| BK3_IO1 | 3 | 48N | 3B | 1 | - | HSI3B_RXD0/TXD0 | FIFO3B_DIN0/DOUT0 | D18 |
| BK3_IO2 | 3 | 49P | 3B | 2 | Note 4 | HSI3B_RXD1/TXD1 | FIFO3B_DIN1/DOUT1 | A19 |
| BK3_IO3 | 3 | 49N | 3B | 3 | - | HSI3B_RXD2/TXD2 | FIFO3B_DIN2/DOUT2 | A18 |
| GND | 3 | - | - | - | - | - | - | GND |
| BK3_IO4 | 3 | 50P | 3B | 4 | HSI3B_SINP | HSI3B_RXD3/TXD3 | FIFO3B_DIN3/DOUT3 | G15 |
| BK3_IO5 | 3 | 50N | 3B | 5 | HSI3B_SINN | HSI3B_RXD4/TXD4 | FIFO3B_DIN4/DOUT4 | G14 |
| BK3_IO6 | 3 | 51P | 3B | 6 | - | HSI3B_RXD5/TXD5 | FIFO3B_DIN5/DOUT5 | D17 |
| BK3_IO7 | 3 | 51N | 3B | 7 | HSI3B_SYDT ⁵ | HSI3B_RXD6/TXD6 | FIFO3B_DIN6/DOUT6 | D16 |
| BK3_IO8 | 3 | 52P | 3B | 8 | - | HSI3B_RXD7/TXD7 | FIFO3B_DIN7/DOUT7 | C18 |
| BK3_IO9 | 3 | 52N | 3B | 9 | - | HSI3B_RXD8/TXD8 | FIFO3B_DIN8/DOUT8 | B18 |
| BK3_IO10/ VREF3 | 3 | 53P | 3B | 10 | HSI3B_SOUTP | HSI3B_RXD9/TXD9 | FIFO3B_DIN9/DOUT9 | F15 |
| BK3_IO11 | 3 | 53N | 3B | 11 | HSI3B_SOUTN | HSI3B_RECCLK | - | F14 |
| GND | 3 | - | - | - | - | - | - | GND |
| BK3_IO12 | 3 | 54P | 3B | 12 | FIFO3B_STRDb ⁶ | - | - | B17 |
| BK3_IO13 | 3 | 54N | 3B | 13 | HSI3B_CDRRSTb | HSI3B_RECCLK | FIFO3B_FIFORSTb | A17 |
| BK3_IO14/ PLL_RST3 | 3 | 55P | 3B | 14 | - | - | - | A16 |

ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|------------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK3_IO15 | 3 | 55N | 3B | 15 | - | - | FIFO3B_EMPTY | C16 |
| BK3_IO16 | 3 | 56P | 2B | 0 | - | HSI2B_RXD0/TXD0 | FIFO2B_DIN0/DOUT0 | D15 |
| BK3_IO17 | 3 | 56N | 2B | 1 | Note 4 | HSI2B_RXD1/TXD1 | FIFO2B_DIN1/DOUT1 | D14 |
| BK3_IO18 | 3 | 57P | 2B | 2 | - | HSI2B_RXD2/TXD2 | FIFO2B_DIN2/DOUT2 | B16 |
| BK3_IO19 | 3 | 57N | 2B | 3 | - | HSI2B_RXD3/TXD3 | FIFO2B_DIN3/DOUT3 | C15 |
| GND | 3 | - | - | - | - | - | - | GND |
| BK3_IO20 | 3 | 58P | 2B | 4 | HSI2B_SOUTP | HSI2B_RXD4/TXD4 | FIFO2B_DIN4/DOUT4 | G13 |
| BK3_IO21 | 3 | 58N | 2B | 5 | HSI2B_SOUTN | HSI2B_RXD5/TXD5 | FIFO2B_DIN5/DOUT5 | G12 |
| BK3_IO22 | 3 | 59P | 2B | 6 | - | HSI2B_RXD6/TXD6 | FIFO2B_DIN6/DOUT6 | B15 |
| BK3_IO23 | 3 | 59N | 2B | 7 | FIFO2B_STRDb ⁶ | HSI2B_RXD7/TXD7 | FIFO2B_DIN7 /DOUT7 | A15 |
| BK3_IO24 | 3 | 60P | 2B | 8 | - | HSI2B_RXD8/TXD8 | FIFO2B_DIN8/DOUT8 | C14 |
| BK3_IO25 | 3 | 60N | 2B | 9 | HSI2B_SYDT ⁵ | HSI2B_RXD9/TXD9 | FIFO2B_DIN9/DOUT9 | A14 |
| BK3_IO26 | 3 | 61P | 2B | 10 | HSI2B_SINP | HSI2B_RECCLK | - | F13 |
| BK3_IO27 | 3 | 61N | 2B | 11 | HSI2B_SINN | - | - | F12 |
| GND | 3 | - | - | - | - | - | - | GND |
| BK3_IO28 | 3 | 62P | 2B | 12 | - | HSI2B_SYDT ⁵ | FIFO2B_FULL | D13 |
| BK3_IO29 | 3 | 62N | 2B | 13 | HSI2B_CDRRSTb | - | FIFO2B_FIFORSTb | C13 |
| BK3_IO30/ PLL_LOCK3 | 3 | 63P | 2B | 14 | - | - | - | B13 |
| BK3_IO31 | 3 | 63N | 2B | 15 | - | - | FIFO2B_EMPTY | A13 |
| RESETb | - | - | - | - | - | - | - | D12 |
| BK4_IO0 | 4 | 64N | 4A | 0 | - | - | FIFO4A_EMPTY | A10 |
| BK4_IO1/ PLL_LOCK0 | 4 | 64P | 4A | 1 | - | - | - | B10 |
| BK4_IO2 | 4 | 65N | 4A | 2 | HSI4A_CDRRSTb | - | FIFO4A_FIFORSTb | E11 |
| BK4_IO3 | 4 | 65P | 4A | 3 | - | HSI4A_SYDT ⁵ | FIFO4A_FULL | E10 |
| GND | 4 | - | - | - | - | - | - | GND |
| BK4_IO4 | 4 | 66N | 4A | 4 | HSI4A_SINN | - | - | F11 |
| BK4_IO5 | 4 | 66P | 4A | 5 | HSI4A_SINP | HSI4A_RECCLK | - | F10 |
| BK4_IO6 | 4 | 67N | 4A | 6 | HSI4A_SYDT ⁵ | HSI4A_RXD9/TXD9 | FIFO4A_DIN9/DOUT9 | C10 |
| BK4_IO7 | 4 | 67P | 4A | 7 | - | HSI4A_RXD8/TXD8 | FIFO4A_DIN8/DOUT8 | C9 |
| BK4_IO8 | 4 | 68N | 4A | 8 | FIFO4A_STRDb ⁶ | HSI4A_RXD7/TXD7 | FIFO4A_DIN7 /DOUT7 | D10 |
| BK4_IO9/ PLL_FB0 | 4 | 68P | 4A | 9 | - | HSI4A_RXD6/TXD6 | FIFO4A_DIN6/DOUT6 | D9 |
| BK4_IO10 | 4 | 69N | 4A | 10 | HSI4A_SOUTN | HSI4A_RXD5/TXD5 | FIFO4A_DIN5/DOUT5 | G11 |
| BK4_IO11 | 4 | 69P | 4A | 11 | HSI4A_SOUTP | HSI4A_RXD4/TXD4 | FIFO4A_DIN4/DOUT4 | G10 |
| GND | 4 | - | - | - | - | - | - | GND |
| BK4_IO12 | 4 | 70N | 4A | 12 | - | HSI4A_RXD3/TXD3 | FIFO4A_DIN3/DOUT3 | A9 |
| BK4_IO13 | 4 | 70P | 4A | 13 | - | HSI4A_RXD2/TXD2 | FIFO4A_DIN2/DOUT2 | C8 |
| BK4_IO14 | 4 | 71N | 4A | 14 | Note 4 | HSI4A_RXD1/TXD1 | FIFO4A_DIN1/DOUT1 | B8 |
| BK4_IO15 | 4 | 71P | 4A | 15 | - | HSI4A_RXD0/TXD0 | FIFO4A_DIN0/DOUT0 | A8 |
| BK4_IO16 | 4 | 72N | 5A | 0 | - | - | FIFO5A_EMPTY | B7 |
| BK4_IO17/ PLL_RST0 | 4 | 72P | 5A | 1 | - | - | - | C7 |
| BK4_IO18 | 4 | 73N | 5A | 2 | HSI5A_CDRRSTb | - | FIFO5A_FIFORSTb | A7 |
| BK4_IO19 | 4 | 73P | 5A | 3 | FIFO5A_STRDb ⁶ | - | - | B6 |
| GND | 4 | - | - | - | - | - | - | GND |
| BK4_IO20 | 4 | 74N | 5A | 4 | HSI5A_SOUTN | HSI5A_RECCLK | - | F9 |

ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|----------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| BK4_IO21/VREF4 | 4 | 74P | 5A | 5 | HSI5A_SOUTP | HSI5A_RXD9/TXD9 | FIFO5A_DIN9/DOUT9 | F8 |
| BK4_IO22 | 4 | 75N | 5A | 6 | - | HSI5A_RXD8/TXD8 | FIFO5A_DIN8/DOUT8 | D7 |
| BK4_IO23 | 4 | 75P | 5A | 7 | - | HSI5A_RXD7/TXD7 | FIFO5A_DIN7/DOUT7 | D6 |
| BK4_IO24 | 4 | 76N | 5A | 8 | HSI5A_SYDT ⁵ | HSI5A_RXD6/TXD6 | FIFO5A_DIN6/DOUT6 | A6 |
| BK4_IO25 | 4 | 76P | 5A | 9 | - | HSI5A_RXD5/TXD5 | FIFO5A_DIN5/DOUT5 | A5 |
| BK4_IO26 | 4 | 77N | 5A | 10 | HSI5A_SINN | HSI5A_RXD4/TXD4 | FIFO5A_DIN4/DOUT4 | G9 |
| BK4_IO27 | 4 | 77P | 5A | 11 | HSI5A_SINP | HSI5A_RXD3/TXD3 | FIFO5A_DIN3/DOUT3 | G8 |
| BK4_IO28 | 4 | 78N | 5A | 12 | - | HSI5A_RXD2/TXD2 | FIFO5A_DIN2/DOUT2 | C5 |
| BK4_IO29 | 4 | 78P | 5A | 13 | Note 4 | HSI5A_RXD1/TXD1 | FIFO5A_DIN1/DOUT1 | B5 |
| BK4_IO30 | 4 | 79N | 5A | 14 | - | HSI5A_RXD0/TXD0 | FIFO5A_DIN0/DOUT0 | D5 |
| BK4_IO31 | 4 | 79P | 5A | 15 | - | HSI5A_SYDT ⁵ | FIFO5A_FULL | C4 |
| GND | 4 | - | - | - | - | - | - | GND |
| GOE1 | - | - | - | - | - | - | - | B4 |
| TMS | - | - | - | - | - | - | - | A4 |
| GND | 5 | - | - | - | - | - | - | GND |
| BK5_IO0 | 5 | 80P | 4B | 0 | - | - | FIFO4B_EMPTY | D2 |
| BK5_IO1 | 5 | 80N | 4B | 1 | - | - | - | D3 |
| BK5_IO2 | 5 | 81P | 4B | 2 | FIFO4B_STRDb ⁶ | - | - | F5 |
| BK5_IO3 | 5 | 81N | 4B | 3 | HSI4B_CDRRSTb | HSI4B_RECCLK | FIFO4B_FIFORSTb | E4 |
| BK5_IO4 | 5 | 82P | 4B | 4 | HSI4B_SINP | HSI4B_RXD9/TXD9 | FIFO4B_DIN9/DOUT9 | J7 |
| BK5_IO5 | 5 | 82N | 4B | 5 | HSI4B_SINN | HSI4B_RXD8/TXD8 | FIFO4B_DIN8/DOUT8 | J6 |
| BK5_IO6 | 5 | 83P | 4B | 6 | HSI4B_SYDT ⁵ | HSI4B_RXD7/TXD7 | FIFO4B_DIN7/DOUT7 | D1 |
| BK5_IO7 | 5 | 83N | 4B | 7 | - | HSI4B_RXD6/TXD6 | FIFO4B_DIN6/DOUT6 | E1 |
| BK5_IO8 | 5 | 84P | 4B | 8 | - | HSI4B_RXD5/TXD5 | FIFO4B_DIN5/DOUT5 | F4 |
| BK5_IO9 | 5 | 84N | 4B | 9 | HSI4_CSLOCK | HSI4_RXD4/TXD4 | FIFO4B_DIN4/DOUT4 | E3 |
| BK5_IO10/VREF5 | 5 | 85P | 4B | 10 | HSI4B_SOUTP | HSI4B_RXD3/TXD3 | FIFO4B_DIN3/DOUT3 | H7 |
| BK5_IO11 | 5 | 85N | 4B | 11 | HSI4B_SOUTN | HSI4B_RXD2/TXD2 | FIFO4B_DIN2/DOUT2 | H6 |
| GND | 5 | - | - | - | - | - | - | GND |
| BK5_IO12 | 5 | 86P | 4B | 12 | Note 4 | HSI4B_RXD1/TXD1 | FIFO4B_DIN1/DOUT1 | E2 |
| BK5_IO13 | 5 | 86N | 4B | 13 | - | HSI4B_RXD0/TXD0 | FIFO4B_DIN0/DOUT0 | F2 |
| BK5_IO14 | 5 | 87P | 4B | 14 | - | HSI4B_SYDT ⁵ | - | G4 |
| BK5_IO15 | 5 | 87N | 4B | 15 | - | - | FIFO4B_FULL | H5 |
| BK5_IO16 | 5 | 88P | 5B | 0 | - | - | FIFO5B_EMPTY | F1 |
| BK5_IO17 | 5 | 88N | 5B | 1 | FIFO5B_STRDb ⁶ | - | - | G1 |
| BK5_IO18 | 5 | 89P | 5B | 2 | HSI5B_CDRRSTb | HSI5B_RECCLK | FIFO5B_FIFORSTb | G3 |
| BK5_IO19 | 5 | 89N | 5B | 3 | HSI5B_SYDT ⁵ | HSI5B_RXD9/TXD9 | FIFO5B_DIN9/DOUT9 | G2 |
| GND | 5 | - | - | - | - | - | - | GND |
| BK5_IO20 | 5 | 90P | 5B | 4 | HSI5B_SOUTP | HSI5B_RXD8/TXD8 | FIFO5B_DIN8/DOUT8 | K7 |
| BK5_IO21 | 5 | 90N | 5B | 5 | HSI5B_SOUTN | HSI5B_RXD7/TXD7 | FIFO5B_DIN7/DOUT7 | K6 |
| BK5_IO22 | 5 | 91P | 5B | 6 | - | HSI5B_RXD6/TXD6 | FIFO5B_DIN6/DOUT6 | H4 |
| BK5_IO23 | 5 | 91N | 5B | 7 | - | HSI5B_RXD5/TXD5 | FIFO5B_DIN5/DOUT5 | H3 |
| BK5_IO24 | 5 | 92P | 5B | 8 | Note 4 | HSI5B_RXD4/TXD4 | FIFO5B_DIN4/DOUT4 | H1 |
| BK5_IO25 | 5 | 92N | 5B | 9 | HSI5_CSLOCK | HSI5B_RXD3/TXD3 | FIFO5B_DIN3/DOUT3 | H2 |
| BK5_IO26 | 5 | 93P | 5B | 10 | HSI5B_SINP | HSI5B_RXD2/TXD2 | FIFO5B_DIN2/DOUT2 | J5 |
| BK5_IO27 | 5 | 93N | 5B | 11 | HSI5B_SINN | HSI5B_RXD1/TXD1 | FIFO5B_DIN1/DOUT1 | K5 |

ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|-----------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| GND | 5 | - | - | - | - | - | - | GND |
| BK5_IO28 | 5 | 94P | 5B | 12 | - | HSI5B_RXD0/TXD0 | FIFO5B_DIN0/DOUT0 | J4 |
| BK5_IO29 | 5 | 94N | 5B | 13 | - | HSI5B_SYDT ⁵ | - | J3 |
| BK5_IO30 | 5 | 95P | 5B | 14 | SS_CLKIN0P | - | - | L6 |
| BK5_IO31/ CLK_OUT0 | 5 | 95N | 5B | 15 | SS_CLKIN0N | - | FIFO5B_FULL | L5 |
| GCLK/CE0 | - | CLK0P | - | - | - | - | - | L4 |
| SEL0 | - | - | - | - | - | - | - | K3 |
| SEL1 | - | - | - | - | - | - | - | K2 |
| GCLK/CE1 | - | CLK0N | - | - | - | - | - | N1 |
| BK6_IO0/ CLK_OUT1 | 6 | 96N | 7A | 0 | SS_CLKOUT0N | - | FIFO7A_EMPTY | N6 |
| BK6_IO1 | 6 | 96P | 7A | 1 | SS_CLKOUT0P | - | - | N5 |
| BK6_IO2 | 6 | 97N | 7A | 2 | HSI7A_CDRRST | - | FIFO7A_FIFORSTb | M5 |
| BK6_IO3 | 6 | 97P | 7A | 3 | FIFO7A_STRDb ⁵ | - | - | M6 |
| GND | 6 | - | - | - | - | - | - | GND |
| BK6_IO4 | 6 | 98N | 7A | 4 | HSI7A_SINN | HSI7A_RECCLK | - | P6 |
| BK6_IO5 | 6 | 98P | 7A | 5 | HSI7A_SINP | HSI7A_RXD9/TXD9 | FIFO7A_DIN9/DOUT9 | P5 |
| BK6_IO6 | 6 | 99N | 7A | 6 | - | HSI7A_RXD8/TXD8 | FIFO7A_DIN8/DOUT8 | N3 |
| BK6_IO7 | 6 | 99P | 7A | 7 | - | HSI7A_RXD7/TXD7 | FIFO7A_DIN7/DOUT7 | N2 |
| BK6_IO8 | 6 | 100N | 7A | 8 | HSI7A_SYDT ⁵ | HSI7A_RXD6/TXD6 | FIFO7A_DIN6/DOUT6 | P3 |
| BK6_IO9 | 6 | 100P | 7A | 9 | HSI7_CSLOCK | HSI7A_RXD5/TXD5 | FIFO7A_DIN5/DOUT5 | P1 |
| BK6_IO10 | 6 | 101N | 7A | 10 | HSI7A_SOUTN | HSI7A_RXD4/TXD4 | FIFO7A_DIN4/DOUT4 | N7 |
| BK6_IO11 | 6 | 101P | 7A | 11 | HSI7A_SOUTP | HSI7A_RXD3/TXD3 | FIFO7A_DIN3/DOUT3 | P7 |
| GND | 6 | - | - | - | - | - | - | GND |
| BK6_IO12 | 6 | 102N | 7A | 12 | - | HSI7A_RXD2/TXD2 | FIFO7A_DIN2/DOUT2 | R3 |
| BK6_IO13 | 6 | 102P | 7A | 13 | Note 4 | HSI7A_RXD1/TXD1 | FIFO7A_DIN1/DOUT1 | R2 |
| BK6_IO14 | 6 | 103N | 7A | 14 | - | HSI7A_RXD0/TXD0 | FIFO7A_DIN0/DOUT0 | R1 |
| BK6_IO15 | 6 | 103P | 7A | 15 | - | HSI7A_SYDT ⁵ | FIFO7A_FULL | T1 |
| BK6_IO16 | 6 | 104N | 6A | 0 | - | - | FIFO6A_EMPTY | T2 |
| BK6_IO17 | 6 | 104P | 6A | 1 | - | - | - | T3 |
| BK6_IO18 | 6 | 105N | 6A | 2 | FIFO6A_STRDb ⁵ | - | - | U1 |
| BK6_IO19 | 6 | 105P | 6A | 3 | HSI6A_CDRRSTb | HSI6_RECCLK | FIFO6A_FIFORSTb | U2 |
| GND | 6 | - | - | - | - | - | - | GND |
| BK6_IO20/ PLL_FB1 | 6 | 106N | 6A | 4 | HSI6A_SOUTN | HSI6A_RXD9/TXD9 | FIFO6A_DIN9/DOUT9 | R5 |
| BK6_IO21/ VREF6 | 6 | 106P | 6A | 5 | HSI6A_SOUTP | HSI6A_RXD8/TXD8 | FIFO6A_DIN8/DOUT8 | T6 |
| BK6_IO22 | 6 | 107N | 6A | 6 | HSI6A_SYDT ⁵ | HSI6A_RXD7/TXD7 | FIFO6A_DIN7/DOUT7 | U4 |
| BK6_IO23 | 6 | 107P | 6A | 7 | - | HSI6A_RXD6/TXD6 | FIFO6A_DIN6/DOUT6 | V4 |
| BK6_IO24 | 6 | 108N | 6A | 8 | - | HSI6A_RXD5/TXD5 | FIFO6A_DIN5/DOUT5 | V3 |
| BK6_IO25 | 6 | 108P | 6A | 9 | HSI6_CSLOCK | HSI6A_RXD4/TXD4 | FIFO6A_DIN4/DOUT4 | V2 |
| BK6_IO26 | 6 | 109N | 6A | 10 | HSI6A_SINN | HSI6A_RXD3/TXD3 | FIFO6A_DIN3/DOUT3 | R6 |
| BK6_IO27 | 6 | 109P | 6A | 11 | HSI6A_SINP | HSI6A_RXD2/TXD2 | FIFO6A_DIN2/DOUT2 | R7 |
| BK6_IO28 | 6 | 110N | 6A | 12 | Note 4 | HSI6A_RXD1/TXD1 | FIFO6A_DIN1/DOUT1 | W1 |
| BK6_IO29 | 6 | 110P | 6A | 13 | - | HSI6A_RXD0/TXD0 | FIFO6A_DIN0/DOUT0 | V1 |
| BK6_IO30 | 6 | 111N | 6A | 14 | - | HSI6A_SYDT ⁵ | - | W2 |
| BK6_IO31 | 6 | 111P | 6A | 15 | - | - | FIFO6A_FULL | W3 |

ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|------------------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| GND | 6 | - | - | - | - | - | - | GND |
| TDI | - | - | - | - | - | - | - | AA4 |
| GOE0 | - | - | - | - | - | - | - | Y4 |
| GND | 7 | - | - | - | - | - | - | GND |
| BK7_IO0 | 7 | 112P | 7B | 0 | - | - | FIFO7B_EMPTY | AB4 |
| BK7_IO1 | 7 | 112N | 7B | 1 | FIFO7B_STRDb ⁶ | - | - | AB5 |
| BK7_IO2 | 7 | 113P | 7B | 2 | HSI7B_CDRRSTb | HSI7B_RECCLK | FIFO7B_FIFORSTb | V6 |
| BK7_IO3 | 7 | 113N | 7B | 3 | HSI7B_SYDT ⁵ | HSI7B_RXD9/TXD9 | FIFO7B_DIN9/DOUT9 | W5 |
| BK7_IO4 | 7 | 114P | 7B | 4 | HSI7B_SINP | HSI7B_RXD8/TXD8 | FIFO7B_DIN8/DOUT8 | T8 |
| BK7_IO5 | 7 | 114N | 7B | 5 | HSI7B_SINN | HSI7B_RXD7/TXD7 | FIFO7B_DIN7/DOUT7 | T9 |
| BK7_IO6 | 7 | 115P | 7B | 6 | - | HSI7B_RXD6/TXD6 | FIFO7B_DIN6/DOUT6 | W6 |
| BK7_IO7 | 7 | 115N | 7B | 7 | - | HSI7B_RXD5/TXD5 | FIFO7B_DIN5/DOUT5 | Y5 |
| BK7_IO8 | 7 | 116P | 7B | 8 | Note 4 | HSI7B_RXD4/TXD4 | FIFO7B_DIN4/DOUT4 | AA5 |
| BK7_IO9 | 7 | 116N | 7B | 9 | - | HSI7B_RXD3/TXD3 | FIFO7B_DIN3/DOUT3 | AA6 |
| BK7_IO10/ VREF7 | 7 | 117P | 7B | 10 | HSI7B_SOUTP | HSI7B_RXD2/TXD2 | FIFO7B_DIN2/DOUT2 | U8 |
| BK7_IO11 | 7 | 117N | 7B | 11 | HSI7B_SOUTN | HSI7B_RXD1/TXD1 | FIFO7B_DIN1/DOUT1 | U9 |
| GND | 7 | - | - | - | - | - | - | GND |
| BK7_IO12 | 7 | 118P | 7B | 12 | - | HSI7B_RXD0/TXD0 | FIFO7B_DIN0/DOUT0 | W7 |
| BK7_IO13 | 7 | 118N | 7B | 13 | - | HSI7B_SYDT ⁵ | - | W8 |
| BK7_IO14/ PLL_RST1 | 7 | 119P | 7B | 14 | - | - | - | AB6 |
| BK7_IO15 | 7 | 119N | 7B | 15 | - | - | FIFO7B_FULL | AB7 |
| BK7_IO16 | 7 | 120P | 6B | 0 | FIFO6B_STRDb ⁶ | - | - | Y7 |
| BK7_IO17 | 7 | 120N | 6B | 1 | HSI6B_CDRRSTb | HSI6B_RECCLK | FIFO6B_FIFORSTb | AA7 |
| BK7_IO18 | 7 | 121P | 6B | 2 | HSI6B_SYDT ⁵ | HSI6B_RXD9/TXD9 | FIFO6B_DIN9/DOUT9 | W9 |
| BK7_IO19 | 7 | 121N | 6B | 3 | - | HSI6B_RXD8/TXD8 | FIFO6B_DIN8/DOUT8 | Y8 |
| GND | 7 | - | - | - | - | - | - | GND |
| BK7_IO20 | 7 | 122P | 6B | 4 | HSI6B_SOUTP | HSI6B_RXD7/TXD7 | FIFO6B_DIN7/DOUT7 | T10 |
| BK7_IO21 | 7 | 122N | 6B | 5 | HSI6B_SOUTN | HSI6B_RXD6/TXD6 | FIFO6B_DIN6/DOUT6 | T11 |
| BK7_IO22 | 7 | 123P | 6B | 6 | - | HSI6B_RXD5/TXD5 | FIFO6B_DIN5/DOUT5 | AA8 |
| BK7_IO23 | 7 | 123N | 6B | 7 | - | HSI6B_RXD4/TXD4 | FIFO6B_DIN4/DOUT4 | AB8 |
| BK7_IO24 | 7 | 124P | 6B | 8 | Note 4 | HSI6B_RXD3/TXD3 | FIFO6B_DIN3/DOUT3 | W10 |
| BK7_IO25 | 7 | 124N | 6B | 9 | - | HSI6B_RXD2/TXD2 | FIFO6B_DIN2/DOUT2 | Y9 |
| BK7_IO26 | 7 | 125P | 6B | 10 | HSI6B_SINP | HSI6B_RXD1/TXD1 | FIFO6B_DIN1/DOUT1 | U10 |
| BK7_IO27 | 7 | 125N | 6B | 11 | HSI6B_SINN | HSI6B_RXD0/TXD0 | FIFO6B_DIN0/DOUT0 | U11 |
| GND | 7 | - | - | - | - | - | - | GND |
| BK7_IO28 | 7 | 126P | 6B | 12 | - | HSI6B_SYDT ⁵ | FIFO6B_EMPTY | W11 |
| BK7_IO29/ PLL_LOCK1 | 7 | 126N | 6B | 13 | - | - | - | Y10 |
| BK7_IO30 | 7 | 127P | 6B | 14 | - | - | - | AA10 |
| BK7_IO31 | 7 | 127N | 6B | 15 | - | - | FIFO6B_FULL | AB9 |

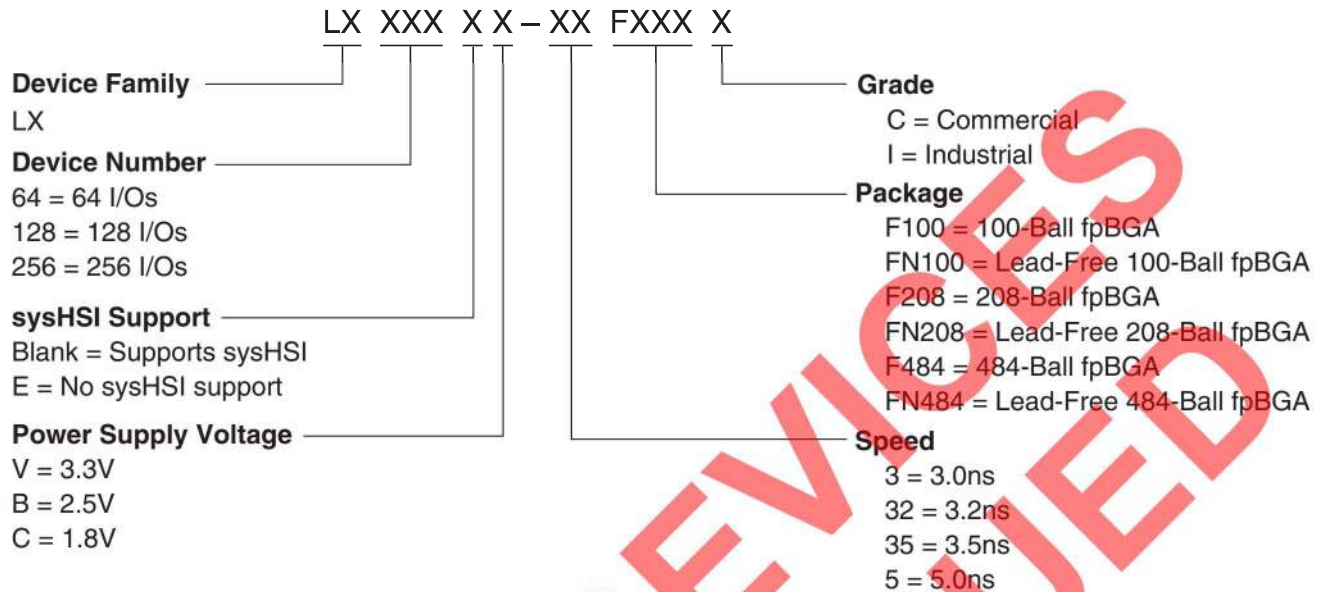
ispGDX2-256 Logic Signal Connections (Continued)

| Signal Name | sysIO Bank | LVDS Pair/Polarity | GDX Block | MRB | SERDES Mode I/O Pin ¹ | SERDES Mode I/O Cell ² | FIFO Mode I/O Cell/Pin ³ | 484 fpBGA |
|-------------|------------|--------------------|-----------|-----|----------------------------------|-----------------------------------|-------------------------------------|-----------|
| TOE | - | - | - | - | - | - | - | AB10 |

1. The signals in this column route to/from the assigned pins of the associated I/O cell.
2. The signals in this column use the I/O cell. If a receiver signal is present in the I/O cell, the associated pin is available for output only. When transmit data (TXD) is present in the cell, the associated pin is available for input only.
3. The DOUT outputs are routed to GRP through the input register of the cell and the DIN inputs are routed direct from the associated pins in FIFO only mode. In SERDES with FIFO mode, the FULL and EMPTY flags are routed to the associated pins through the output MUX and the pins.
4. If the Source Synchronous Receiver is used in the HSI Block, this pin is unavailable for another use and must be left unconnected.
5. The SYDT signal has two routing options. If direct output through the dedicated pin is used, the I/O cell (the whole HSI Block) is not available for transmitter. The SYDT in the I/O Cell column is routed to the GRP through the input register of the cell and frees the I/O cell for transmitter.
6. FIFO_STRDb flag output is used in SERDES with FIFO Mode only.
7. sysHSI Source Synchronous Receive Mode is not available for channel 3A.

SELECTED DEVICES DISCONTINUED

Part Number Description



Ordering Information

Conventional Packaging

Commercial

| Family | Part Number | I/Os | Voltage | t _{PD} | Package | Pins | Grade |
|--------|----------------|------|---------|-----------------|---------|------|-------|
| LX64V | LX64V-3F100C | 64 | 3.3 | 3 | fpBGA | 100 | C |
| | LX64V-5F100C | 64 | 3.3 | 5 | fpBGA | 100 | C |
| LX128V | LX128V-32F208C | 128 | 3.3 | 3.2 | fpBGA | 208 | C |
| | LX128V-5F208C | 128 | 3.3 | 5 | fpBGA | 208 | C |
| LX256V | LX256V-35F484C | 256 | 3.3 | 3.5 | fpBGA | 484 | C |
| | LX256V-5F484C | 256 | 3.3 | 5 | fpBGA | 484 | C |
| LX64B | LX64B-3F100C | 64 | 2.5 | 3 | fpBGA | 100 | C |
| | LX64B-5F100C | 64 | 2.5 | 5 | fpBGA | 100 | C |
| LX128B | LX128B-32F208C | 128 | 2.5 | 3.2 | fpBGA | 208 | C |
| | LX128B-5F208C | 128 | 2.5 | 5 | fpBGA | 208 | C |
| LX256B | LX256B-35F484C | 256 | 2.5 | 3.5 | fpBGA | 484 | C |
| | LX256B-5F484C | 256 | 2.5 | 5 | fpBGA | 484 | C |
| LX64C | LX64C-3F100C | 64 | 1.8 | 3 | fpBGA | 100 | C |
| | LX64C-5F100C | 64 | 1.8 | 5 | fpBGA | 100 | C |
| LX128C | LX128C-32F208C | 128 | 1.8 | 3.2 | fpBGA | 208 | C |
| | LX128C-5F208C | 128 | 1.8 | 5 | fpBGA | 208 | C |
| LX256C | LX256C-35F484C | 256 | 1.8 | 3.5 | fpBGA | 484 | C |
| | LX256C-5F484C | 256 | 1.8 | 5 | fpBGA | 484 | C |

"E-Series" Commercial

| Family | Part Number | I/Os | Voltage | t _{PD} | Package | Pins | Grade |
|---------|-----------------|------|---------|-----------------|---------|------|-------|
| LX64EV | LX64EV-3F100C | 64 | 3.3 | 3 | fpBGA | 100 | C |
| | LX64EV-5F100C | 64 | 3.3 | 5 | fpBGA | 100 | C |
| LX128EV | LX128EV-32F208C | 128 | 3.3 | 3.2 | fpBGA | 208 | C |
| | LX128EV-5F208C | 128 | 3.3 | 5 | fpBGA | 208 | C |
| LX256EV | LX256EV-35F484C | 256 | 3.3 | 3.5 | fpBGA | 484 | C |
| | LX256EV-5F484C | 256 | 3.3 | 5 | fpBGA | 484 | C |
| LX64EB | LX64EB-3F100C | 64 | 2.5 | 3 | fpBGA | 100 | C |
| | LX64EB-5F100C | 64 | 2.5 | 5 | fpBGA | 100 | C |
| LX128EB | LX128EB-32F208C | 128 | 2.5 | 3.2 | fpBGA | 208 | C |
| | LX128EB-5F208C | 128 | 2.5 | 5 | fpBGA | 208 | C |
| LX256EB | LX256EB-35F484C | 256 | 2.5 | 3.5 | fpBGA | 484 | C |
| | LX256EB-5F484C | 256 | 2.5 | 5 | fpBGA | 484 | C |
| LX64EC | LX64EC-3F100C | 64 | 1.8 | 3 | fpBGA | 100 | C |
| | LX64EC-5F100C | 64 | 1.8 | 5 | fpBGA | 100 | C |
| LX128EC | LX128EC-32F208C | 128 | 1.8 | 3.2 | fpBGA | 208 | C |
| | LX128EC-5F208C | 128 | 1.8 | 5 | fpBGA | 208 | C |

"E-Series" Industrial

| Family | Part Number | I/Os | Voltage | t _{PD} | Package | Pins | Grade |
|---------|----------------|------|---------|-----------------|---------|------|-------|
| LX64EV | LX64EV-5F100I | 64 | 3.3 | 5 | fpBGA | 100 | I |
| LX64EB | LX64EB-5F100I | 64 | 2.5 | 5 | fpBGA | 100 | I |
| LX64EC | LX64EC-5F100I | 64 | 1.8 | 5 | fpBGA | 100 | I |
| LX128EV | LX128EV-5F208I | 128 | 3.3 | 5 | fpBGA | 208 | I |
| LX128EB | LX128EB-5F208I | 128 | 2.5 | 5 | fpBGA | 208 | I |
| LX128EC | LX128EC-5F208I | 128 | 1.8 | 5 | fpBGA | 208 | I |
| LX256EV | LX256EV-5F484I | 256 | 3.3 | 5 | fpBGA | 484 | I |
| LX256EB | LX256EB-5F484I | 256 | 2.5 | 5 | fpBGA | 484 | I |
| LX256EC | LX256EC-5F484I | 256 | 1.8 | 5 | fpBGA | 484 | I |

Lead-Free Packaging

Commercial

| Family | Part Number | I/Os | Voltage | t _{PD} | Package | Pins | Grade |
|--------|-----------------|------|---------|-----------------|-----------------|------|-------|
| LX64V | LX64V-3FN100C | 64 | 3.3 | 3.0 | Lead-free fpBGA | 100 | C |
| | LX64V-5FN100C | 64 | 3.3 | 5.0 | Lead-free fpBGA | 100 | C |
| LX64B | LX64B-3FN100C | 64 | 2.5 | 3.0 | Lead-free fpBGA | 100 | C |
| | LX64B-5FN100C | 64 | 2.5 | 5.0 | Lead-free fpBGA | 100 | C |
| LX64C | LX64C-3FN100C | 64 | 1.8 | 3.0 | Lead-free fpBGA | 100 | C |
| | LX64C-5FN100C | 64 | 1.8 | 5.0 | Lead-free fpBGA | 100 | C |
| LX128V | LX128V-32FN208C | 128 | 3.3 | 3.2 | Lead-free fpBGA | 208 | C |
| | LX128V-5FN208C | 128 | 3.3 | 5.0 | Lead-free fpBGA | 208 | C |
| LX128B | LX128B-32FN208C | 128 | 2.5 | 3.2 | Lead-free fpBGA | 208 | C |
| | LX128B-5FN208C | 128 | 2.5 | 5.0 | Lead-free fpBGA | 208 | C |
| LX128C | LX128C-32FN208C | 128 | 1.8 | 3.2 | Lead-free fpBGA | 208 | C |
| | LX128C-5FN208C | 128 | 1.8 | 5.0 | Lead-free fpBGA | 208 | C |
| LX256V | LX256V-35FN484C | 256 | 3.3 | 3.5 | Lead-free fpBGA | 484 | C |
| | LX256V-5FN484C | 256 | 3.3 | 5.0 | Lead-free fpBGA | 484 | C |
| LX256B | LX256B-35FN484C | 256 | 2.5 | 3.5 | Lead-free fpBGA | 484 | C |
| | LX256B-5FN484C | 256 | 2.5 | 5.0 | Lead-free fpBGA | 484 | C |
| LX256C | LX256C-35FN484C | 256 | 1.8 | 3.5 | Lead-free fpBGA | 484 | C |
| | LX256C-5FN484C | 256 | 1.8 | 5.0 | Lead-free fpBGA | 484 | C |

"E-Series" Commercial

| Family | Part Number | I/Os | Voltage | t _{PD} | Package | Pins | Grade |
|---------|------------------|------|---------|-----------------|-----------------|------|-------|
| LX64EV | LX64EV-3FN100C | 64 | 3.3 | 3.0 | Lead-free fpBGA | 100 | C |
| | LX64EV-5FN100C | 64 | 3.3 | 5.0 | Lead-free fpBGA | 100 | C |
| LX64EB | LX64EB-3FN100C | 64 | 2.5 | 3.0 | Lead-free fpBGA | 100 | C |
| | LX64EB-5FN100C | 64 | 2.5 | 5.0 | Lead-free fpBGA | 100 | C |
| LX64EC | LX64EC-3FN100C | 64 | 1.8 | 3.0 | Lead-free fpBGA | 100 | C |
| | LX64EC-5FN100C | 64 | 1.8 | 5.0 | Lead-free fpBGA | 100 | C |
| LX128EV | LX128EV-32FN208C | 128 | 3.3 | 3.2 | Lead-free fpBGA | 208 | C |
| | LX128EV-5FN208C | 128 | 3.3 | 5.0 | Lead-free fpBGA | 208 | C |
| LX128EB | LX128EB-32FN208C | 128 | 2.5 | 3.2 | Lead-free fpBGA | 208 | C |
| | LX128EB-5FN208C | 128 | 2.5 | 5.0 | Lead-free fpBGA | 208 | C |
| LX128EC | LX128EC-32FN208C | 128 | 1.8 | 3.2 | Lead-free fpBGA | 208 | C |
| | LX128EC-5FN208C | 128 | 1.8 | 5.0 | Lead-free fpBGA | 208 | C |
| LX256EV | LX256EV-35FN484C | 256 | 3.3 | 3.5 | Lead-free fpBGA | 484 | C |
| | LX256EV-5FN484C | 256 | 3.3 | 5.0 | Lead-free fpBGA | 484 | C |
| LX256EB | LX256EB-35FN484C | 256 | 2.5 | 3.5 | Lead-free fpBGA | 484 | C |
| | LX256EB-5FN484C | 256 | 2.5 | 5.0 | Lead-free fpBGA | 484 | C |
| LX256EC | LX256EC-35FN484C | 256 | 1.8 | 3.5 | Lead-free fpBGA | 484 | C |
| | LX256EC-5FN484C | 256 | 1.8 | 5.0 | Lead-free fpBGA | 484 | C |

"E-Series" Industrial

| Family | Part Number | I/Os | Voltage | t _{PD} | Package | Pins | Grade |
|---------|-----------------|------|---------|-----------------|-----------------|------|-------|
| LX64EV | LX64EV-5FN100I | 64 | 3.3 | 5.0 | Lead-free fpBGA | 100 | I |
| LX64EB | LX64EB-5FN100I | 64 | 2.5 | 5.0 | Lead-free fpBGA | 100 | I |
| LX64EC | LX64EC-5FN100I | 64 | 1.8 | 5.0 | Lead-free fpBGA | 100 | I |
| LX128EV | LX128EV-5FN208I | 128 | 3.3 | 5.0 | Lead-free fpBGA | 208 | I |
| LX128EB | LX128EB-5FN208I | 128 | 2.5 | 5.0 | Lead-free fpBGA | 208 | I |
| LX128EC | LX128EC-5FN208I | 128 | 1.8 | 5.0 | Lead-free fpBGA | 208 | I |
| LX256EV | LX256EV-5FN484I | 256 | 3.3 | 5.0 | Lead-free fpBGA | 484 | I |
| LX256EB | LX256EB-5FN484I | 256 | 2.5 | 5.0 | Lead-free fpBGA | 484 | I |
| LX256EC | LX256EC-5FN484I | 256 | 1.8 | 5.0 | Lead-free fpBGA | 484 | I |

SELECT DEVICES
DISCONTINUED

For Further Information

In addition to this data sheet, the following Lattice technical notes may be helpful when designing with the ispGDX2 Family:

- *sysIO Design and Usage Guidelines* (TN1000)
- *sysCLOCK PLL Design and Usage Guidelines* (TN1003)
- *sysHSI Usage Guide* (TN1020)
- *Power Estimation in ispGDX2 Devices* (TN1021)

**SELECT DEVICES
DISCONTINUED**